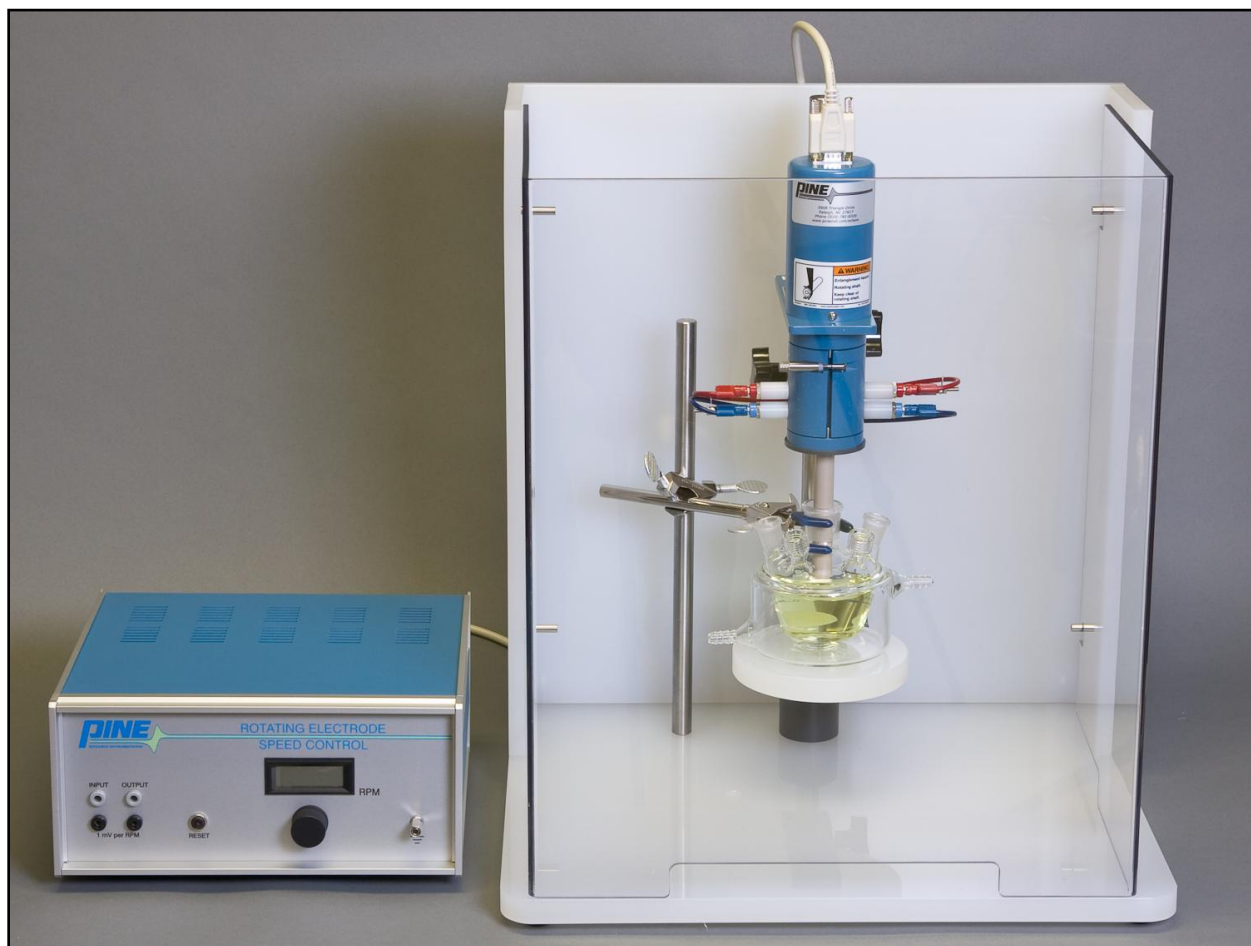


Modulated Speed Rotator User Manual



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1 Preface

1.1 Scope

Pine's Modulated Speed Rotator (MSR) is a solid-state-controlled servo-system designed to rotate an electrode in an electrochemical cell. This manual describes the proper use of the MSR rotator and covers routine operating procedures, periodic maintenance and calibration, and safety issues.

The reader of this manual is assumed to have some basic knowledge of electronics, electrochemistry, and the modern practice of voltammetry. While some background information is presented in this manual, the reader is referred to the appropriate scientific literature for more detail regarding the theory and practice of hydrodynamic voltammetry.

1.2 Copyright

This publication may not be reproduced or transmitted in any form, electronic or mechanical, including photocopying, recording, storing in an information retrieval system, or translating, in whole or in part, without the prior written consent of Pine Research Instrumentation.

1.3 Trademarks

All trademarks are the property of their respective owners.

WaveNow® and AfterMath® are registered trademarks of Pine Research Instrumentation (Durham NC).

1.4 Certifications



This instrument complies with one or more EU directives and bears the CE marking. See the "CE Declaration of Conformity" attached to the end of this manual for more details.

1.5 Warranty

The MSR Rotator is warranted to be free from defects in material and workmanship for a six month period from the date of shipment to the original purchaser and when used under normal conditions. The obligation under this warranty is limited to replacing or repairing any part or parts which shall upon examination disclose to Pine Research Instrumentation's satisfaction to have been defective and shall have been returned freight prepaid and clear of encumbrances to Pine Research Instrumentation within the warranty period. This warranty is offered expressly in lieu of all other warranties, expressed or implied and all other obligations or liabilities.

1.6 Specifications

All specifications are subject to change without notice.

Power	100 - 240 VAC, +/-10%; 50/60 Hz; 2A
Shipping Information	shipping weight: 55 pounds (25 kg) shipping dimensions: 24.0 x 24.0 x 24.0 in (61 x 61 x 61 cm)
Dimensions (L x W x H)	control unit: 11.4 x 10.1 x 5.75 in (29 x 26 x 15 cm) rotator enclosure: 18.8 x 15.5 x 21.0 in (48 x 40 x 54 cm)
Operating Temperature	10 °C to 40 °C (50 °F to 104 °F)
Motor	motor power: 15 W supply voltages: +30 VDC, - 24 VDC motor type: permanent magnet
Motor Protection	2 Amp thermal-type circuit breaker current limited power supplies
Rate Control	closed loop servo-system temperature compensated tachometer mounted on motor shaft
Rate Display	4 ½ digit display indicates rotation rate (RPM)
Rate Accuracy	100 to 200 RPM: accurate to within ± 2 counts of display reading 200 to 10,000 RPM: accurate to within $\pm 1\%$ of display reading
Controls	front panel: 10-turn rotation rate control knob button to reset circuit breaker rear panel: power switch
Rotation Rate Input	allows optional external signal to control rotation rate (banana jack) selectable control ratio: 1 RPM/mV (default) 2 RPM/mV 4 RPM/mV
Rotation Rate Output	allows optional external monitoring of rotation rate (banana jack) output signal ratio: 1 mV/RPM ($\pm 1.0\%$)
Rotator Motor Stop	rear panel input optional digital motor stop signal (banana jack)
Chassis Ground	metal binding post (banana jack) connects to ground lead of power cord and to control unit chassis
Common Jacks	DC common (3 black banana jacks), isolated from chassis ground
Slew Rate of Motor	approximately 300,000 RPM/sec maximum (no load)
Bandwidth	> 50 Hz, -1 dB (at 1000 RPM peak to peak modulation on a 2000 RPM base rate)

1.7 Safety Notices

Throughout this manual there are safety notices which are indicated with special icons as shown below (see Figure 1.1). When working with the rotator and related accessories take heed and abide by all safety warnings. Failure to do so may result in damage to property, personal injury, or both.








	CAUTION: Indicates information needed to prevent injury or death to a person or to prevent damage to equipment.
	RISK OF ELECTRICAL SHOCK: Indicates information needed to prevent injury or death to a person due to electrical shock.
	RISK OF ELECTROSTATIC DAMAGE: Indicates information needed to prevent damage to equipment due to electrostatic discharge.
	RISK FROM LASER LIGHT: Indicates information needed to prevent eye injury due to laser beam light.
	CHEMICAL INCOMPATIBILITY: Indicates chemical incompatibility information needed to prevent damage to equipment.
	DISCONNECT POWER: Indicates when the power cord should be disconnected from the power source prior to performing an operation.
	TEMPERATURE CONSTRAINT: Indicates when an operation or use of an object is limited to a specified temperature range.

Figure 1.1: Special Icons Used to Indicate Safety Information

1.8 Notes and Hints

Throughout this manual there are highlighted notes and information which are indicated with special icons as shown below (see Figure 1.2).

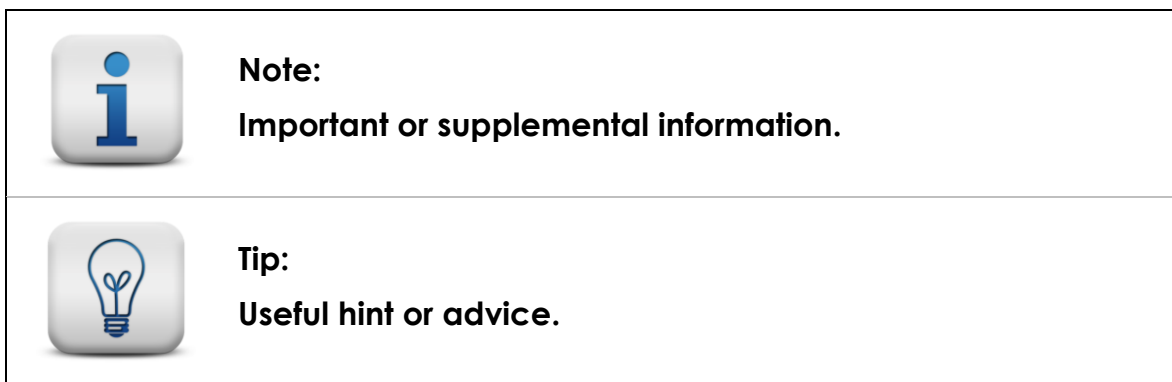


Figure 1.2: Special Icons Used to Highlight Useful Information

1.9 Technical Service Contact

For questions about proper operation of the MSR rotator system or other technical issues, please contact Pine Research Instrumentation directly using the contact information below:

Pine Research Instrumentation
www.pineinst.com/echem
Phone: +1 (919) 782-8320
FAX: +1 (919) 782-8323

1.10 Factory Return Service Address

In the event that the rotator or one of its components or a related accessory must be returned to the factory for service, please contact Pine Research Instrumentation (see contact information above) to obtain a Return Material Authorization (RMA) form. Include a copy of this RMA form in any and all shipping cartons and ship the cartons to the factory address below:

Pine Instrument Company
104 Industrial Drive
Grove City PA 16127
USA
Phone: +1 (724) 458-6391



2 Description

The MSR rotator provides excellent steady-state control of constant rotation rates, but it also offers outstanding acceleration/deceleration control for those applications where the rotation rate must be modulated. The base rotation rate (for steady-state constant rate control) may be manually adjusted from 50 to 10,000 RPM by turning a ten-turn potentiometer knob located on the front panel of the control unit. As the knob is turned, a built-in tachometer measures the actual rotation rate, and this rate is continuously displayed on the front panel of the control unit. Manually turning the knob and observing the rotation rate is by far the most common manner in which the rotation rate is selected.

More complex control of the rotation rate is possible when the MSR rotator is connected to a potentiostat system capable of supplying an analog rotation rate signal. While specific details vary from one system to another, the basic idea is that the potentiostat produces an analog signal that is proportional to the target rotation rate. This analog signal is carried by a cable (supplied by the potentiostat manufacturer) to a pair of input banana jacks on the front panel of the MSR control unit. This connection permits the software which controls the potentiostat to control the rotation rate using a constant voltage level (for steady-state rotation) or a more complex waveform such as a sine wave (for hydrodynamically modulated voltammetry).

The rotator is able to accurately follow complex waveforms and create the desired rotation rate response by using a high rate, low inertia, permanent magnet DC motor in combination with a high voltage, bi-polar power supply. In general, the MSR can track and follow low frequency (less than 100 Hz) external input signals with amplitudes that do not exceed 10% of the baseline rotation rate. The usual proportionality between the applied potential and the rotation rate is 1.0 RPM/mV, but a hardware jumper setting inside the control unit may be used to select the different ratios (see Section 6.7).

The rotation rate is typically monitored by observing the front panel display on the control unit. In addition, the tachometer measurement can be monitored by connecting an oscilloscope, voltmeter, or other recording device across the two output banana jacks on the front panel. The voltage signal from the tachometer presented at these output jacks is proportional to the rotation rate. The ratio used for this signal is 1.0 mV/RPM.

The control unit is connected to the motor unit using a conventional HD-15 "VGA cable" like those used for connecting a display monitor to a computer. The usual cable length is 183 cm (72 in), but longer distances can be spanned by chaining together multiple cables.

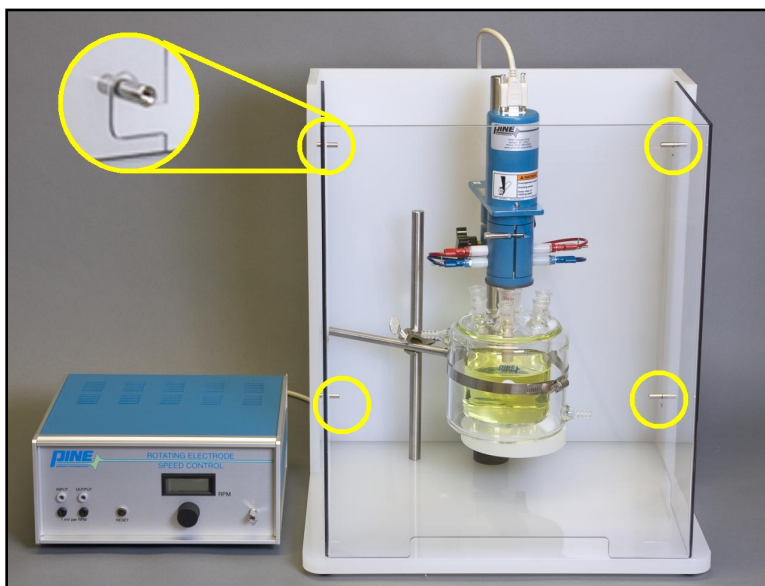
The motor unit can be positioned vertically along a center post that is mounted in a sturdy and chemically resistant enclosure base. A flat cell platform can also be positioned along the center post, making it easy to raise and lower the cell with respect to the motor unit. The electrochemical cell can be further secured by clamping it to a side post located adjacent to the center post.

The motor unit and electrochemical cell are enclosed on the back side by a rear wall permanently attached to the enclosure base. The cell and motor are further enclosed on the front side by a transparent enclosure window. The enclosure window can be removed to set up the cell, but the enclosure window must be securely mounted to the enclosure base before rotating the electrode.



CAUTION:

Do not rotate the electrode unless the enclosure window is securely mounted to all four pins as shown below.



The rotator may be used with rotating disk electrodes (RDEs), rotating ring-disk electrodes (RRDEs), and rotating cylinder electrodes (RCEs). Connections to the rotating electrode shaft are made by two pairs of silver-carbon brushes. For RDEs and RCEs, all four brushes make contact with the rotating shaft and may be shorted together to obtain four points of contact. For RRDEs, the upper brush pair contacts the disk electrode, and the lower pair contacts the ring electrode.

2.1 Major System Components

The table and photo below (see Figure 2.1) show the major system components.

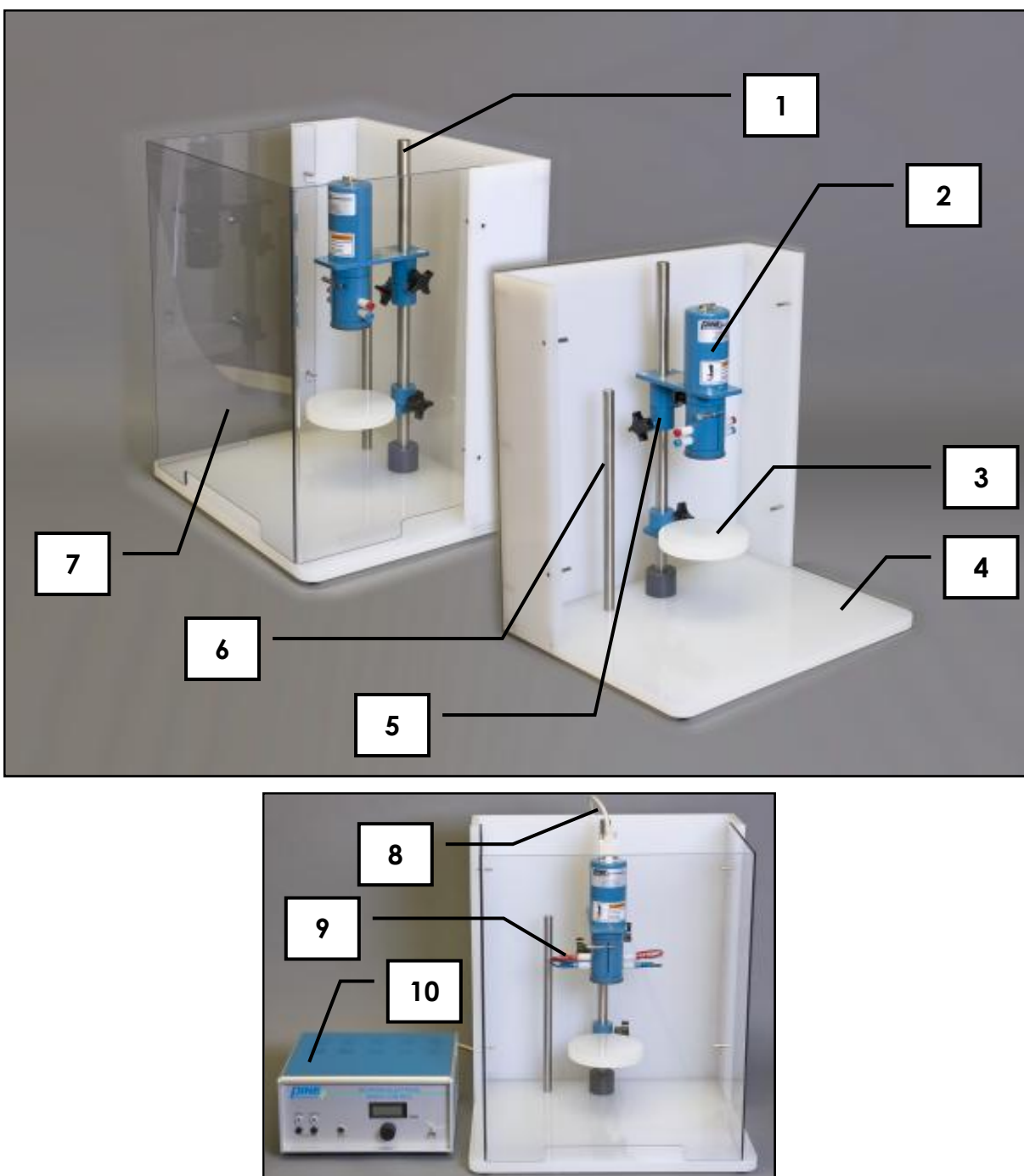


Figure 2.1: Major Components of the Pine MSR Rotator System

1	Center Post	The cell platform, support collar, and motor unit are supported by the center post.
2	Motor Unit	The motor unit is mounted on the center post and holds the motor and brushes.
3	Cell Platform	The cell platform supports cells with flat bottom surfaces.
4	Enclosure Base	The support frame is fabricated from chemically-resistant polymer.
5	Support Collar	The support collar helps prevent motor from unexpectedly sliding down center post.
6	Side Post	The side post is a support for cell clamps and can be installed in one of two positions.
7	Enclosure Window	This is a transparent window covering the front of the overall enclosure.
8	Motor Control Cable	This cable connects the control unit to the motor unit.
9	Banana Cables (red and blue)	The pair of red brush contacts are used with rotating disk electrodes (RDE) and rotating cylinder electrodes (RCE). The pair of blue contacts is only used with rotating ring-disk electrodes (RRDE), in which case the blue brushes make contact with the ring while the red brushes contact the disk.
10	Control Unit	The control unit contains the power supply and rotation rate control circuitry.

2.2 Control Unit Components

The table and photo below (see Figure 2.2) show the control unit components.

10	Control Unit	The control unit contains the power supply and rotation rate control circuitry.
11	Rotation Rate Display	4 ½ digit display of rotation rate (RPM)
12	Rotation Rate Knob	10 turn knob for manual rotation rate control
13	Chassis Ground (Earth Ground)	Connected to the control unit chassis, earth ground (via the third prong on the power cord), and motor unit chassis (via the motor control cable).
14	Reset Button	Motor circuit breaker reset
15	Signal Ground	DC signal common (isolated from chassis)
16	Rotation Rate Input Signal	External control of the rotation rate is possible by applying a voltage signal across these banana jacks (see Section 4.6.3). (1, 2, or 4 RPM/mV ratio, 50KΩ impedance)
17	Rotation Rate Output Signal	A voltage signal proportional to the rotation rate is presented at these banana jacks. (1.0 mV/RPM, ~600 Ω output impedance)
18	Control Box Cover	Metal cover
19	Control Box Cover Screws	Metal screws that hold cover on control unit
20	Motor Stop Input Signal	This digital logic signal is used to stop electrode rotation (see Section 4.6.4).
21	Signal Ground	DC signal common (isolated from chassis)
22	Motor Cable Connector	Accepts one end of motor control cable
23	Serial Number Plate	Unique system serial number
24	Power Cord Connector	Connects to external electrical power cord
25	Power Switch	Main power switch (with circuit breaker)

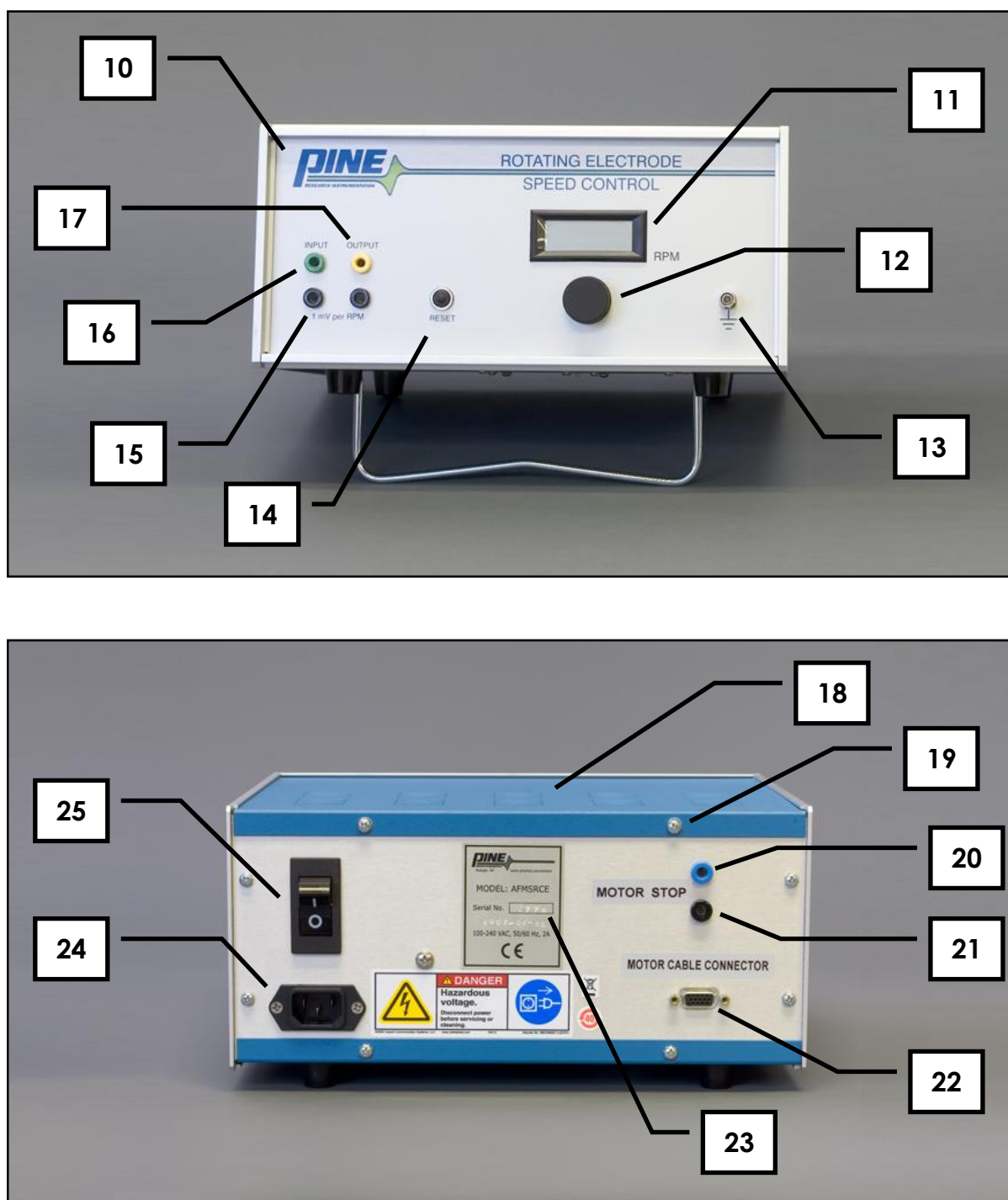


Figure 2.2: Control Unit Front and Back Panels

2.3 Motor Unit Components

The table below and the photographs on the next page (see Figure 2.3) identify the major components of the motor unit.

26	Motor Cable Connector	Accepts one end of motor control cable
27	Upper Brush Pair (red)	These upper brushes make contact on opposing sides of the rotating shaft and are used to make contact with rotating disk electrodes and rotating cylinder electrodes.
28	Lower Brush Pair (blue)	These lower brushes make contact on opposing sides of the rotating shaft and are used to make contact with the ring electrode when working with rotating ring-disk electrodes.
29	Clamshell Doors	These doors open to permit access to the brush chamber.
30	Door Latch	Secures clamshell doors in closed position
31	Brush Contact	Spring-loaded silver-carbon brush provides electrical contact with the rotating shaft
32	Motor Coupling	Used to attach the shaft to the motor
33	Motor Coupling Hex Screw Pair	Hex screws located on either side of the motor coupling tighten to hold the shaft inside the motor coupling
34	Electrode Shaft	The top end of the rotating shaft is mounted in motor coupling and the active electrode surface is at the bottom end of the shaft.
35	Lower Bearing Assembly	An easily replaceable bearing assembly stabilizes the rotating shaft at the point where the shaft exits the motor unit. Metal and ceramic bearings are available.

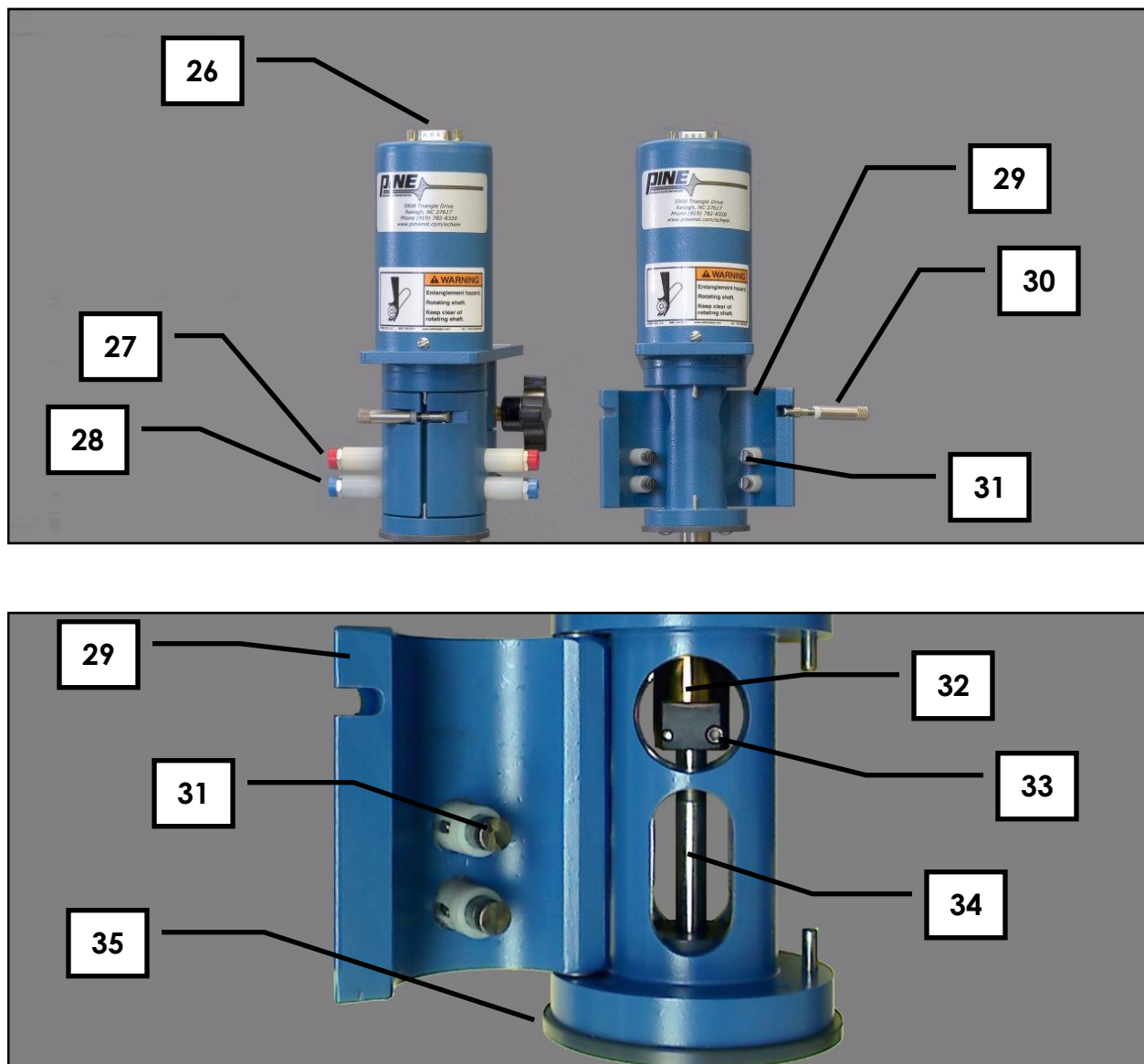


Figure 2.3: Motor Unit Components

2.4 Typical Rotating Disk Electrode Design

Most rotating disk electrodes consist of two parts (see Figure 2.4), a shaft and a tip, but in some cases the entire electrode may be a single piece.

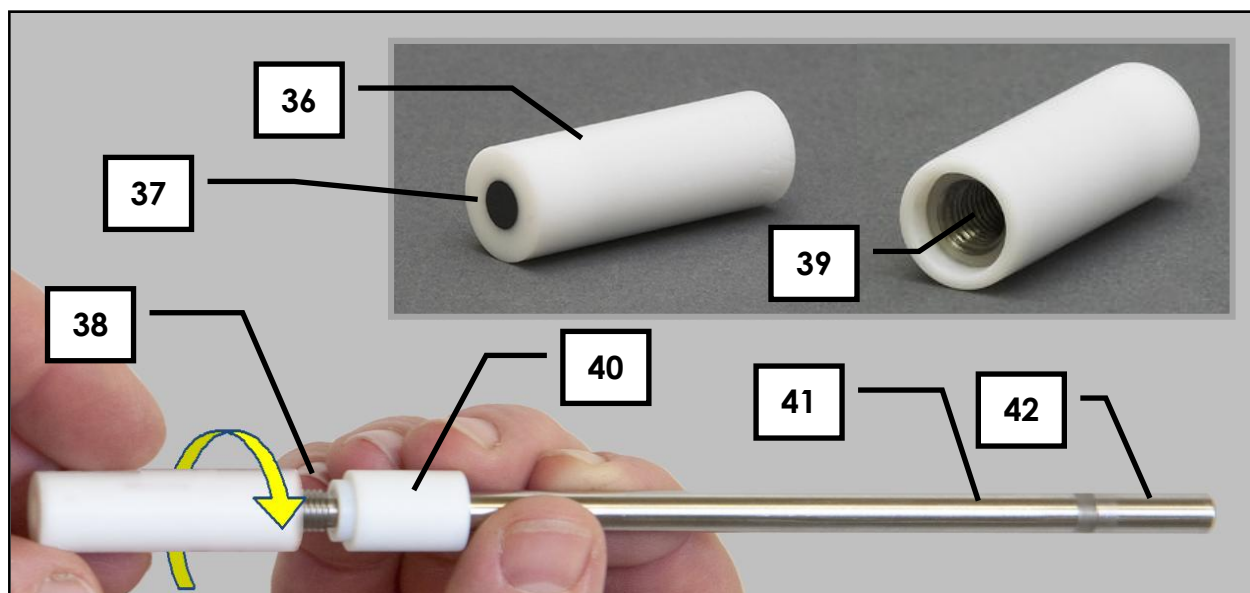


Figure 2.4: Typical Rotating Disk Electrode (RDE) Tip with Shaft

36	Insulating Shroud on Tip	This insulating shroud material is typically Teflon, PEEK or KEL-F.
37	Electrode Surface	The electrode surface is typically polished to mirror smoothness.
38	Threads on shaft	These threads are normally in electrical contact with disk.
39	Threads inside tip	These threads are normally in electrical contact with disk.
40	Insulating Shroud on Shaft	This insulating shroud material is typically Teflon, PEEK or KEL-F.
41	Disk Contact Area	This metal area on the shaft is normally in electrical contact with disk.
42	Shaft Mounting Area	This electrically-isolated portion of the shaft is used to physically mount the shaft in the motor coupling.

2.5 Typical Rotating Ring-Disk Electrode Design

Rotating ring-disk electrode tips mount on to a special two-conductor shaft (see Figure 2.5). In some cases, the tip can be taken apart into smaller pieces.

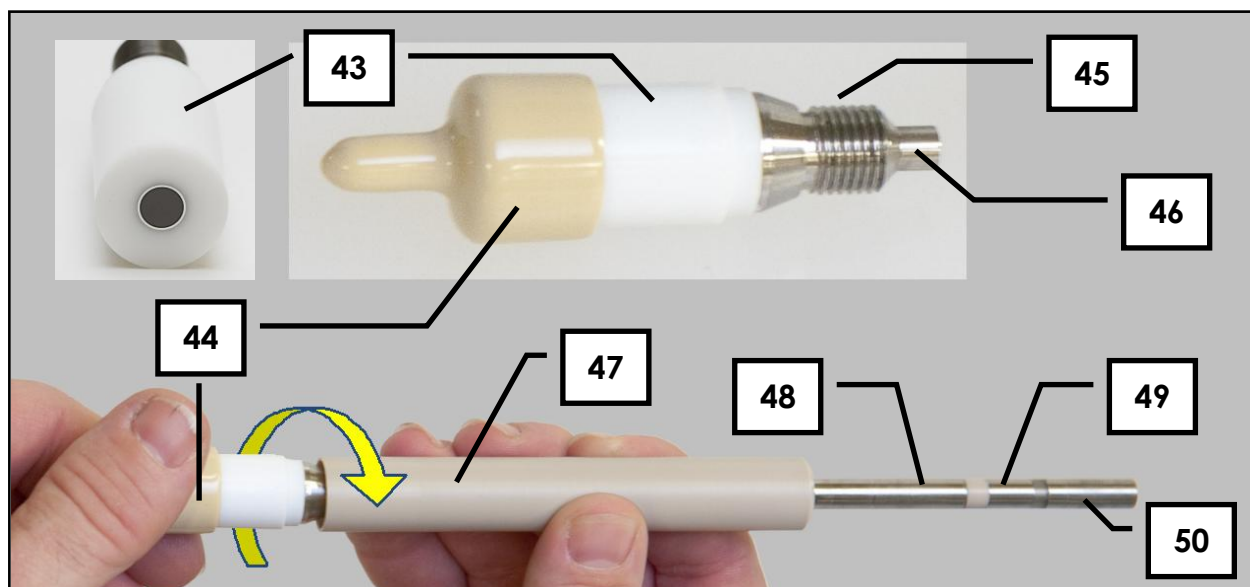


Figure 2.5: Typical Rotating Ring-Disk Electrode (RRDE) Tip with Shaft

43	Insulating Shroud on Tip	This insulating shroud material is typically Teflon, PEEK or KEL-F.
44	Plastic Cover	Cover protects electrode when not in use.
45	Ring Threads on Tip	These threads contact the ring electrode.
46	Disk Core on Tip	This disk core is in electrical contact with the surface of the disk electrode.
47	Insulating Shroud on Shaft	This insulating shroud material is typically Teflon, PEEK or KEL-F.
48	Ring Contact Area	This metal area on the shaft is normally in electrical contact with the ring electrode.
49	Disk Contact Area	This metal area on the shaft is normally in electrical contact with the disk electrode.
50	Shaft Mounting Area	This electrically-isolated portion of the shaft is used to physically mount the shaft in the motor coupling.

3 Installation

3.1 Site Preparation

The rotator system should be located on a sturdy table or laboratory bench with ample clearance around the perimeter of the rotator enclosure. The front of the rotator should be unobstructed, and there should be at least 20 centimeters clearance on each side and behind the rotator, for a total table space of 40 cm x 60 cm. The location should also include enough space for the control unit (30 cm x 30 cm) and vertical clearance to easily raise and lower the motor unit.

3.2 Unpacking and Setting Up the Rotator



Note:

The numbers appearing in parentheses in the installation instructions below correspond to the labels in Figure 2.1.



Inspect the contents of the shipping carton. Remove the top piece of cardboard to reveal the two smaller boxes in the carton. The control unit **(10)** is packed inside the larger box, and the smaller box holds additional components. Remove both boxes and set aside. Then, carefully remove the enclosure window **(7)** and the enclosure base **(4)** from the box. The center post **(1)** is pre-installed in the enclosure base.

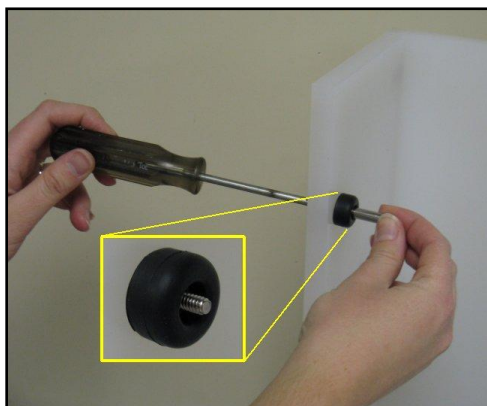


Open the smaller box. It should contain the motor unit **(2)**, the support collar **(5)**, the cell platform **(3)**, the side post **(6)**, two banana cables **(9)**, a small bag of hardware, and a standard three-pronged laboratory clamp (with right-angle mount).

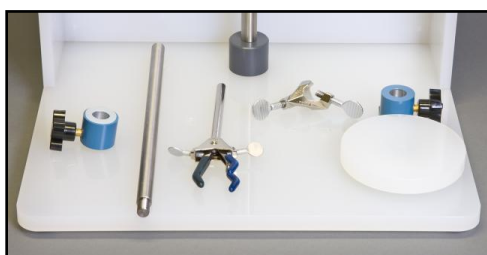


Note:

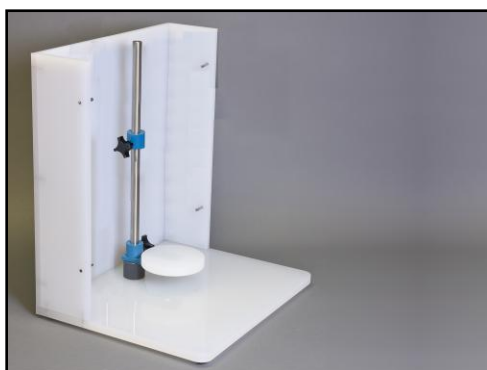
The outer diameter of the side post **(6)** shown in these photos is 5/8" (15.9 mm), but in some alternate rotator configurations this diameter may be 1/2" (12.7 mm).



Locate the small bag of hardware. Remove the four pins, four screws, and four rubber bumpers. Place each screw in one of the pre-drilled holes along the side walls of the enclosure, two on the left and two on the right. Install a rubber bumper on each screw as shown, with the flat side of the bumper against the wall. Install the pins onto the rubber bumpers and screws. Properly installed pins and bumpers will point inwards as shown.



Locate the support collar **(5)**, side post **(6)**, and three-pronged laboratory clamp (with right-angle mount), cell platform **(3)**, and the large plastic washer (usually shipped in the hardware bag).



Slide the cell platform **(3)** onto the center post and position it near the bottom of the center post with the platform facing up. Tighten the knob to secure the cell platform to the center post. Next, slide the support collar on to the center post and position it slightly above the midpoint of the center post with the knob on the left side. Tighten the knob to secure the support collar to the center post. Slide the plastic washer on the center post and allow it to rest on top of the support collar.



Carefully slide the motor unit **(2)** on to the center post **(1)** until it rests on the support collar **(5)**. Tighten the knob to secure the motor unit to the center post.



Note:

The relative vertical positions of the cell platform, support collar, and motor unit may be adjusted as needed to fit the specific size and shape of a particular electrochemical cell.



There are several holes in the floor of the enclosure base **(4)**, which are threaded to accept the side post. Choose one of these holes and install the side post in it. Then, mount the laboratory clamp on to the side post.



There are two short banana cables (red and blue) which serve as jumpers between the left and right brush connections. Use the red cable to connect the upper (red) pair of brush connections, and use the blue cable to connect the lower (blue) pair of brush connections, running the wires behind the assembly as shown.

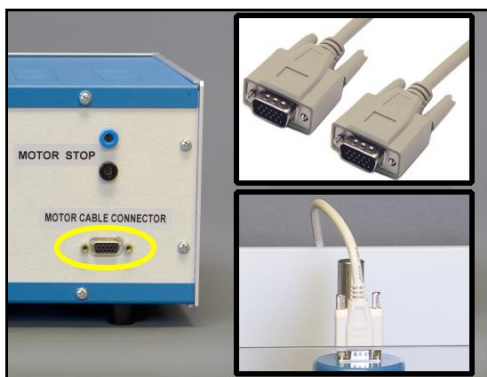


Insert one banana plug stud into the red banana cable, and insert the other banana plug stud into the blue banana cable. These flat studs are an ideal place to make connections using alligator clips.



The red jacks make electrical contact with a rotating disk electrode (RDE) or a rotating cylinder electrode (RCE) tip.

When using a rotating ring-disk electrode (RRDE), the red jacks make contact with the disk, and the blue jacks make contact with the ring.



Remove the control unit **(10)** from the box and place it next to the enclosure base. Plug the male end of the motor control cable **(8)** into the motor cable connector on the back of the control unit, and plug the female end of the cable into the top of the motor unit.

CAUTION:



The connectors on both ends of the motor control cable **MUST** be firmly secured by tightening the pair of screws on each connector. Failure to secure the connectors will result in improper control of the rotation rate.



Use an appropriate power cord (sold separately) to connect the control unit to the local power supply.

The local power supply should provide an earth ground connection for the third prong on the power cord.



CAUTION:

Failure to connect the third prong of the power cord to a proper earth ground may impair the protection provided by the system.



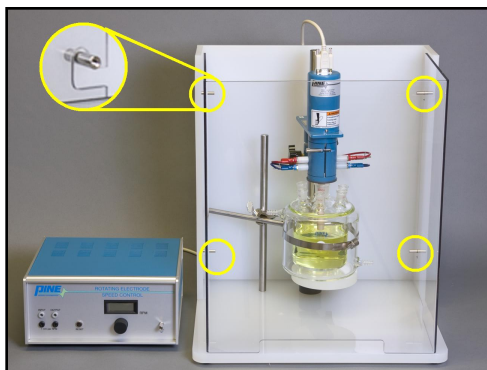
CAUTION:

Risk of electric shock.



CAUTION:

Disconnect all power before servicing the rotator.



Attach the enclosure window by hooking it on to the four pins. The window will rest securely on the enclosure base.



CAUTION:

Do not rotate the electrode unless the enclosure window is securely mounted to the four pins.

4 Operation

This section of the manual discusses information pertaining to routine operation of the rotator. Users of the rotator should be familiar with all of the information in this section prior to operating the rotator.

4.1 The Rotating Shaft

The electrode shaft normally rotates in a clockwise direction as viewed from the top of the rotator. The upper end of a standard shaft has a 1/4" (6.35 mm) outer diameter. When properly mounted in the rotator, the upper 2.5" (63.5 mm) of the shaft is inside the motor unit, while the remaining length of the shaft extends down below the motor unit.

The rotator accepts shafts for use with Rotating Disk Electrodes (RDEs), Rotating Cylinder Electrodes (RCE) or Rotating Ring-Disk Electrodes (RRDEs). Electrical connection is accomplished using one or more silver-carbon brushes to contact metal surfaces on the upper portion of the rotating shaft. Each shaft is specially designed to provide one or two current paths down to the electrode tip which are electrically isolated from the mounting area near the top of the shaft.

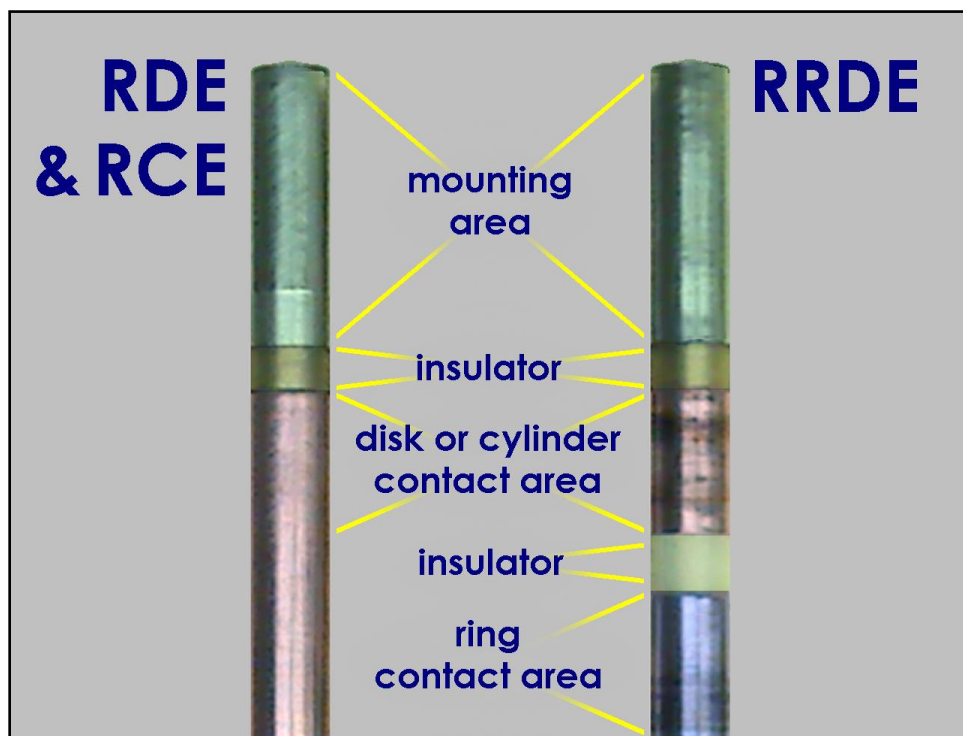


Figure 4.1: Contact Areas at Top of Rotating Electrode Shafts

The uppermost portion of the shaft is used to mount the shaft into the rotator (see Figure 4.1). This mounting area is electrically isolated from the remainder of the shaft so that the electrode connections remain isolated from the rotator chassis. An insulating spacer just below the mounting area isolates the mounting area from the electrode contact area.

For an RDE or RCE shaft (see Figure 4.1, left), the entire metal exterior of the shaft below the insulating spacer is in electrical contact with the disk (or cylinder) electrode. For an RRDE shaft (see Figure 4.1, right), there are two insulating spacers. The portion of the shaft between the two insulating spacers provides electrical contact with the disk electrode. The lower portion of the shaft (below the lower insulating spacer) provides electrical contact with the ring electrode.

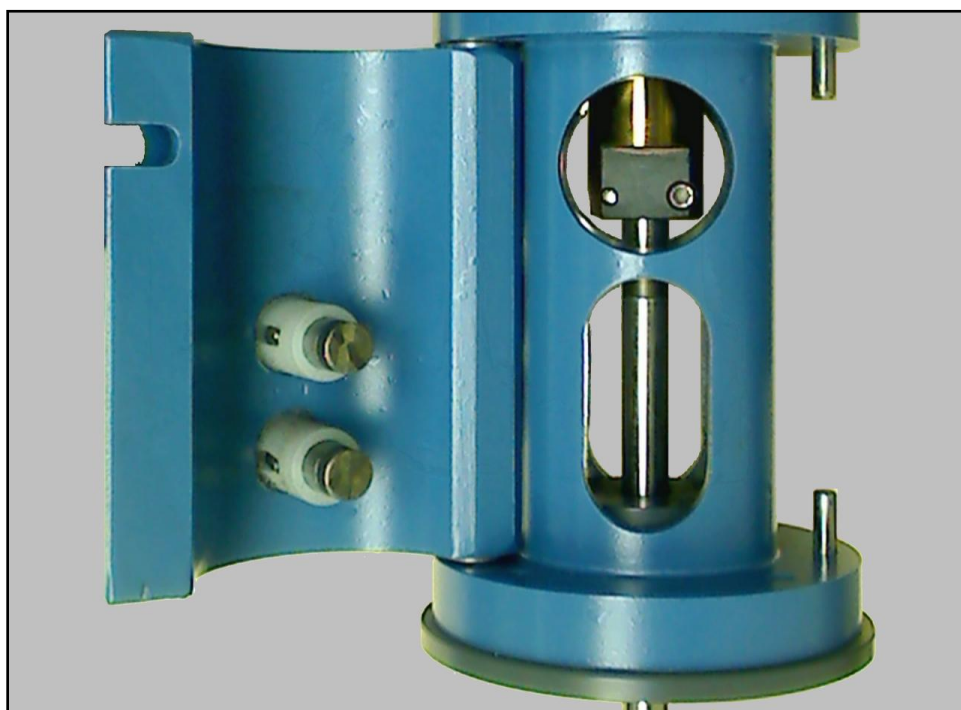


Figure 4.2: The Brush Chamber (side view)

The shaft is connected to the rotator motor via a brass motor coupling located inside the brush chamber (see Figure 4.2). Two clamshell doors surround the brush chamber. These doors are securely latched during rotator operation and push two pairs of contact brushes against the rotating shaft. The upper (red) pair of brushes makes contact with the disk (or cylinder) while the lower (blue) pair makes contact with the ring on a rotating ring-disk electrode.

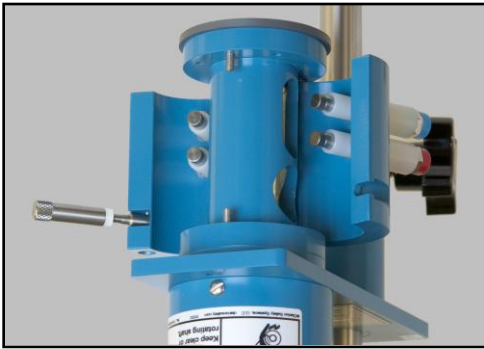
4.1.1 Installing a Shaft

**DISCONNECT POWER:**

Before removing a shaft or installing a new shaft, turn off the power to the rotator and disconnect the power cord from the power source.

**Tip:**

It is often easier to remove or install a shaft disconnecting the motor control cable and inverting the entire motor unit on the center post. Several of the photos in this section of the manual show the rotator motor in such an inverted position.

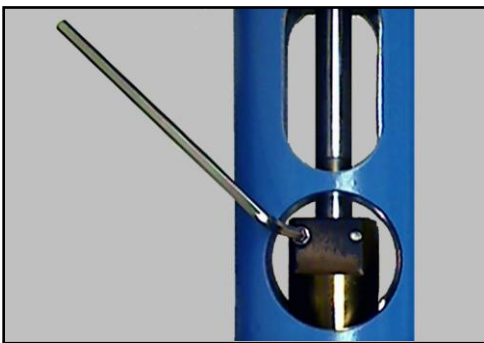


Loosen the latch on the clamshell doors.

Open the doors to provide access to the brush chamber.

**Tip:**

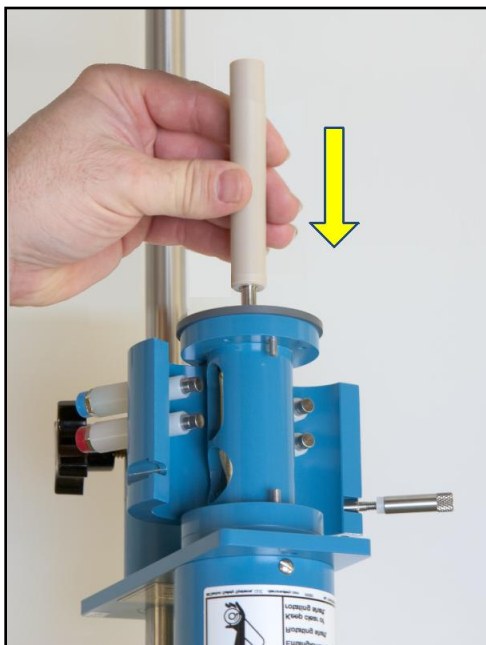
Do not lose the white plastic washer on the door latch.



If there is a shaft already installed, use the hex driver tool (5/64", provided) to loosen the two screws on the motor coupling. Do not remove these screws entirely; just loosen them by one or two turns of the hex driver. Usually it is necessary to hold the motor coupling in place with one hand while loosening the screws with the other hand.

**Note:**

A new rotator has tape around the motor coupling to protect the hex screws. Remove this tape and loosen the hex screws if needed to allow the shaft to enter the coupling.



Install the shaft by sliding it through the hole in the lower bearing assembly and into the brush chamber.

The shaft should be pushed as far as possible into the motor coupling so that the contact brushes are properly aligned with the electrical contact areas on the rotating electrode shaft (see Figure 4.3).

If the shaft is properly installed, the brushes will contact metal surfaces on the shaft.

If the shaft is improperly installed, the brushes may contact an insulating gap on the shaft, and the connection to the rotating electrode will fail.



Tip:

Apply a small amount of a silicon-based grease to the top of the shaft before installing the shaft into the motor coupling. This helps to prevent the shaft from sticking in the coupling.



Use the hex driver tool (5/64") to securely tighten both hex screws on the motor coupling.

Gently tug on the shaft to make sure it is securely mounted in the motor coupling.

Close the clamshell doors and tighten the latch.

Remount the motor unit on the center post (in the non-inverted position).



CAUTION:

Before reconnecting the rotator power cable or the motor control cable to the control unit, be sure the control unit power switch is off and the rotation rate knob is turned to the fully counterclockwise position.

Reconnect the motor control cable from the control unit to the motor unit.

Reconnect the power cable from the power source to the control unit.

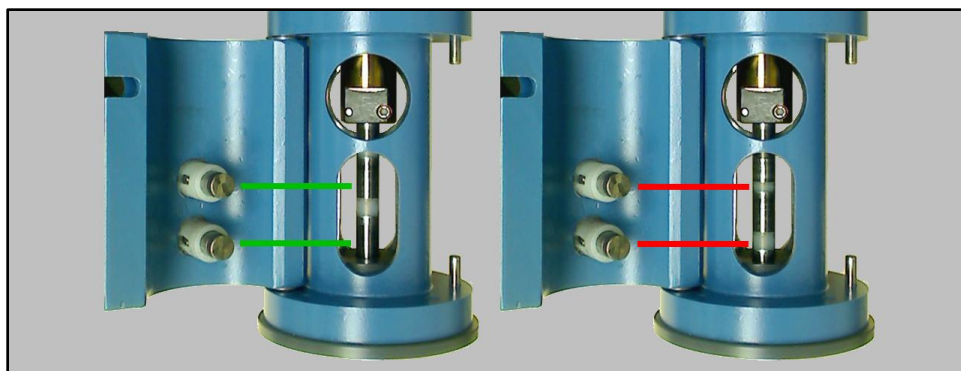


Figure 4.3: Proper (left) and Improper (right) Shaft Insertion Positions



CAUTION:

Check the shaft to make sure it is securely mounted in the rotator. Check the shaft to make sure that it is not bent or damaged. Do not turn on the rotator if the shaft is loose, bent, or damaged in any way.

With the rotation rate knob in the fully counterclockwise position, turn on the control unit.

Slowly turn the rotation rate knob clockwise until the shaft rotates between 100 and 200 RPM.

While the shaft is slowly rotating (100 to 200 RPM), inspect the rotating shaft to assure that it is rotating properly about the axis of rotation. If the shaft is wobbling, vibrating, or tilting away from the axis of rotation, then turn off the rotator and remove the shaft from the rotator.



CAUTION:

If the slowly rotating shaft appears to be wobbling, vibrating, or tilting away from the axis of rotation, then it is either damaged or improperly installed. Do not attempt to use a damaged or improperly installed shaft. Remove the shaft immediately and replace it with a properly installed and undamaged shaft.

If the shaft is rotating properly along the axis of rotation, then it is ready for use. Some shafts are actually single-piece electrodes where the electrode tip is permanently attached to the shaft. But most shafts are designed to accept a variety of different tips. For these “shaft and tip” designs, the shaft may remain mounted in the rotator, and changing the tip is a simple matter of unscrewing one tip and then threading a new tip on to the shaft.

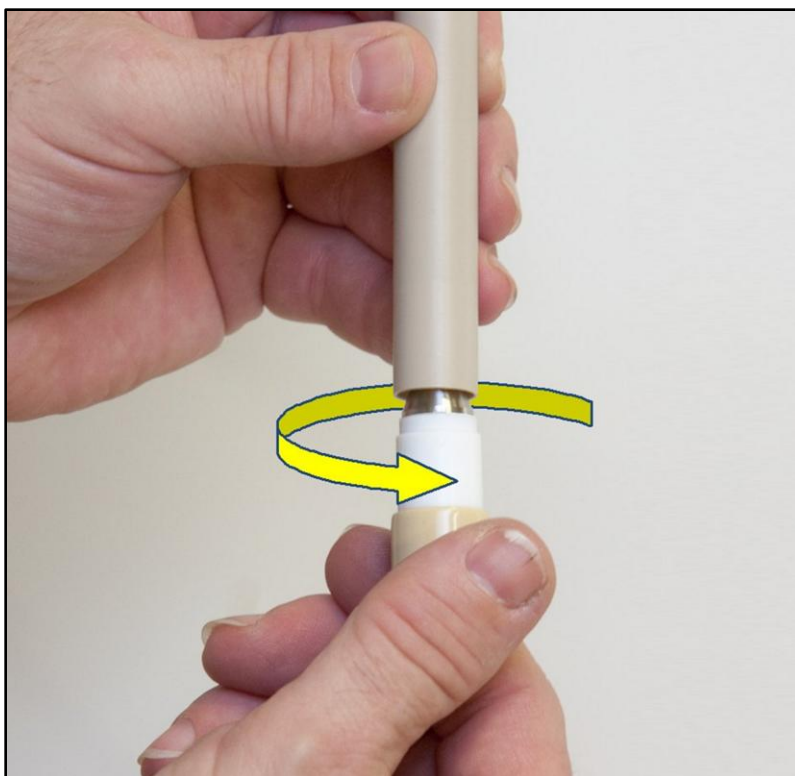


Figure 4.4: Installing a Tip on to a Shaft

4.1.2 Changing the Tip on a Shaft



DISCONNECT POWER:

Before removing a tip from a shaft or installing a new tip on to a shaft, turn off the power to the rotator and disconnect the power cord from the power source.

When removing a tip from a shaft or installing a new tip on a shaft, use one hand to prevent the shaft from rotating while using the other hand to gently turn the tip.

Remove the old tip from the shaft by gently unscrewing the tip by hand. No tools are required to remove a tip from a shaft.



DO NOT USE TOOLS ON THE SHAFT OR TIP:

Never use a tool to unscrew a tip from a shaft. If a tip cannot be removed from a shaft by hand, then contact Pine for further instructions.

Thread the new tip on to the shaft (see Figure 4.4) and gently tighten it by hand. Never use a tool to tighten the tip on to the shaft.

**CAUTION:**

Before reconnecting the rotator power cable or the motor control cable to the control unit, be sure the control unit power switch is off and the rotation rate knob is turned to the fully counterclockwise position.

Reconnect the motor control cable from the control unit to the motor unit.

Reconnect the power cable from the power source to the control unit.

**CAUTION:**

Check the shaft to make sure it is securely mounted in the rotator. Check the shaft to make sure that it is not bent or damaged. Do not turn on the rotator if the shaft is loose, bent, or damaged in any way.

With the rotation rate knob in the fully counterclockwise position, turn on the control unit.

Slowly turn the rotation rate knob clockwise until the shaft is rotating between 100 and 200 RPM.

While the shaft is slowly rotating (100 to 200 RPM), inspect the rotating shaft and tip to assure that both are rotating properly about the axis of rotation. If the shaft or tip is wobbling, vibrating, or tilting away from the axis of rotation, then turn off the rotator and remove the shaft from the rotator.

**CAUTION:**

If the slowly rotating shaft and tip appear to be wobbling, vibrating, or tilting away from the axis of rotation, then the shaft or the tip or both are improperly installed or damaged. Do not attempt to use a damaged or improperly installed shaft or tip. Remove the shaft and tip immediately and replace with a properly installed and undamaged shaft and tip.

If the shaft and tip are rotating properly along the axis of rotation, then the next step is to mount the electrochemical cell that holds the test solution (see Section 4.2).

4.2 Mounting the Cell

All cells should be clamped to the side post and also supported from below using the cell platform. For a cell with multiple side ports, carefully orient the cell so that any accessories mounted in the side ports have enough clearance. Smaller cells may be clamped using a traditional laboratory clamp secured to the center port (see Figure 4.5, left). Larger cells may be clamped using a large diameter column clamp (see Figure 4.5, right).



Figure 4.5: Properly Supported and Clamped Electrochemical Cells

The cell platform and clamp positions allow adjustment of the vertical position of the cell with respect to the motor unit. In addition, the vertical position of the motor unit is easily adjusted. Usually, it is easier to mount and clamp the cell in a fixed vertical position. Then, the rotating electrode can be moved vertically down into the cell or up out of the cell as needed.



CAUTION:

When raising and lowering the motor unit, be sure to hold the motor unit carefully so that it does not unexpectedly fall and break the glass cell located below the motor unit.



CAUTION:

Position the motor unit with respect to the glass cell so that the electrode tip is immersed ~1.0 cm into the test solution. Excessive immersion may corrode the shaft or tip by allowing liquids to seep into the joint between the shaft and tip.



CAUTION:

Center the rotating electrode within the opening on the cell so that it does not rub against the walls of the opening. Damage will occur if the rotating shaft or tip abrades against these walls.

4.3 The Enclosure

**CAUTION:**

Do not rotate the electrode unless the enclosure window is securely mounted to the four pins (see Figure 4.6 below)

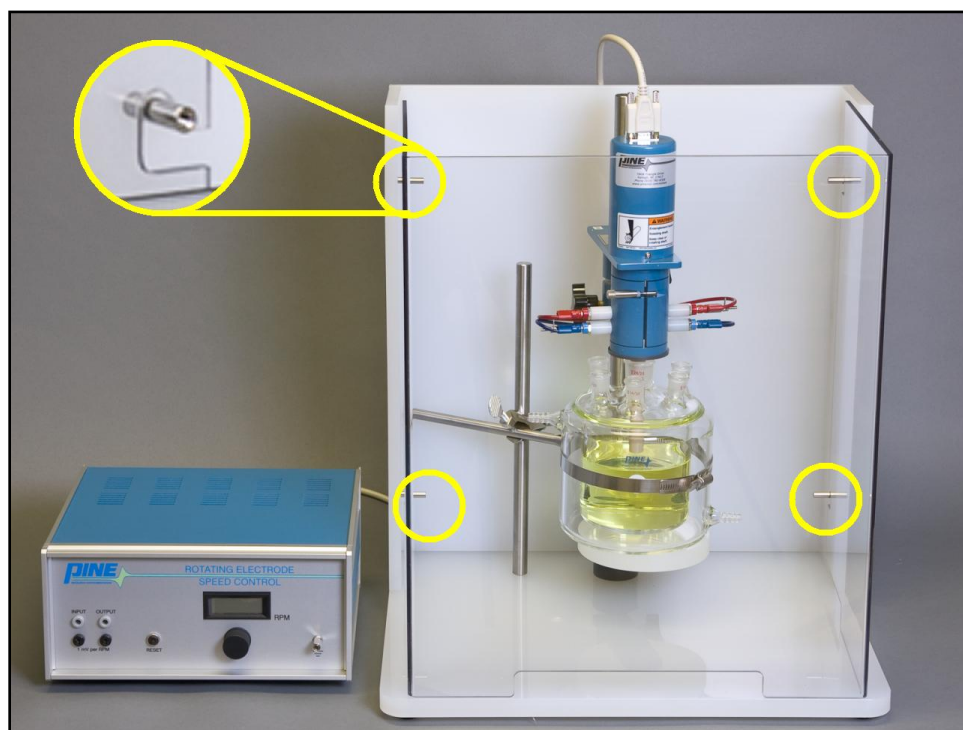


Figure 4.6: Enclosure Properly Mounted on All Four Pins

After the cell has been mounted and the electrode has been lowered into the cell, securely mount the enclosure by hooking the enclosure to the four pins on the enclosure base (see Figure 4.6).

Note that the enclosure has small openings near the bottom which permit cell connections, purge gas tubing, and coolant to be carefully routed to the electrochemical cell from locations outside the enclosure.

4.4 Cell Connections

The counter electrode and the reference electrode are usually mounted in appropriate side ports on the electrochemical cell (see Figure 4.7). The counter electrode is often a simple platinum wire or carbon rod to which an alligator clip is easily affixed.



Figure 4.7: Connection of Counter and Reference Electrodes

Many commercially available reference electrodes have a sturdy pin connector on the top end which can accept an alligator clip. The cable which connects the reference electrode to the potentiostat should be of the shielded (coaxial) type, and care should be taken to route this cable well away from noise sources such as power cords, networking cables, or video monitors.

Note:



Cell cables on newer model Pine potentiostats use **GREEN** to mark the counter electrode connection and **WHITE** to mark the reference electrode connection (see Figure 4.7).

Older Pine bipotentiostats use **RED** to mark the counter electrode and use a **BNC** connector for the reference electrode.

Tip:



There is no universally accepted color coding scheme for marking potentiostat cell cable connections. If you are using the rotator with a third-party potentiostat, consult the potentiostat documentation for information about the cell cable markings.

4.4.1 RDE and RCE Wiring

There are two pairs of brushes which provide electrical contact with the rotating shaft (see Figure 4.8). The upper pair of brush contacts (red) is used to make electrical contact with a rotating disk electrode (RDE) or a rotating cylinder electrode (RCE).

To make good contact on opposite sides of the rotating shaft, both of the red brushes (left and right sides) should be used. Use a short banana jumper cable

to connect the opposing brushes together (see Figure 4.8), and then connect the working electrode cable(s) from the potentiostat to the jumper cable.

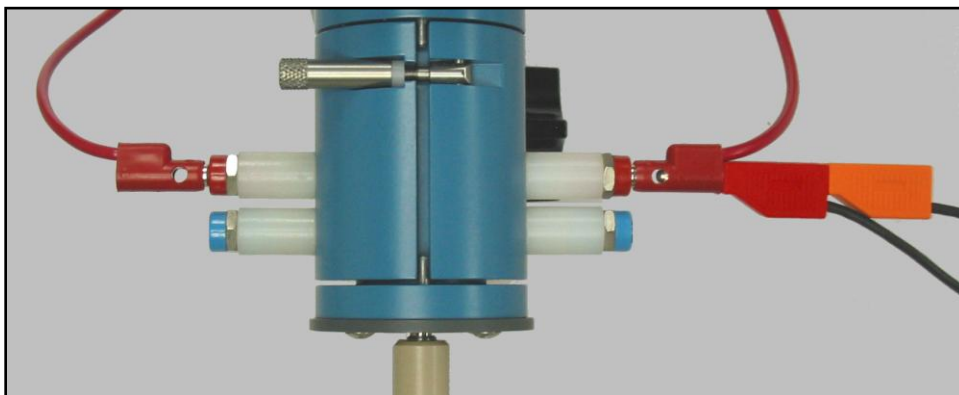


Figure 4.8: Brush Connections for a Rotating Disk Electrode (RDE) or a Rotating Cylinder Electrode (RCE)

Tip:



Most modern potentiostats provide separate cable connections for the working electrode “drive” line and for the working electrode “sense” line. The drive line carries current while the sense line measures the potential. Both of these lines must be connected to the rotating electrode brushes. (Note that many older potentiostats use only one cable to carry both the drive and sense signals for the working electrode.)

Note:



Cell cables on newer model Pine potentiostats use RED to mark the working electrode “drive” line and ORANGE to mark the working electrode “sense” line. Both of these should be connected to the rotator brushes (see Figure 4.8).

Note:



Older Pine bipotentiostats use only one cable connection for both the “drive” and the “sense” signals. This connection is marked with a YELLOW banana jack on the bipotentiostat front panel.

4.4.2 RRDE Wiring

The lower pair of brush contacts are only used with a rotating ring-disk electrode (see Figure 4.9). The lower pair of brushes (blue) contacts the ring electrode while the upper pair (red) contacts the disk electrode. Banana jumper cables are used to short together the opposing brushes in each pair to assure good contact with both sides of the rotating shaft.

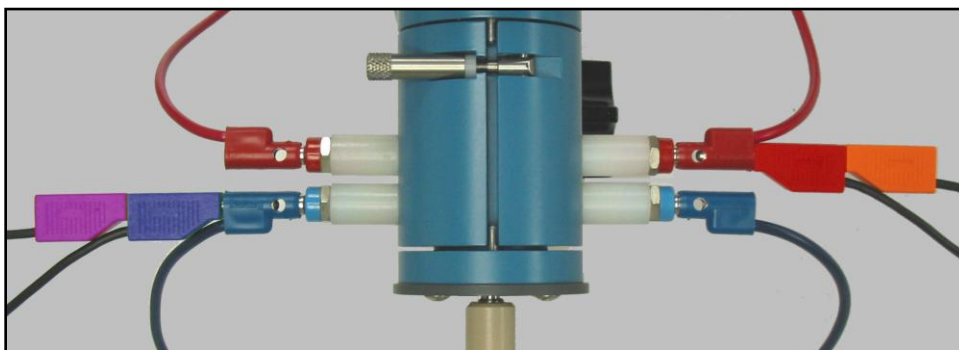


Figure 4.9: Brush Connections for a Rotating Ring-Disk Electrode (RRDE)



Tip:

A bipotentiostat is required when working with a rotating ring-disk electrode. A bipotentiostat provides independent control of two different working electrodes in the same electrochemical cell.



Note:

Cell cables on newer model Pine bipotentiostats use RED and ORANGE to mark the first working electrode drive and sense lines, respectively. Both of these cables must be connected to the upper pair of electrode brushes (red) to contact the disk.

Cell cables on newer model Pine bipotentiostats use BLUE and VIOLET to mark the second working electrode drive and sense lines, respectively. Both of these cables must be connected to the lower pair of electrode brushes (blue) to contact the ring.



Note:

Older Pine bipotentiostats use only one cable for both the “drive” and the “sense” signals. The YELLOW connection corresponds to the disk, and the BLUE connection corresponds to the ring.

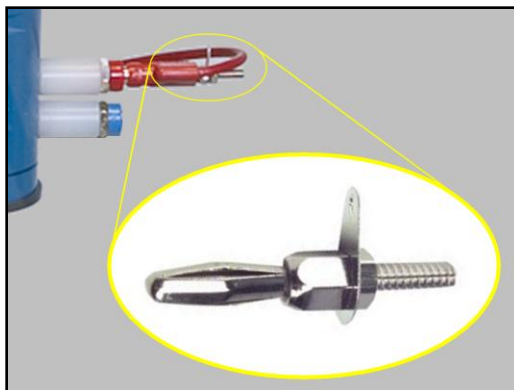


Figure 4.10: Optional Banana Stud for Alligator Clip Connections

The jumper cables used to short the opposing brushes feature stackable banana plugs. If the working electrode cable(s) for the potentiostat also terminate with banana plugs, then these plugs can simply be inserted directly into either end of the jumper cable (see Figure 4.9).

The cell cables for many potentiostats terminate in alligator clips rather than banana plugs. The easiest way to connect such alligator clips is to first insert a banana stud connector into the jumper cable (see Figure 4.10). The small tab on the banana stud provides a good place to attach the alligator clip.

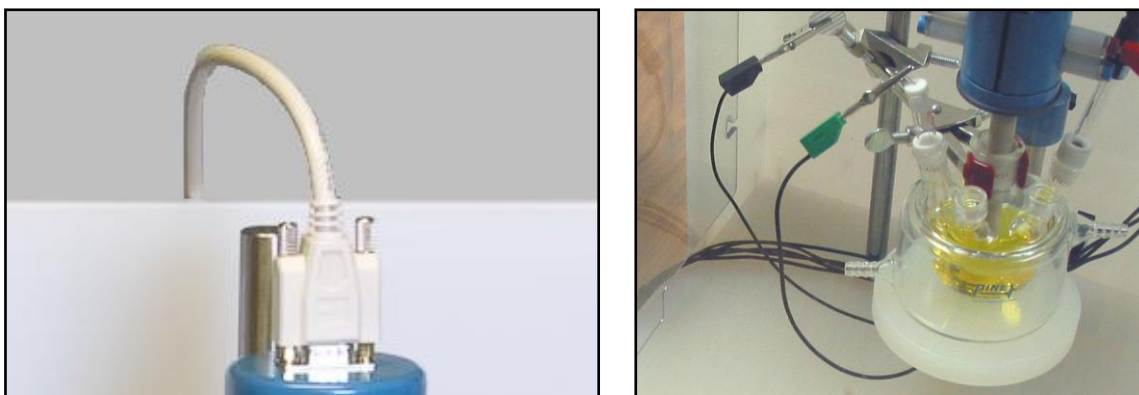


Figure 4.11: Routing Cables out of the Enclosure

4.4.3 Routing Cables and Tubing

The motor control cable may be routed out of the top of the enclosure to connect the motor unit to the control unit. The enclosure has slots along the bottom of the window that provide clearance for routing cell cables and any tubing out of the enclosure. If required, cables and tubing may be routed through the back panel by drilling small holes in the panel. Any such drilled holes should have a diameter no greater than 13.0 mm (0.5 in).

4.4.4 Proper Chassis Grounding

It is important to properly ground all metal objects near an electrochemical cell to the earth ground, and this generally includes the metal chassis of the potentiostat, the motor unit chassis, the control unit chassis, and the clamps used to physically secure the electrochemical cell.



Note:

When working with electrochemical equipment, it is important to understand the meanings of terms such as “chassis ground”, “earth ground”, “DC common”, “signal common”, and “floating ground”.

The term chassis ground refers to the grounding connection for the metal case surrounding an instrument. The chassis ground on the control unit and on most (but not all) potentiostats is connected to the “third prong” of the power cord. In a modern laboratory environment, the third prong of the power source is normally connected to the earth. In this circumstance, the “chassis ground” is also called the “earth ground”.

While the details of proper grounding for any given potentiostat model may differ, the general idea is to bring all of the chassis ground connections together to one particular point to avoid creating “grounding loops”. Many potentiostats have a convenient connection point for the chassis ground, so this connection point often serves as a common point to which all of the other chassis ground lines are connected.

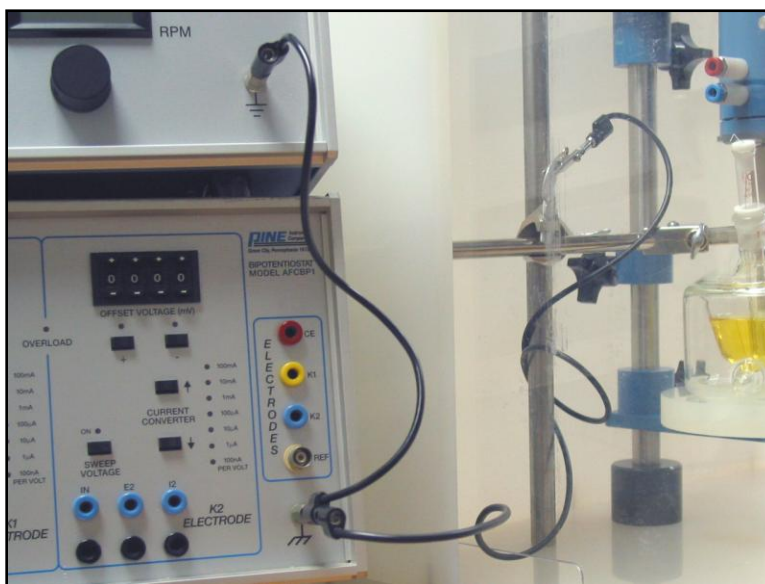


Figure 4.12: Typical Chassis Ground Connections

An example of a central chassis grounding point is provided (see Figure 4.12). In this example, the chassis ground connection on the front panel of the potentiostat serves as the common grounding point. The chassis ground for the rotator control unit (which is sitting on top of the potentiostat) is connected to the common grounding point using a short banana cable. In addition, the metal clamp holding the electrochemical cell is connected to the common grounding point using another banana cable.

It is also necessary for the metal case around the motor unit to be connected to the common grounding point. This required connection is usually made in an indirect fashion. Because the motor control cable (which connects the motor unit to the control unit) is a shielded cable, the shield assures that the chassis of the motor unit and the chassis of the control unit are electrically connected. Thus, as long as the rotator control unit chassis is connected to the common grounding point on the potentiostat, then the metal case around the motor unit is (indirectly) connected to the common grounding point.



Note:

On some older MSR rotator models, the motor control cable is permanently connected to the control unit, and this cable is not shielded. When working with an older MSR rotator, it is necessary to purposefully make a connection from the motor unit chassis to the common grounding point.

4.4.5 Proper Signal Grounding

The excitation signals applied to the electrochemical cell by the potentiostat and also the response signals measured by the potentiostat are all usually measured with respect to a common “zero” signal. This common signal line is called the “DC common” or the “signal common” or the “analog common” depending upon the particular model of potentiostat being used.

The potentiostat may send or receive analog signals to and from other electronic instruments (such as a digital oscilloscope, an XY recorder, a computer-based data acquisition system, or the rotator control unit). All of these other instruments also have a “DC common” line which represents the common “zero” analog signal level. In general, the act of connecting a potentiostat to each of these other instruments causes the “DC common” lines for each of the instruments to be connected together.

The distinction between the “DC common” and the “chassis ground” is important to maintain and preserve whenever possible. Most potentiostats offer separate connection points for the chassis ground and the DC common, and as long as these connection points are not purposefully shorted together, then the

DC common line is able to “float” with respect to the chassis ground. Such a “floating ground” configuration is required when the potentiostat is used in conjunction with certain other instruments (such as a scanning electrochemical microscope or a quartz crystal microbalance). When working with these types of instruments, it is often important to maintain a separation between the chassis ground and the DC common and to avoid shorting these lines together.

Note:



The MSR control unit offers separate connection points for the chassis ground and the DC common signal. The chassis ground connection is the silver banana post in the lower right corner of the front panel. Any of the black banana jacks on the front and back panels may be used as DC common connections.

But in other cases, the act of deliberately shorting the DC common signal to the chassis ground can reduce the amount of noise in the signals recorded by a potentiostat. When working with a potentiostat connected to a rotator, it may be helpful to try connecting the DC common to the chassis ground to see if this action improves the appearance of voltammograms. But remember that such a connection eliminates the “floating ground” feature of the potentiostat.

It is also important for potentiostat users to be aware of cases where the “floating ground” feature is indirectly compromised by a hidden connection. These cases can occur when multiple instruments and/or computers are interconnected and being used together as a system. For example, the rotation rate is often externally controlled via a signal from a potentiostat (see Section 4.6.3). Such a connection necessarily connects the DC common on the potentiostat to the DC common on the rotator control unit. This connection, in itself, is not enough to cause an indirect short between DC common and the chassis ground.

However, it is very likely that the potentiostat is connected to a computer via a shielded communications cable. The shield line in the cable may cause the DC common of the potentiostat to be connected to the DC common of the computer. Then, depending upon the internal design of the computer, the DC Common may be connected to the chassis ground at some point inside the computer. And, of course, the chassis ground connections for the computer, the rotator, and the potentiostat are all very likely to be connected to the very same earth ground via their respective power cables.

The elaborate path described in the previous paragraph causes the DC common on the potentiostat and the rotator to be shorted to the chassis ground (and the earth ground) via the power cables. This highly indirect

connection is not readily apparent during a casual inspection of the overall system. Tracking down this kind of indirect connection often involves careful investigation and the use of an ohmmeter.

4.5 Using the Rotator in a Glove Box

The rotator may be placed in a glove box when working with air or moisture sensitive compounds. A smaller base (sold separately) is available for use in a glove box (see Figure 4.13).

It is important to understand that the low humidity environment found in most glove boxes increases the rate of wear on both the brush contacts and the internal brushes within the motor itself.

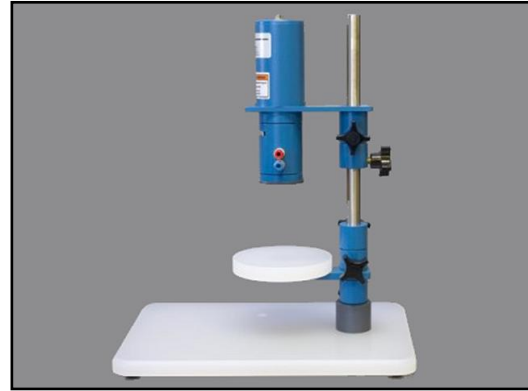


Figure 4.13: Glove Box Configuration

To mitigate the wear rate of the brush contacts, it is recommended that four special low-humidity brushes (sold separately) be installed prior to placing the rotator in the glove box. Contact the factory for more details.



CAUTION:

Using the rotator in a dry environment such as a low humidity glove box will increase the wear rate of the internal motor brushes. See section 6.5 for more information about how to replace a worn motor.

4.6 Rotation Rate Control



CAUTION:

Always turn the rotation rate control knob completely counterclockwise before turning on the rotator.



Note:

The fully counterclockwise position corresponds (nominally) to a rotation rate of zero. Even with the knob in this position, there may be some residual rotation (typically less than 10 RPM) in either the clockwise or counter-clockwise direction.

Always begin each session using the rotator with the power turned off and the rotation rate control knob in the fully counterclockwise position. The fully counterclockwise position corresponds to the slowest rotation rate, and it is always safest to turn on the rotator with the knob in this position.

4.6.1 Manual Control of Rotation

To rotate the electrode under manual control, turn on the control unit power and slowly turn the rotation rate control knob clockwise. As the knob is turned clockwise, the rotation rate increases and the display on the control unit shows the rotation rate.

4.6.2 Monitoring the Rotation Rate

The rotation rate is always displayed on the front panel, but it can also be monitored at the output jacks on the front panel of the control unit. The signal presented at the output jacks is a voltage which is proportional to the rotation rate. The proportionality ratio is 1.0 mV/RPM.



Note:

The rotation rate is controlled to within 1.0% of the display value selected using the rotation rate control knob. It is normal for the last one or two digits on the display to flicker.

4.6.3 External Control of the Rotation Rate

It is often convenient for the rotation rate to be controlled via an externally supplied signal. Many potentiostats are capable of providing such a signal to control the rotation rate while simultaneously performing electrochemical measurements. An externally supplied signal is also required when performing hydrodynamically modulated voltammetry, where the rotation rate is varied sinusoidally as electrochemical measurements are made with the potentiostat.

The signal from the potentiostat is a voltage applied to the input jacks on the front panel of the control unit (see Figure 4.14, left). This voltage is proportional to the desired rotation rate. The proportionality ratio is 1.0 RPM/mV, which is the ratio compatible with Pine potentiostats. Other ratios are available for use with other potentiostat models (see Section 6.7).

External control of the rotation rate may involve a signal connection between a potentiostat from one manufacturer being connected to a rotator from another manufacturer. The signals on these various instruments may have been calibrated to different tolerances by each manufacturer. Small signal level differences within these tolerances can add up, causing the actual rotation rate (as displayed on the control unit) to differ slightly from the rotation rate (as specified using the potentiostat software).

**CAUTION:**

If an external voltage signal is used to control the rotation rate, the voltage applied to the input jacks should not exceed ± 10 VDC.

**Note:**

The input impedance across the input jacks is 50K Ω .

**Tip:**

The rotation rate set point is based upon the sum of external voltage signal and the rotation rate control knob setting. It is sometimes useful to use the knob setting to establish a baseline rotation rate while using the external signal to superimpose a smaller magnitude sine wave.

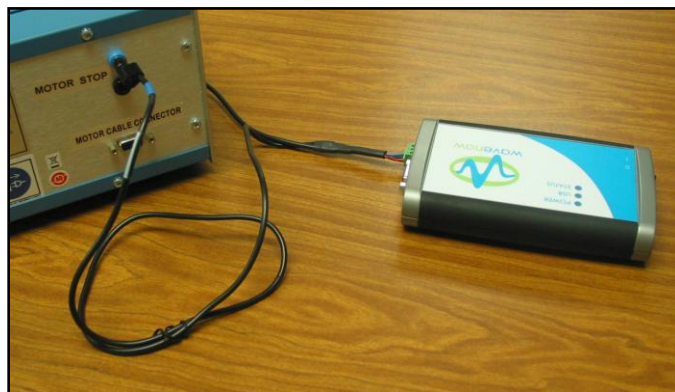
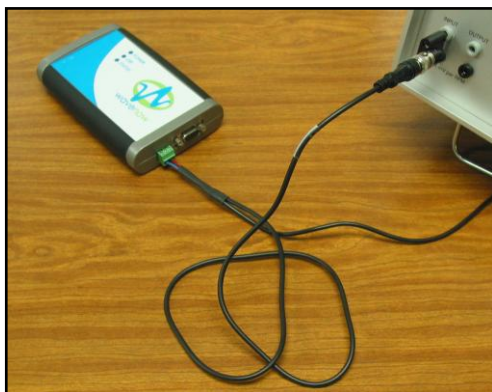


Figure 4.14: External Control of Rotation Rate by a Potentiostat

4.6.4 External Motor Stop Control

An external digital signal can be applied to a pair of banana jacks on the back panel to bring the rotator to a complete stop (see Figure 4.14, right). This digital signal can be used by a potentiostat or other external instrument to assure that the rotation rate is actually zero.

The motor stop signal logic is “active HIGH” by default, meaning that the motor is allowed to rotate if a signal greater than 2.0 volts is applied across the banana jacks. If the two banana jacks are shorted together (i.e., if the motor stop signal is driven to ground), then the motor stops rotating.

If desired, the control unit can be reconfigured for “active LOW” logic (see Section 6.8). In this configuration, a signal greater than 2.0 volts applied to the motor stop banana jacks causes the motor to stop rotating.



Note:

When the control unit is configured for “active HIGH” logic and when no connections are made to the motor stop banana jacks, the motor is allowed to spin. An internal “pull up” circuit assures that the motor stop signal remains “high” in this case.

4.7 Circuit Protection

The power switch on the back panel also acts as a circuit breaker to help protect the control unit circuitry. If the circuit breaker trips, then it can be reset by turning the power switch to the full “off” position and then turning the switch back “on” again.

A secondary circuit breaker on the front panel protects the windings in the motor. If this circuit breaker trips, then it can be reset by pressing the “reset” button on the front panel.

5 Electrodes

5.1 Electrode Handling Precautions

Rotating electrode tips and shafts are precision research tools machined to tight specifications for proper balance when spinning at high rotation rates. When not in use, an electrode tip should be cleaned, dried, and stored in its original case. When working with electrode shafts and tips, special care should be taken not to drop the shaft or tip as this will likely throw the shaft or tip off balance.



CAUTION:

Do not use a shaft or electrode tip if it has been dropped, bent, or otherwise physically damaged.



CAUTION:

Any rotating shaft or tip which wobbles, vibrates, or tilts away from the axis of rotation is either improperly installed or damaged. Do not attempt to use a damaged or improperly installed shaft or tip.



CAUTION:

Each rotating electrode has a maximum rotation rate limitation. Do not exceed the maximum rotation rate.



CAUTION:

Do not apply excessive twisting force to the shroud of an electrode tip when threading it on to the shaft, as this may cause a leak between the shroud and the electrode.



CAUTION:

Position the motor unit with respect to the glass cell so that the electrode tip is immersed ~1.0 cm into the test solution. Excessive immersion may corrode the shaft or tip by allowing liquids to seep into the joint between the shaft and tip.



CAUTION:

Center the rotating electrode within the opening on the cell so that it does not rub against the walls of the opening. Damage will occur if the rotating shaft or tip abrades against these walls.

TEMPERATURE LIMITATIONS:

Electrode tips with Teflon shrouds are designed for use at room temperature (15°C to 30°C). Exposing these tips to colder or warmer temperatures is likely to compromise the seal between the Teflon shroud and the electrode surface.

Electrode tips with PEEK or KEL-F shrouds are available and are better suited for use at elevated temperatures.

**Note:**

After each use of rotating electrode (or electrode tip), clean and dry the electrode and then return it to the plastic storage box in which it was originally shipped.

**Note:**

A polishing kit is available for use in restoring the electrode surface to its original mirror smooth finish. A slurry of microscopic abrasive particles may be used to routinely repolish the electrode surface (usually at the end of each day). In the event of very serious damage to the electrode surface, it is generally better to return the electrode to the factory for professional repolishing.

5.2 Shafts

The rotator accepts a variety of different shaft designs (each sold separately) having a sturdy metal internal shank that is insulated with a polymeric shroud. The upper portion of the shaft is designed to mate with the motor coupling inside the brush chamber (see Figure 4.2). The lower portion of the shaft is protected with a chemically resistant shroud material (Teflon, PEEK, or KEL-F).



Standard RDE & RCE Shaft (12 mm OD)

This lower end of this shaft (part number AFE3M) features a 12.0 mm OD Teflon shroud and a standard 1/4-28 thread. These threads accept RDE and RCE tips with 12.0 mm OD shrouds.

Specifically, this shaft is compatible with E3 & E4TQ Series RDE tips and with classic 12 mm OD rotating cylinder electrode tips.

A bearing assembly for mounting this shaft in a 24/25 ground glass joint is available separately (part number AC01TPA).



Standard RDE & RRDE Shaft (15 mm OD)

This shaft (part number AFE6M) features a 15.0 mm OD PEEK shroud along most of its length. The lower end of the shaft has an internal taper and 3/8-24 threads designed to accept RDE and RRDE tips which have a 15.0 mm OD.

Specifically, this shaft is compatible with E5, E5TQ & E5HT Series RDE tips. It is also compatible with E6 & E7 Series RRDE tips.



Precision RDE & RRDE Shaft (15 mm OD) (for use with gas-purged bearing assembly)

This shaft (part number AFE6MB) has a precision machined 15.0 mm outer diameter which is specially designed to mate with the 15.0 mm inner diameter of a gas-purged bearing assembly (part number AC01TPA6M).

This shaft is compatible with E5, E5TQ, E5HT, E6 & E7 Series tips.



Precision RCE Shaft (15 mm OD) (for use with gas-purged bearing assembly)

This shaft (part number AFE9MBA) has a precision machined 15.0 mm outer diameter which is specially designed to mate with the 15.0 mm inner diameter of a gas-purged bearing assembly (part number AC01TPA6M).

This shaft has a PEEK shroud and accepts cylinder inserts which are 15.0 mm OD x 6.3 mm tall. The cylinder inserts are sealed between a pair of rubber washers.



Precision Gas-Purged Bearing Assembly (15 mm ID)

This gas-purged bearing assembly (part number AC01TPA6M) fits into the 24/25 center port on an electrochemical cell. A small plastic hose barb on the side of the assembly allows the space within the bearing assembly to be purged with an inert gas.



The main body of the assembly is made from chemically resistant PEEK polymer, and the bearing is ceramic.

Although the bearing is not perfectly sealed, the inner diameter of the bearing (15 mm ID) allows a precision machined shaft (15 mm OD) to pass through the bearing assembly with a reasonably tight fit.



Simple Taper Plug Assembly (12 mm ID)

This bearing assembly (part number AC01TPA) fits into the 24/25 center port on an electrochemical cell. The main body of the assembly is made from Teflon, and the bearing is stainless steel. This assembly is compatible with the AFE3M shaft and E2 Series single-piece RDEs. This bearing assembly does not perfectly seal the electrochemical cell.

5.3 RDE Tips

The rotator is compatible with a variety of RDE tips (sold separately), and each tip design is compatible with one or more shafts as described below.



E3 Series RDE Tips

These RDE tips feature a 12 mm OD Teflon shroud around a 5 mm OD disk electrode. These tips fit the standard RDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk materials include gold, platinum, and glassy carbon. Other disk and shroud materials are available upon request.

Part Numbers

Standard RDE Shaft (for 12 mm OD RDE tips)	AFE3M
Glassy Carbon RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050GC
Basal Plane Pyrolytic Graphite RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050GB
Edge Plane Pyrolytic Graphite RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050GE
Aluminum RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050AL
Copper RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050CU
Gold RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050AU
Nickel RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050NI
Palladium RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050PD
Platinum RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050PT
Silver RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050AG
Tantalum RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050TA
Titanium RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050TI
Tungsten RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050W
Zinc RDE tip (5 mm OD disk, 12 mm OD shroud)	AFE3T050ZN



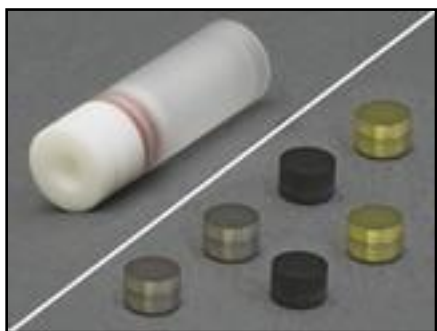
MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E4TQ Series ChangeDisk RDE Tips

These RDE tips feature a 12 mm OD Teflon holder which can accept a removable disk insert. These tips fit the standard RDE shaft and may be used at rotation rates up to 2000 RPM. The disk insert (5 mm OD x 4 mm thick) is typically fabricated from fabricated from gold, platinum, or glassy carbon. Other disk materials are available upon request.

Part Numbers

Standard RDE Shaft (for 12 mm OD RDE tips)	AFE3M
ChangeDisk RDE tip (12 mm OD shroud, accepts 5 mm OD x 4 mm thick disks)	AFE4TQ050
Toolkit (for removing and polishing disk inserts)	AFE4K050
Glassy Carbon Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GC
Basal Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GB
Edge Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GE
Aluminum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AL
Copper Disk Insert (5 mm OD x 4 mm thick)	AFED050P040CU
Gold Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AU
Nickel Disk Insert (5 mm OD x 4 mm thick)	AFED050P040NI
Palladium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PD
Platinum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PT
Silver Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AG
Tantalum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TA
Titanium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TI
Tungsten Disk Insert (5 mm OD x 4 mm thick)	AFED050P040W
Zinc Disk Insert (5 mm OD x 4 mm thick)	AFED050P040ZN



MAXIMUM ROTATION RATE: 2000 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E5 Series RDE Tips

These RDE tips feature a 15 mm OD Teflon shroud around a 5 mm OD disk electrode. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk materials include gold, platinum, and glassy carbon. Other materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
Glassy Carbon RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050GC
Basal Plane Pyrolytic Graphite RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050GB
Edge Plane Pyrolytic Graphite RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050GE
Aluminum RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050AL
Copper RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050CU
Gold RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050AU
Nickel RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050NI
Palladium RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050PD
Platinum RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050PT
Silver RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050AG
Tantalum RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050TA
Titanium RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050TI
Tungsten RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050W
Zinc RDE tip (5 mm OD disk, 15 mm OD shroud)	AFE5T050ZN



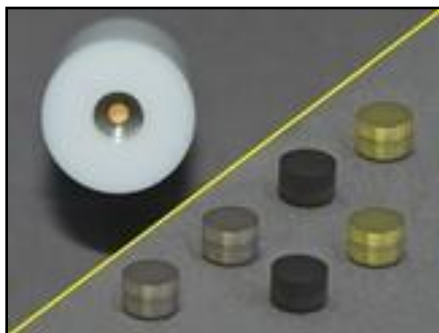
MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E5TQ Series ChangeDisk RDE Tips

These RDE tips feature a 15 mm OD Teflon shroud which accepts a 5 mm OD removable disk insert. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2000 RPM. Standard disk inserts are fabricated from gold, platinum, and glassy carbon. Other disk materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
ChangeDisk RDE tip (15 mm OD shroud, accepts 5 mm OD x 4 mm thick disks)	AFE5TQ050
Toolkit (for removing and polishing disk inserts)	AFE6K050
Glassy Carbon Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GC
Basal Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GB
Edge Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GE
Aluminum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AL
Copper Disk Insert (5 mm OD x 4 mm thick)	AFED050P040CU
Gold Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AU
Nickel Disk Insert (5 mm OD x 4 mm thick)	AFED050P040NI
Palladium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PD
Platinum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PT
Silver Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AG
Tantalum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TA
Titanium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TI
Tungsten Disk Insert (5 mm OD x 4 mm thick)	AFED050P040W
Zinc Disk Insert (5 mm OD x 4 mm thick)	AFED050P040ZN



MAXIMUM ROTATION RATE: 2000 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E5HT Series HotSpot RDE Tips

These RDE tips feature a 15 mm OD PEEK shroud around a 5 mm OD disk electrode. The PEEK shroud permits these RDE tips to be used at temperatures up to 80°C. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk materials include gold, platinum, and glassy carbon. Other materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
Glassy Carbon HotSpot RDE tip (5 mm OD disk, 15 mm OD shroud, 80°C limit)	AFE5T050GCHT
Aluminum HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050ALHT
Copper HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050CUHT
Gold HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050AUHT
Nickel HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050NIHT
Palladium HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050PDHT
Platinum HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050PTHT
Silver HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050AGHT
Tantalum HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050TAHT
Titanium HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050TIHT
Tungsten HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050WHT
Zinc HotSpot RDE tip (5 mm OD disk, 15 mm OD, 80°C limit)	AFE5T050ZNHT



MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 80°C

Do not use this electrode outside the operating temperature range.



CHEMICAL INCOMPATIBILITY:

The shroud material (PEEK) may be discolored by prolonged exposure to concentrated acids.

Note:



RDE tips with PEEK shrouds are considerably more difficult to polish by hand than tips with Teflon shrouds. Mechanical polishing is recommended if the appropriate equipment is available.

5.4 Single-Piece RDE Designs

Electrode designs where the electrode tip is permanently mounted on the shaft are called “single-piece” electrodes. In general, these designs have higher maximum rotation rates.



E2 Series FastSpeed RDEs

These single-piece rotating disk electrodes are ideal for applications requiring a high rotation rate (up to 7000 RPM). The shroud is fabricated from chemically resistant Teflon. Standard disk materials include gold, platinum, and glassy carbon, but other materials are available upon request.

Part Numbers

Glassy Carbon FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050GC
Basal Plane Pyrolytic Graphite FastSpeed RDE (5 mm OD disk, 12 mm OD shroud) .	AFE2M050GB
Edge Plane Pyrolytic Graphite FastSpeed RDE (5 mm OD disk, 12 mm OD shroud) .	AFE2M050GE
Aluminum FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050AL
Copper FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050CU
Gold FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050AU
Nickel FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050NI
Palladium FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050PD
Platinum FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050PT
Silver FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050AG
Tantalum FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050TA
Titanium FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050TI
Tungsten FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050W
Zinc FastSpeed RDE (5 mm OD disk, 12 mm OD shroud)	AFE2M050ZN



MAXIMUM ROTATION RATE: 7000 RPM

Do not rotate at rates higher than the maximum rotation rate.

CAUTION:



Use extreme caution when rotating electrodes at rates above 2000 RPM. Always secure the enclosure around the rotator before rotating the electrode (see Figure 4.6).

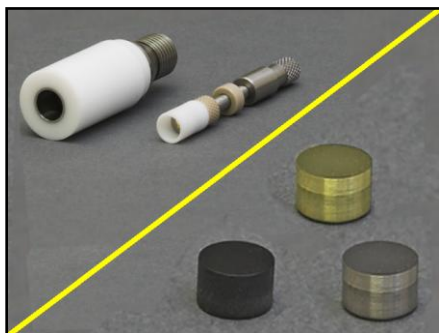


OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.

5.5 RRDE Tips

All RRDE tips have 15 mm OD shrouds made from either Teflon or PEEK. The ring electrode is permanently mounted in the RRDE tip, but the disk electrode may be permanently mounted or removable.



E6 Series ChangeDisk RRDE Tips

These ring-disk electrode tips feature a Teflon shroud and the option to remove and replace the disk insert. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk and ring materials include gold, platinum, and glassy carbon. Other materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
Toolkit (for removing and polishing disk inserts)	AFE6K050
ChangeDisk RRDE Tip (platinum ring, accepts 5 mm OD x 4 mm thick disks)	AFE6R1PT
ChangeDisk RRDE Tip (gold ring, accepts 5 mm OD x 4 mm thick disks)	AFE6R1AU
ChangeDisk RRDE Tip (glassy carbon ring, accepts 5 mm OD x 4 mm thick disks)	AFE6R1GC
Glassy Carbon Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GC
Basal Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GB
Edge Plane Pyrolytic Graphite Disk Insert (5 mm OD x 4 mm thick)	AFED050P040GE
Aluminum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AL
Copper Disk Insert (5 mm OD x 4 mm thick)	AFED050P040CU
Gold Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AU
Nickel Disk Insert (5 mm OD x 4 mm thick)	AFED050P040NI
Palladium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PD
Platinum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040PT
Silver Disk Insert (5 mm OD x 4 mm thick)	AFED050P040AG
Tantalum Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TA
Titanium Disk Insert (5 mm OD x 4 mm thick)	AFED050P040TI
Tungsten Disk Insert (5 mm OD x 4 mm thick)	AFED050P040W
Zinc Disk Insert (5 mm OD x 4 mm thick)	AFED050P040ZN



MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E7 Series ThinGap RRDE Tips

These ring-disk electrode tips feature a Teflon shroud and a thin gap (180 or 320 μm) between the permanently mounted disk and ring electrodes. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk and ring materials include gold, platinum, and glassy carbon. Other materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
ThinGap RRDE Tip (glassy carbon disk, gold ring, 320 μm gap)	AFE7R9GCAU
ThinGap RRDE Tip (glassy carbon disk, platinum ring, 320 μm gap)	AFE7R9GCPT
ThinGap RRDE Tip (glassy carbon disk and ring, 320 μm gap)	AFE7R9GCGC
ThinGap RRDE Tip (gold disk and ring, 180 μm gap)	AFE7R8AUAU
ThinGap RRDE Tip (platinum disk and ring, 180 μm gap)	AFE7R8PTPT
ThinGap RRDE Tip (gold disk, platinum ring, 180 μm gap)	AFE7R8AUPT
ThinGap RRDE Tip (platinum disk, gold ring, 180 μm gap)	AFE7R8PTAU



MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 30°C

Do not use this electrode outside the operating temperature range.



E7HT Series HotSpot RRDE Tips

These ring-disk electrode tips feature a PEEK shroud and a Teflon gap between the permanently mounted disk and ring electrodes. The PEEK shroud permits these electrodes to be used at elevated temperatures. These tips fit the standard RRDE shaft and may be used at rotation rates up to 2500 RPM. Standard disk and ring materials include gold, platinum, and glassy carbon. Other materials are available upon request.

Part Numbers

Standard RDE & RRDE Shaft (for 15 mm OD tips)	AFE6M
HotSpot RRDE Tip (glassy carbon disk, platinum ring)	AFE7R2GCPT
HotSpot RRDE Tip (gold disk, platinum ring)	AFE7R2AUPT
HotSpot RRDE Tip (platinum disk and ring)	AFE7R2PTPT
HotSpot RRDE Tip (glassy carbon disk, gold ring)	AFE7R2GCAU
HotSpot RRDE Tip (gold disk and ring)	AFE7R2AUAU
HotSpot RRDE Tip (platinum disk, gold ring)	AFE7R2PTAU



MAXIMUM ROTATION RATE: 2500 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 80°C

Do not use this electrode outside the operating temperature range.



CHEMICAL INCOMPATIBILITY:

The shroud material (PEEK) may be discolored by prolonged exposure to concentrated acids.



Note:

RRDE tips with PEEK shrouds are considerably more difficult to polish by hand than those with Teflon shrouds. Mechanical polishing is recommended if the appropriate equipment is available.

5.6 RCE Tips

Two styles of rotating cylinder electrode tips are available, each with a different outer diameter (12 or 15 mm OD). The older 12 mm OD design is still supported, but new RCE users are encouraged to begin working with the newer 15 mm design. The 15 mm design is generally offered in conjunction with a special one liter glass cell designed specifically for use with the 15 mm OD RCE system.



15 mm OD RCE System

A typical 15-mm OD RCE system includes a 15 mm OD RCE shaft (part number AFE9MBA), a one liter corrosion cell (part number AFCELL8), and a gas-purged bearing assembly (part number AC01TPA6M). The shaft is able to accept standard cylinder samples (15 mm OD x 6.3 mm tall) fabricated from carbon steel or various stainless steels. Other materials are available on request.



MAXIMUM ROTATION RATE: 4000 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 80°C

Do not use this electrode outside the operating temperature range.



12 mm OD RCE Tips

Traditional 12 mm OD RCE tips accept cylinder inserts (12 mm OD x 7.96 mm tall) fabricated from carbon or stainless steel. Other materials are available on request. This RCE tip fits on to the standard RDE/RCE shaft (shaft part number AFE3M). New RCE users are encouraged to consider the 15 mm OD RCE system instead.



MAXIMUM ROTATION RATE: 2000 RPM

Do not rotate at rates higher than the maximum rotation rate.



OPERATING TEMPERATURE RANGE: 15°C to 80°C

Do not use this electrode outside the operating temperature range.

6 Maintenance

6.1 Routine Cleaning

Regular maintenance of the rotator primarily consists of keeping the external surfaces of the system clean by wiping them with a towel moistened with water or a mild, non-abrasive cleaner.

After about two weeks of continuous use, open the brush chamber and vacuum out any dust or debris. If necessary, remove the lower bearing assembly for better access to the brush chamber (see section 6.3), and use a towel moistened with water or a mild, non-abrasive cleaner to clean the inner surfaces of the brush chamber.

The electrode brushes may deposit silver-carbon dust inside the brush chamber and deposit a film on the surface of the rotating shaft. A thin film on the shaft actually improves the contact between the brush and the shaft does not need to be cleaned unless the film is rough or bumpy.

6.2 Brush Replacement

The brushes contact the rotating shaft, slowly wearing during normal use, and periodically, the brushes must be replaced. A simple brush replacement kit is available, or in the case of serious damage to the entire brush assembly, the brush and its Teflon holder can be replaced.

6.2.1 Internal Brush Replacement



DISCONNECT POWER:

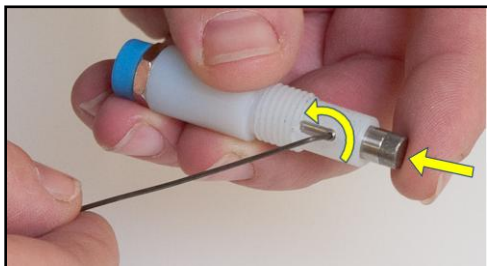
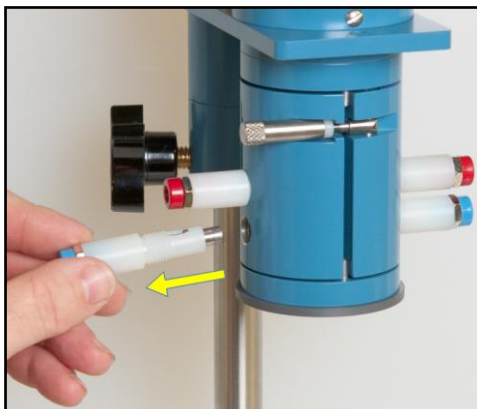
Before replacing a brush, turn off the power to the rotator and disconnect the power cord from the power source.



The standard brush replacement kit (part number ACAR063RM) contains a small hex key, a new brush, and a new set screw (installed in the brush).

A special brush replacement kit (part number ACAR063LHM) should be used when the rotator is routinely operated in low humidity conditions such as inside a glove box.

Remove the entire brush assembly from the rotator by unscrewing it as shown below. It should be possible to remove the brush assembly by hand.

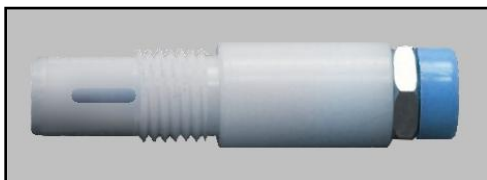


Use the small hex key to remove the set screw. Note that the required hex key (0.035") is included with the brush replacement kit.

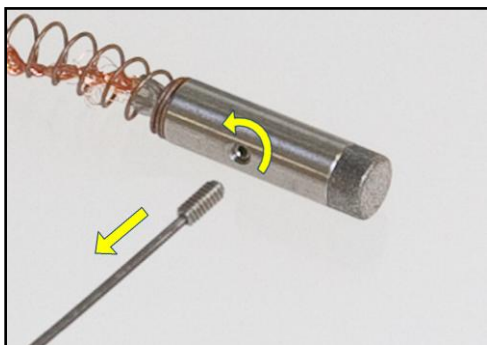


Note:

The brush is spring-loaded. When you remove the set screw, the brush will tend to fly out of the brush holder. Use a finger to hold it in place as you are removing the set screw.



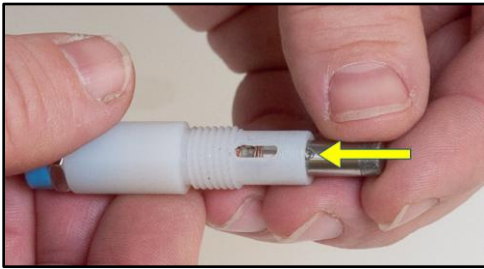
After removing the set screw, remove and discard the old brush, but do not discard the empty brush holder.



The new replacement brush includes a set screw which is already installed.

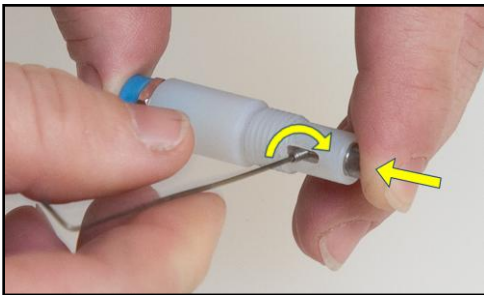
Temporarily remove this set screw.

Be careful not to misplace the set screw.



Carefully slide the new spring-loaded brush into the brush holder.

Be careful to properly align the set screw hole with the slot on the side of the brush holder.



While squeezing the new brush into the brush holder, use the hex key to reinstall the set screw.

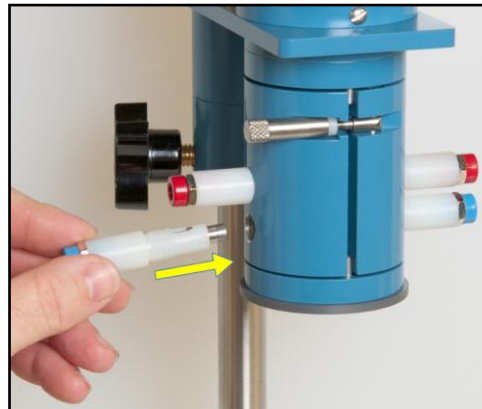
Tighten the set screw until it stops turning.



Note:

The set screw should protrude slightly into the slot, and the brush should be free to travel to the extent permitted by the width of the slot.

Reinstall the brush assembly by threading it back into the side of the rotator. Hand-tighten the brush assembly. Do not use tools to tighten the assembly.



INTENTIONAL WEAR PERIOD:



After installing a new brush, install a shaft and allow the rotator to run at 1000 RPM for at least eight (8) hours. This rotation period wears a concave groove into the new brush. This intentional wear actually improves the electrical contact between the brush and the shaft.

6.2.2 Complete Brush Assembly Replacement

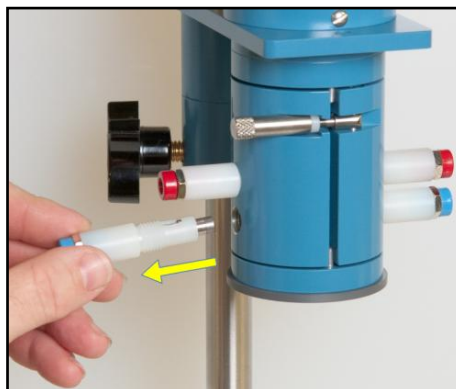
In the event that the main body of the brush assembly is damaged, it may be necessary to replace the entire brush assembly.



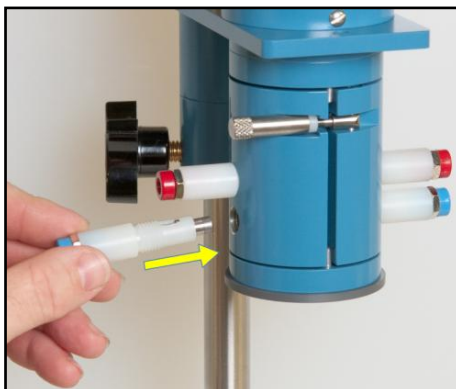
DISCONNECT POWER:

Before replacing a brush, turn off the power to the rotator and disconnect the power cord from the power source.

Remove the old brush assembly from the rotator by unscrewing it as shown below. Remove the old brush assembly by hand. (Use tools only if necessary!)



Install the new brush assembly by threading it by hand into the side of the rotator. Do not use tools to tighten the brush assembly.



INTENTIONAL WEAR PERIOD:



After installing a new brush, install a shaft and allow the rotator to run at 1000 RPM for at least eight (8) hours. This rotation period wears a concave groove into the new brush. This intentional wear actually improves the electrical contact between the brush and the shaft.

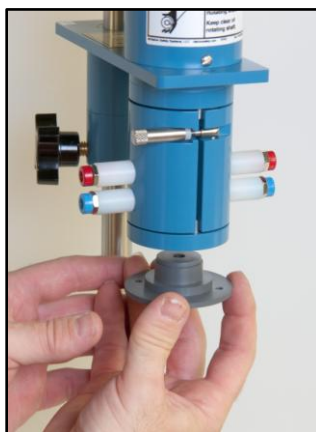
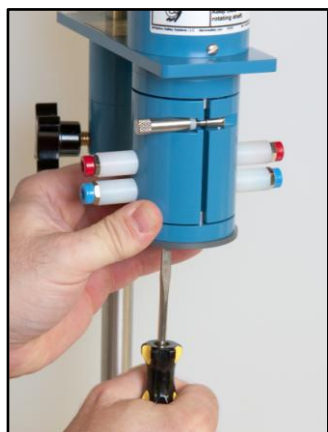
6.3 Lower Bearing Replacement

The lower bearing assembly is a common replacement item due to mechanical wear and also due to exposure to corrosive vapors from the cell solution. The standard lower bearing assembly (part number ACMR3301X) contains a stainless steel bearing which is generally resistant to corrosive attack. In laboratories where particularly corrosive solutions are used, an assembly based on a ceramic bearing (part number ACMR3302) can be used instead.



DISCONNECT POWER:

Before replacing the lower bearing assembly, turn off the power to the rotator and disconnect the power cord from the power source.



Disconnect the motor control cable from the connector on top of the motor unit. If there is a shaft presently installed the motor unit, remove the shaft. Disconnect any signal cables from the brush banana jacks (red and blue).

Use a flathead screwdriver to loosen the four screws that secure the lower bearing assembly to the motor unit. As you are loosening the final screw with one hand, catch the bearing assembly with your other hand.



Note:

After the bearing assembly has been removed, it is a good idea to clean or vacuum out any debris in the brush chamber.

Align the four screw holes on the new bearing assembly with the four threaded holes in the motor unit.

Thread the four screws into the holes by hand. Then, tighten the screws with a flathead screwdriver.

6.4 Removing the Motor-Coupling Assembly

On rare occasions (such as when replacing a failed motor), it may be necessary to remove the motor-coupling assembly from the motor unit.



DISCONNECT POWER:

Before removing the motor-coupling assembly, turn off the power to the rotator and disconnect the power cord from the power source.

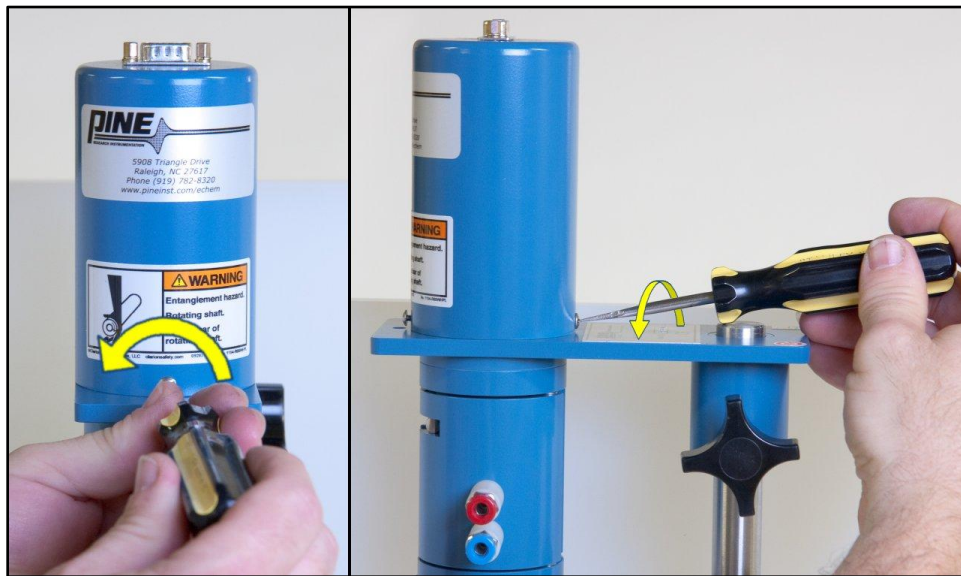
Disconnect the motor control cable from the top of the motor unit.

If there is a shaft presently installed in the motor unit, remove the shaft.

Disconnect any signal cables from the brush banana jacks (red and blue).

There are two screws which hold the cowling in place (front and back).

Use a flathead screwdriver to remove these two screws from the cowling.



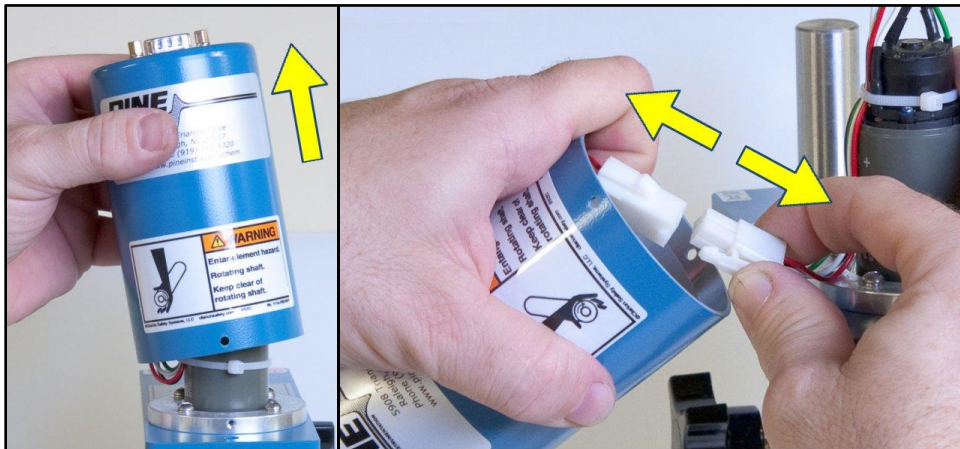
Carefully begin removing the cowling from the motor unit.

The internal cable assembly will prevent the cowling from being completely removed.

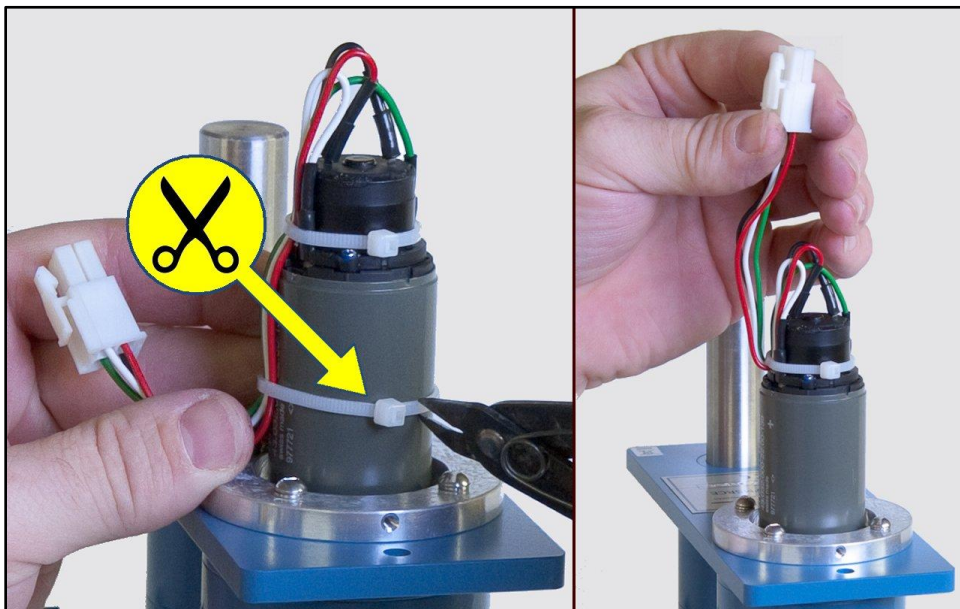
However, there is a junction in the middle of the internal cable assembly where two white connectors are joined together.

By disconnecting the cable assembly at this junction, it is possible to remove the cowling completely.

Disconnect the junction by releasing the locking mechanism that holds the connectors together.



The internal cables are secured to the motor using two plastic cable ties. In order to remove the motor, the lower cable tie must be cut and removed.



CAUTION:

DO NOT REMOVE the upper cable tie. The upper cable tie protects the fragile connections to the motor.



Note:

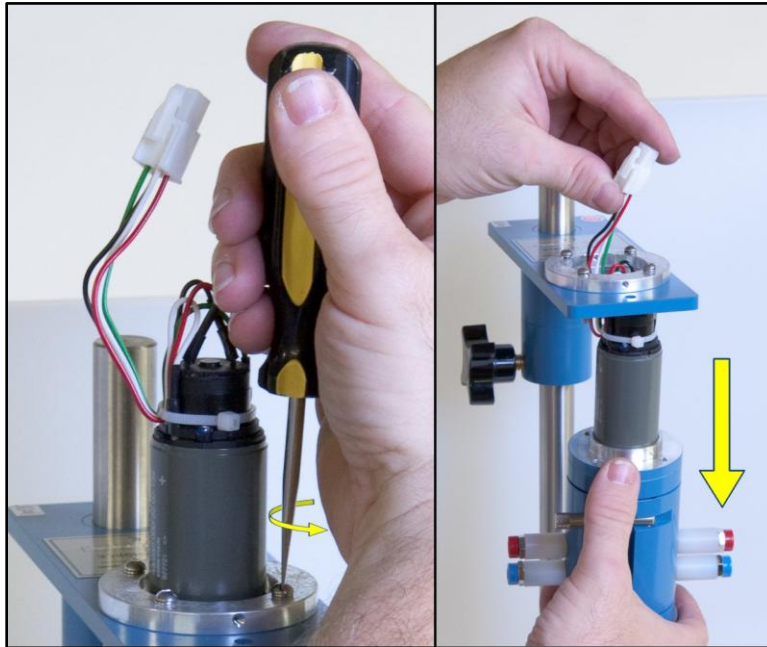
The red (positive) and black (negative) lines are connected to the tachometer, and the white (positive) and green (negative) lines are connected to the motor.

There are four screws which hold the motor in place.

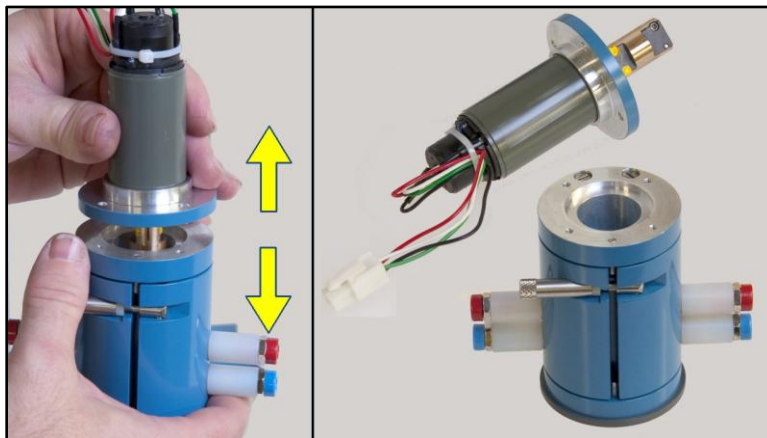
Using a flathead screwdriver, loosen and remove these four screws.

As the fourth and final screw is being removed, be sure to support the motor and brush chamber from below to prevent damage from a sudden fall.

Carefully lower the motor out of the support while guiding the fragile motor and tachometer cables through the support.



Carefully separate the motor from the brush chamber.



Note:

After the motor has been removed, it is a good idea to clean or vacuum out any debris in the brush chamber.

6.5 Installing a New Motor-Coupling Assembly

After removing the old motor-coupling assembly (see above), a new motor-coupling assembly may be installed.



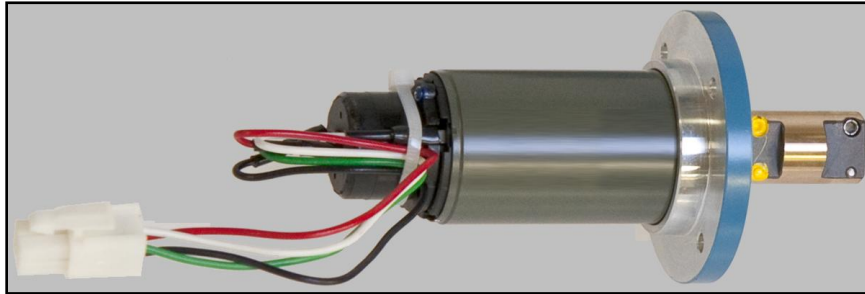
DISCONNECT POWER:

Before installing the motor-coupling assembly, turn off the power to the rotator and disconnect the power cord from the power source.

Disconnect the motor control cable from the top of the motor unit.

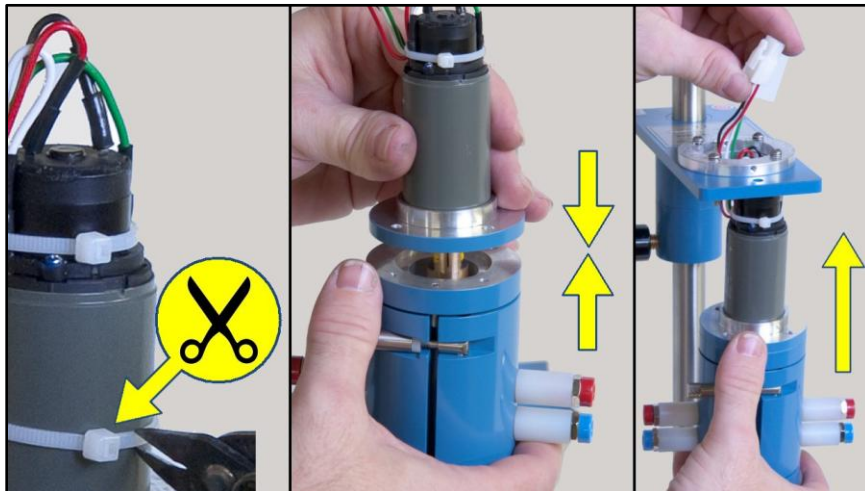
Disconnect any signal cables from the brush banana jacks (red and blue).

Examine the new motor coupling unit. There should be one cable tie securing the cables to the motor (black) as shown below. Do not remove this cable tie.



Remove any extra cable ties (i.e. around the green part of the motor) so that the cable can move freely.

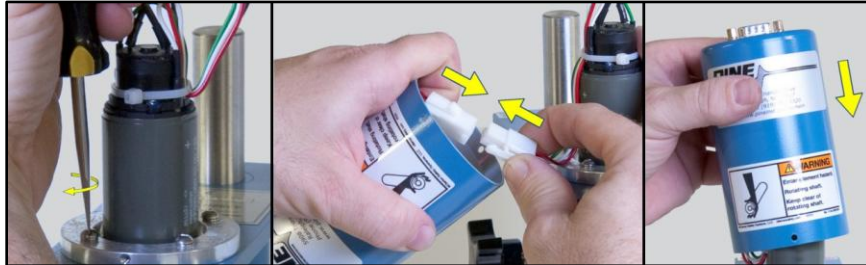
Align the threaded holes in the new motor with those in the brush chamber and push the motor up into the support. Carefully feed the cables through the hole as shown in the figure below.



Secure the motor and chamber to the support using four screws.

Connect the internal cable within the cowling to the motor by joining the two white connectors together.

Replace the cowling on top of the motor and secure it with two screws.



CAUTION:

After installing a new motor, it is necessary to recalibrate the rotation rate using an optical tachometer (see Figure 6.1).

6.6 Rotation Rate Calibration

The rotation rate is controlled by a tunable analog feedback circuit located inside the control unit. This circuit is tuned and calibrated at the factory prior to shipment, but if the rotator needs to be recalibrated by the owner at a later date, the procedure below describes the best method for calibrating and verifying the rotation rate control circuit.

The most important tool required for calibrating the rotator is a non-contact **optical tachometer**. Pine offers such a simple tachometer (see Figure 6.1) as part of the MSR Calibration Kit (part number AKMSRCAL, sold separately), and this simple tachometer is suitable for routine verification or calibration of the rotation rate by the owner.

In the event that the rotation rate must be rigorously traceable to a national or international standards organization, a more sophisticated and professional tachometer with traceable certification should be used (see Figure 6.2). When a rotator is manufactured at the factory (or when a rotator is returned to the factory for service), Pine uses a traceable tachometer to perform the recalibration.

The tachometer reads the rotation rate when it is pointed at a rotating shaft equipped with a **reflective target** (see Figure 6.3). The MSR Calibration Kit includes a shaft suitable for use as a target. Alternately, a stainless steel rod (1/4" OD x 5" L; 6.35 mm OD x 100 mm L) may be mounted in the motor coupling, and a mark can be made on the rod with a marker.

The calibration process involves making adjustments to various trimmer potentiometers (trimmers) on the circuit board. The MSR Calibration Kit includes a **trimmer adjustment tool** for this purpose. Alternately, a small flathead screwdriver can be used to make these adjustments.

A calibrated **digital voltmeter** is required to confirm certain signal levels on the circuit board. It is recommended that a 4 ½ digit voltmeter be used for this purpose. The calibration process also requires a **known voltage source** (1000 mV). This known source can be a power supply or waveform generator, and the value of the known voltage (1000 mV) should be verified using the calibrated digital voltmeter.

Other tools required are a medium sized **Phillips screwdriver** (to remove the top panel of the control unit) and a small (5/64") **hex key** (to turn the hex screws on the motor coupling when installing or removing a shaft). The hex key is included with the purchase of a new rotator but can be reordered (part number THWA078) or purchased at many retail hardware supply stores.



Figure 6.1: Rotator Calibration Toolkit (including simple handheld tachometer)



Figure 6.2: Professional Optical Tachometer with Traceable Calibration

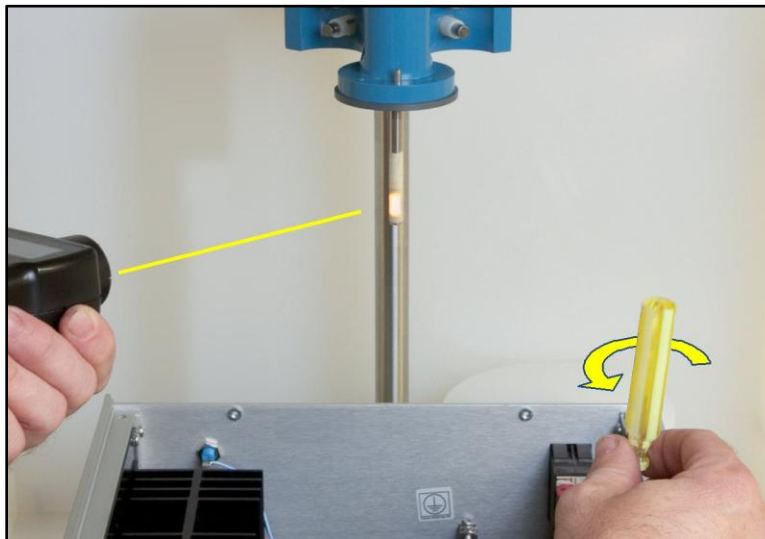


Figure 6.3: Use of Optical Tachometer with Reflective Target

**CAUTION:**

This procedure requires working inside the control unit while the control unit is powered on and operating.

HIGH VOLTAGES ARE PRESENT INSIDE THE CONTROL BOX!

KEEP HANDS AND TOOLS AWAY FROM THE POWER ENTRY MODULE AND THE TWO POWER SUPPLY MODULES!

**CAUTION:**

Electronic components may be damaged by static electricity. Ensure proper grounding when handling static sensitive components by wearing a grounding strap.

**CAUTION:**

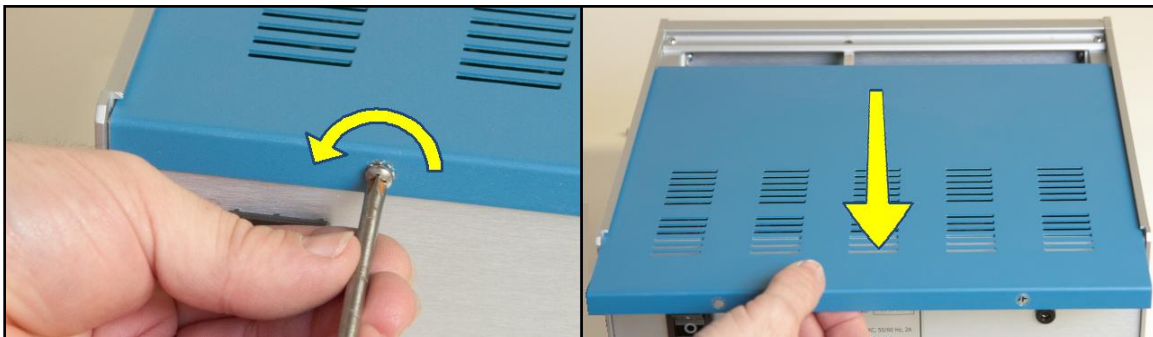
Many optical tachometers use a laser beam as a light source. Do not look directly at the laser beam. Do not point the laser beam into the eye.

**Note:**

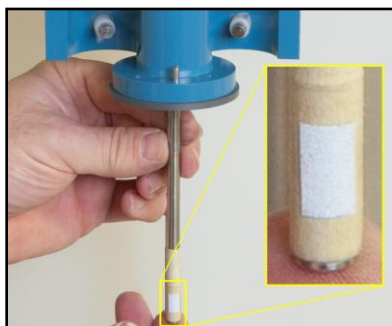
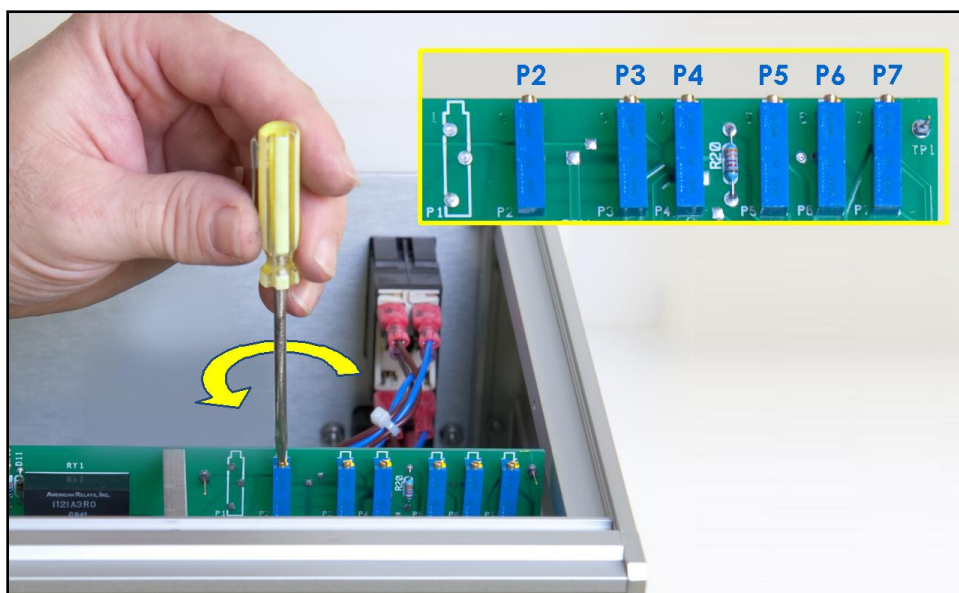
When performing a traceable rotation rate calibration, verify the dates on the calibration certificates for the tachometer and voltmeter and confirm that the certificates have not expired.

Switch off power to the rotator and disconnect the power cord.

With the power cord disconnected, remove the cover from the control unit.



While the power is switched off, note the positions of the various trimmers located along the top of the main circuit board. A trimmer adjustment tool (or a flathead screwdriver) is required to adjust these trimmers.



While the power is switched off, install the tachometer target into the motor coupling on the motor unit.

This target should be a metal rod with the appropriate diameter (1/4" or 6.35 mm).

Many tachometers require that a piece of reflective tape be attached to the end of the shaft as shown.

Turn the rotation rate knob fully counter-clockwise. This is the position which corresponds to a nearly zero rotation rate.

Reconnect the power cord and carefully switch on the rotator.

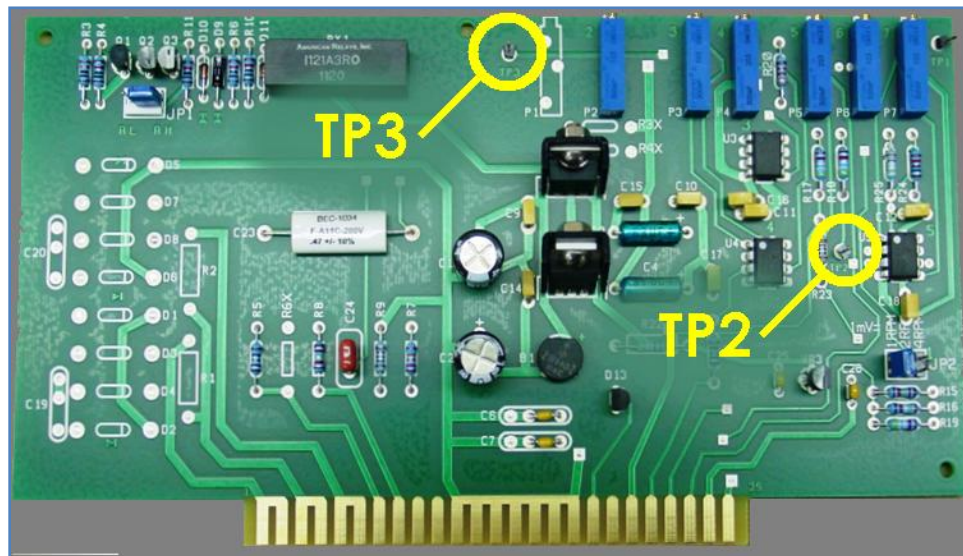
Using the tachometer to monitor the actual rotation rate, slowly adjust the rotation rate knob on the front panel until the tachometer indicates a rotation rate of approximately 2800 RPM.

WAITING PERIOD:



Allow the rotator to rotate at 2800 RPM for one (1) hour before continuing with the calibration process. This waiting period permits all electronic and mechanical components of the rotator system to equilibrate and reach a steady state.

After the one hour waiting period, turn the rotation rate knob fully counter-clockwise. This is the position which corresponds to a nearly zero rotation rate.



Locate testpoints **TP2** and **TP3** on the circuit board. These testpoints are accessible without the need to remove the circuit board from the control unit.

Connect the black lead of the digital voltmeter to one of the two black banana jacks (DC common) on the front panel of the control unit. In the next several steps of the procedure, the red lead on the voltmeter is connected to various testpoints, but the black lead should remain connected to the DC Common jack on the front panel.

Connect the red lead of the digital voltmeter to testpoint **TP3** on the circuit board. Adjust trimmer **P3** until the voltmeter reads **0.0000 VDC \pm 0.0005 VDC**.

Connect the red lead of the digital voltmeter to testpoint **TP2** on the circuit board. Adjust trimmer **P2** until the voltmeter reads **0.0000 VDC \pm 0.0005 VDC**.

Keep the red lead of the digital voltmeter connected to testpoint **TP2** on the circuit board. Adjust trimmer **P3** until the voltmeter reads approximately **0.0125 VDC**. At this point, the motor should be rotating at a very slow rate. The direction of this slow rotation should be counterclockwise when looking down on the motor unit from above.

Turn the rotation rate control knob very slowly until the motor comes to a complete stop. Adjust trimmer **P7** until the rotation rate display on the front panel reads **0000 \pm 1**.

Connect the red lead of the digital voltmeter to the OUTPUT signal jack on the front panel. Confirm that the signal level at this jack is **0.000 VDC** \pm 0.001 VDC.

Using the tachometer to monitor the actual rotation rate, slowly adjust the rotation rate knob on the front panel until the tachometer indicates a rotation rate of **3000 RPM** \pm 1 RPM.

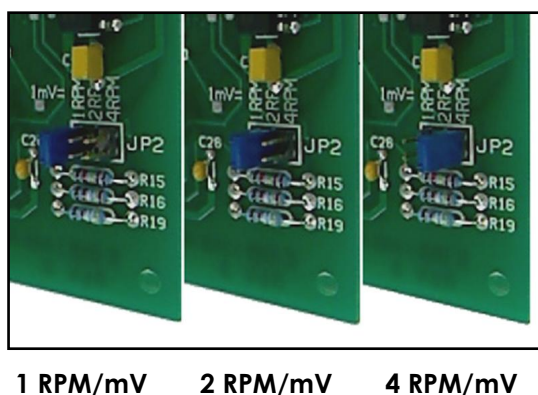
While the shaft is rotating at 3000 RPM, adjust trimmer **P6** until the rotation rate display on the front panel of the control unit reads **3000** \pm 1.

Connect the red lead of the digital voltmeter to the OUTPUT signal jack on the front panel. Confirm that the signal level at this jack is **3.000 VDC** \pm 0.001 VDC.

Slowly turn the rotation rate control knob counterclockwise until the motor comes to a complete stop.

Connect a DC voltage source to the rotation rate input signal jacks on the front panel of the control unit. The positive lead from the voltage source should be connected to the INPUT signal jack (gray banana jack), and the negative lead from the voltage source should be connected to the DC Common (black banana jack).

Determine the input rotation rate ratio of the unit by examining the position of jumper **JP2** on the circuit board. The default position of jumper JP2 is the 1 RPM/mV position, but on some rotator models, it may be in one of the other two positions.



1 RPM/mV

2 RPM/mV

4 RPM/mV



Note:

Some older control units may not have jumper JP2 on the circuit board. In this case, the input rotation rate ratio is printed on the front panel near the INPUT banana jacks.

Using the DC voltage source, apply **1.000 VDC** ± 0.001 VDC to the rotation rate INPUT signal. At this point, the rotation rate display on the front panel should indicate a rotation rate that is approximately **1000 RPM**. Adjust **P5** until the rotation rate display on the front panel reads **1000 RPM** ± 1 RPM (see note below). The optical tachometer should also measure **1000 RPM** ± 1 RPM.



Note:

The previous step assumes that the input rotation rate ratio is 1 RPM/mV. If the unit is configured with a 2 RPM/mV ratio, the display should indicate 2000 RPM. If the unit is configured with a 4 RPM/mV ratio, the display should indicate 4000 RPM.

Disconnect the voltage source from the INPUT jacks on the front panel.

Verify the calibration at the several different rotation rates (suggested rates are 200, 500, 1000, 2000, and 5000 RPM). At each rotation rate, the rotation rate display on the front panel, the rotation rate indicated by the optical tachometer, and the rotation rate indicated at the OUTPUT jack on the front panel should all agree to within one percent (1.0 %). The readings noted during this step should be recorded in a log book or on a certification sheet.



Note:

A convenient certification sheet that can be used to record the verification readings (from the previous step) can be found at the end of this procedure.

Switch off power to the rotator and disconnect the power cord.

Use a small (5/64") hex key to loosen the hex screws in the motor coupling and remove the shaft from the rotator.

Use the hex key to securely retighten the hex screws into the motor coupling.

Close the clamshell doors on the brush chamber and secure the latch.

Secure the enclosure around the rotator motor unit (see Figure 4.6).

CAUTION:

The next part of the calibration procedure involves very high rotation rates at or above 10000 RPM. Before proceeding to the next step, verify that the shaft has been removed from the rotator, verify that the hex screws in the motor coupling are tightened, verify that the clamshell doors are closed and properly latched, and verify that the enclosure is properly secured around the rotator motor unit (see Figure 4.6).

Turn the rotation rate knob fully counter-clockwise. This is the position which corresponds to a nearly zero rotation rate.

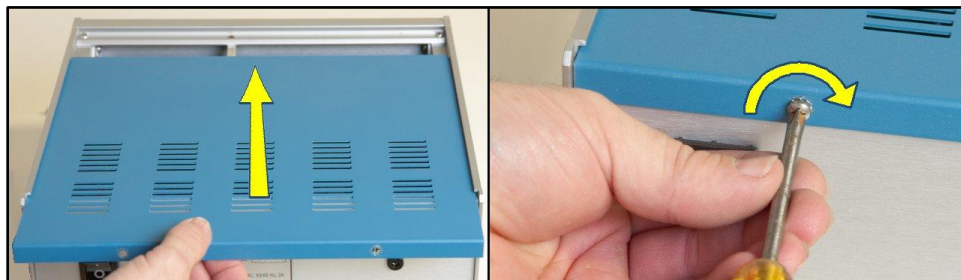
Reconnect the power cord and carefully switch on the rotator.

Slowly turn the rotation rate control knob fully clockwise to the fastest rotation rate. The rotation rate display on the front panel of the control unit should read approximately 10050 RPM. Adjust trimmer **P4** until the rotation rate display on the front panel of the control unit reads **10050 RPM \pm 10 RPM**.

Turn the rotation rate knob fully counter-clockwise. This is the position which corresponds to a nearly zero rotation rate.

Switch off power to the rotator and disconnect the power cord.

Replace the cover on the control unit.



At this point the calibration procedure is complete. Make a note in a log book or place a sticker on the control unit to record the calibration date.

Rotation Rate Calibration Record

Rotator Model and Serial Number

Technician (sign and date here)

Tachometer Make, Model, and SN

Tachometer Calibration Date

Voltmeter Make, Model, and SN

Voltmeter Calibration Date

Control Unit Display and Output Signal Calibration

Control Unit Display Reading	Expected Rotation Rate (RPM)	Tachometer Reading (RPM)	Output Signal (volts)
100	100 ± 2.0		
200	200 ± 2.0		
500	500 ± 5.0		
1000	1000 ± 10.0		
2000	2000 ± 20.0		
5000	5000 ± 50.0		

Control Unit Input Signal Calibration

Input Signal (volts)	Expected Rotation Rate (RPM)	Tachometer Reading (RPM)	Control Unit Display Reading
0.100	100 ± 2.0		
0.200	200 ± 2.0		
0.500	500 ± 5.0		
1.000	1000 ± 10.0		
5.000	5000 ± 50.0		



Note:

Above 200 RPM, rotation rate is certified to be within ± 1.0% of the value on the control unit display. From 100 to 200 RPM, the rate is certified to be within 2 counts of the displayed rate.



Note:

The control unit and motor unit must be calibrated together as a system. This certification is valid only for the particular motor and control units with the serial number listed above.

6.7 Changing the Input Rotation Rate Ratio

The rotation rate can be controlled by applying an external voltage signal to the input jacks on the front panel of the control unit. The proportionality ratio used to convert the applied voltage signal to the rotation rate can be one of three different values. By default, the rotator ships with this ratio configured to 1.0 RPM/mV (compatible with Pine potentiostat systems). This ratio can be changed to 2.0 RPM/mV or to 4.0 RPM/mV (for use with other potentiostats).



DISCONNECT POWER:

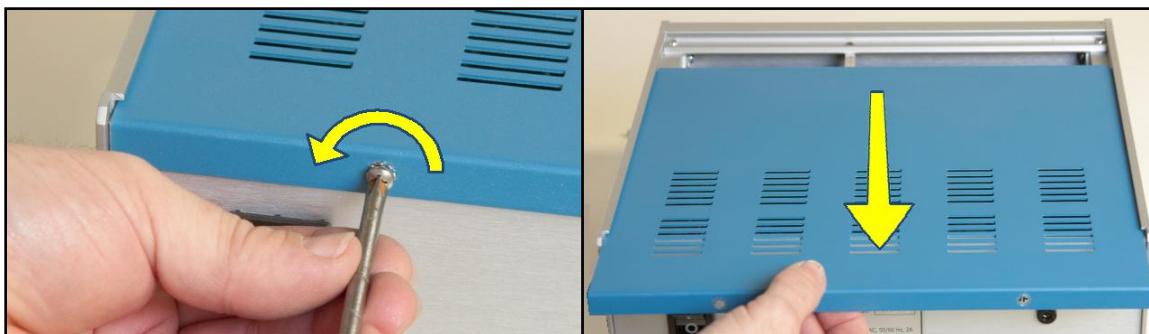
Before removing the control unit cover, turn off the power switch and disconnect the power cord from the power source.



CAUTION:

Electronic components may be damaged by static electricity. Ensure proper grounding when handling static sensitive components by wearing a grounding strap.

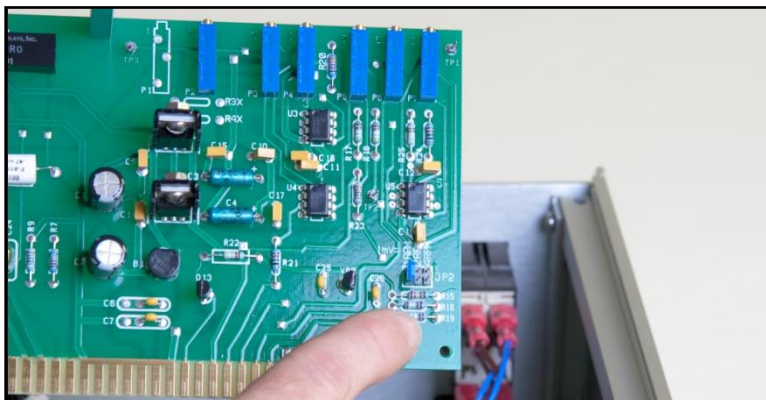
With the power cord disconnected, remove the cover from the control unit.



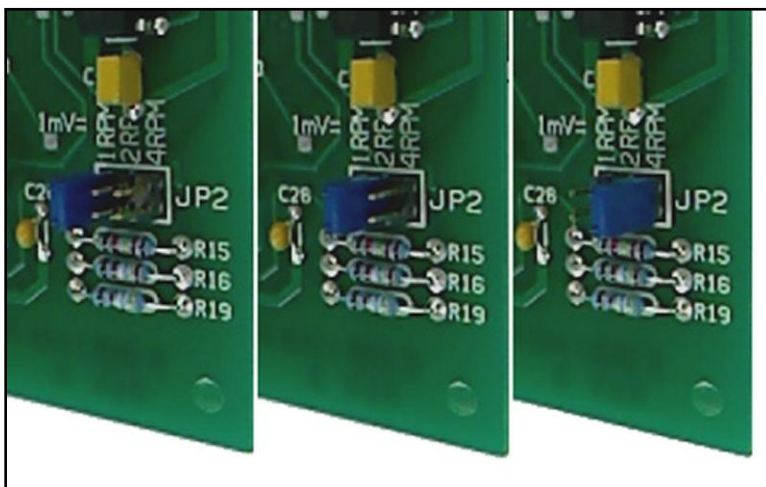
Loosen the screw that secures the main analog board to the front panel, and then carefully remove the analog board.



On the board, locate the configuration pins with the designation **JP2**. There is a small jumper that can be used to short together one of three pairs of pins.

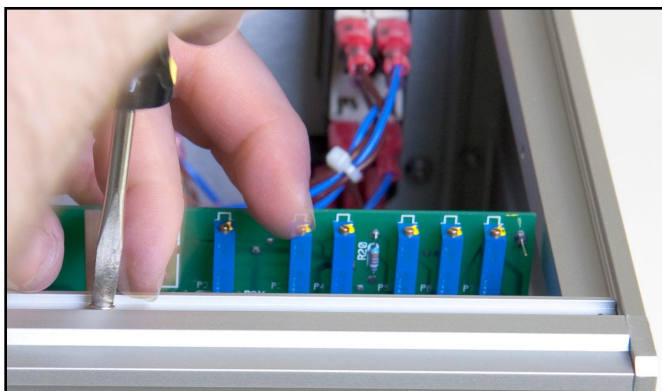


Place the jumper across one of the three pairs of pins. Choose the ratio required for the particular potentiostat being used with the rotator.

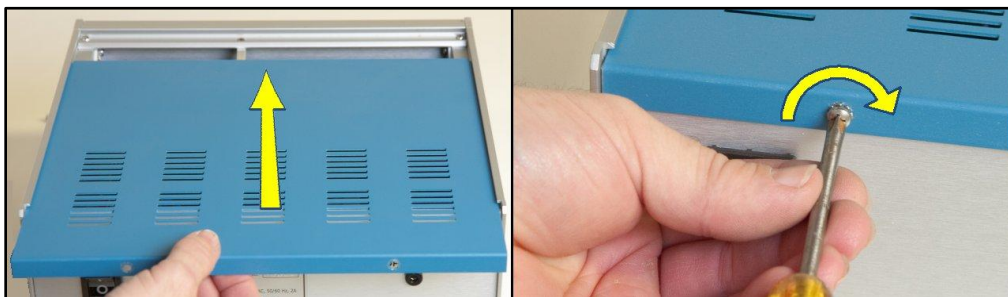


1 mV = 1 RPM 1 mV = 2 RPM 1mV = 4 RPM
(default)

Reinstall the board in the control unit and secure the board to the front panel.



Replace the cover on the control unit.



At this point the input ratio has been changed. Make a note in a log book or place a sticker on the control unit to indicate the new input ratio.

6.8 Changing the Motor Stop Signal Logic

The motor stop signal on the back panel of the control unit is a digital signal that can be used to bring the motor to a complete stop. This digital signal can be configured for either “active HIGH” or “active LOW” logic.

The motor stop signal logic is “active HIGH” by default, meaning that the motor is allowed to rotate if a signal greater than 2.0 volts is applied across the banana jacks. If the two banana jacks are shorted together (i.e., if the motor stop signal is driven to ground), then the motor stops rotating.



Note:

When the control unit is configured for “active HIGH” logic and when no connections are made to the motor stop banana jacks, the motor is allowed to rotate. An internal “pull up” circuit assures that the motor stop signal remains “high” in this case.

When a Pine potentiostat is connected to the rotator, the “active HIGH” logic should be used. A new rotator shipped from the factory is pre-configured for “active HIGH” logic by default.

Some third-party potentiostats require “active LOW” logic to be used. The control unit can be reconfigured for “active LOW” logic. In this configuration, a signal greater than 2.0 volts applied across the motor stop banana jacks causes the motor to stop rotating.

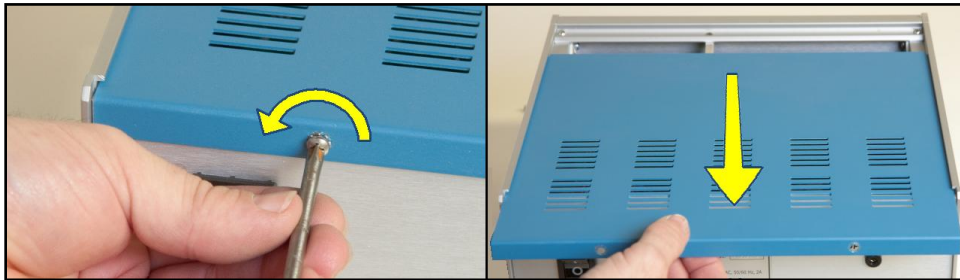
**DISCONNECT POWER:**

Before removing the control unit cover, turn off the power switch and disconnect the power cord from the power source.

**CAUTION:**

Electronic components may be damaged by static electricity. Ensure proper grounding when handling static sensitive components by wearing a grounding strap.

With the power cord disconnected, remove the cover from the control unit.



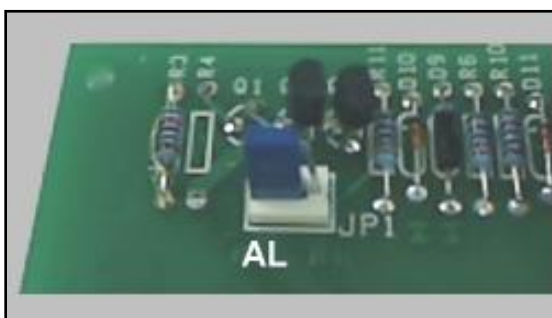
Loosen the screw that secures the main analog board to the front panel, and then carefully remove the analog board.



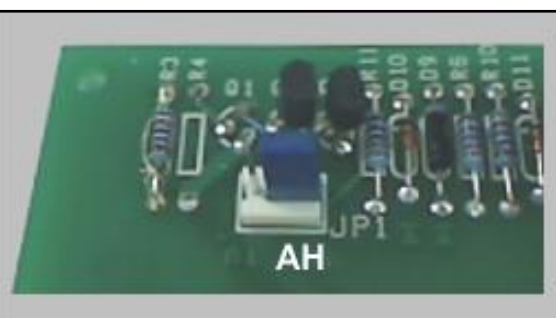
On the board, locate the configuration pins with the designation **JP1**. There is a small jumper that can be placed in one of two positions at this location.



Place the jumper across one of the two positions shown below. Choose the position required for the particular potentiostat being used with the rotator.

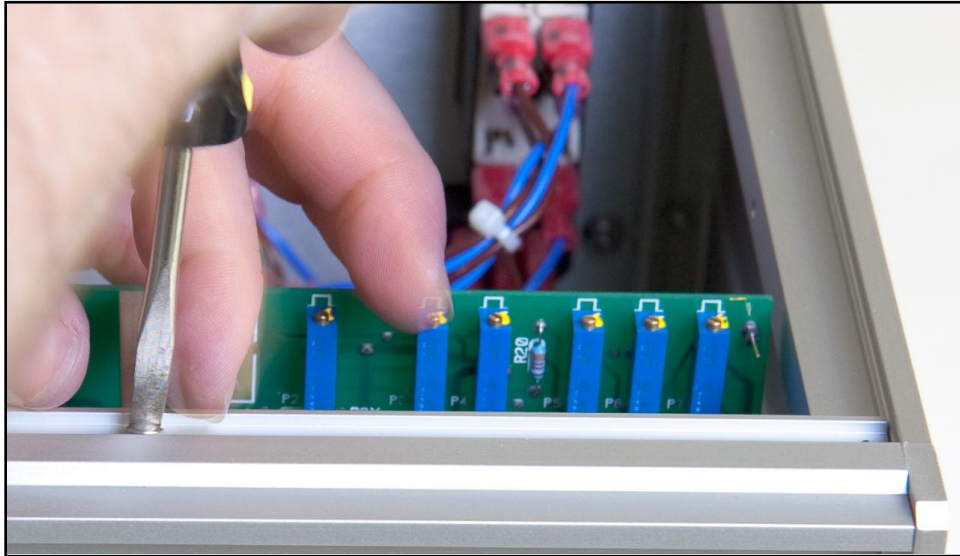


Active LOW Position

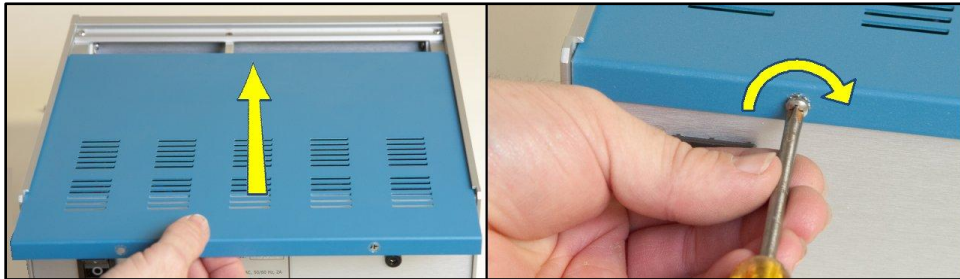


Active HIGH Position
(default)

Reinstall the board in the control unit and secure the board to the front panel.



Replace the cover on the control unit.



At this point the motor stop signal logic has been changed. Make a note in a log book or place a sticker on the control unit to indicate the new logic.

7 Parts and Accessories

7.1 Mechanical Parts and Hardware

There are several moving parts on the rotator which are subject to normal wear during routine use. This section describes these parts in more detail.



Brush Replacement Kit

Order this kit to replace a worn brush contact. This kit includes a spring-loaded brush and a required hex key tool. The replacement brush may be mounted in any of the four brush holders on the rotator. Special low humidity brushes are available for use in dry environments such as inside a glove box.

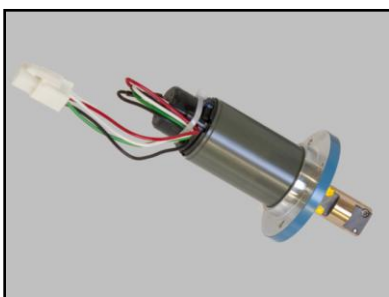
Standard Brush Kit ACAR063RM
Low Humidity Brush Kit ACAR063LHM



Complete Brush Assembly

To replace an entire brush assembly, order one of the parts below. This complete assembly includes the brush holder, a color coded banana jack, and a spring-loaded brush contact already mounted in the assembly.

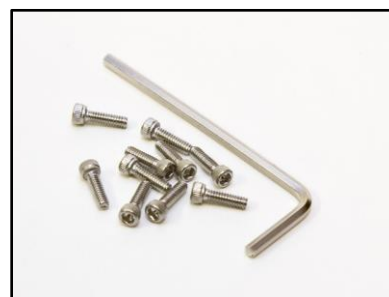
Brush Assembly (blue) ACMR3298XB
Brush Assembly (red) ACMR3298XR
Brush Assembly (yellow) ACMR3298XY
Brush Assembly (green) ACMR3298XG



Motor Coupling Assembly

The motor, motor coupling and mounting flange are sold together as one single unit. Note that it is not possible to purchase these three items separately.

Motor Coupling Assembly ACMR3165CE



Motor Coupling Hex Screws

This kit includes ten (10) replacement hex screws for use with the motor coupling. A pair of these screws is used to secure the rotating shaft inside the motor coupling. This kit also includes the hex key tool required to tighten these screws.

Motor Coupling Hex Screw Kit AKMRHEX



Lower Bearing Assembly

The lower bearing assembly stabilizes the rotating shaft at the point where the shaft exits the brush chamber. The standard assembly has a stainless steel bearing. A special assembly with a ceramic bearing is available for use in corrosive environments.

Stainless-Steel Bearing Assembly...ACMR3301X
Ceramic Bearing Assembly.....ACMR3302



Enclosure Parts

The enclosure consists of everything in the photo above except for the motor unit. Note that side posts are sold separately.

Enclosure (including window)ACMRS02
Enclosure Window Only.....ACMRN04I
Side Post (5/8" OD)AC01MSRD
Side Post (1/2" OD)AC01MSRDG



Three-Prong Lab Clamp

This three-pronged clamp fits a 24/25 center joint on an electrochemical cell. Standard right-angle bracket is included.

Three-Prong Clamp.....AKCLAMP



Round Cell Clamp

This clamp is for use with large round cells with outer diameters between 140 and 165 mm. Standard right-angle bracket is included.

Round Cell Clamp.....AKCLAMP2



Cell Platform

The cell platform is fabricated from a chemically-resistant polymer and mounts anywhere along the center post.

Cell Platform.....ACPR103



Motor Control Cable

The motor control cable has HD-15 connectors on either end and is used to connect the control unit to the motor unit.

Motor Control Cable.....EWC15DSUB

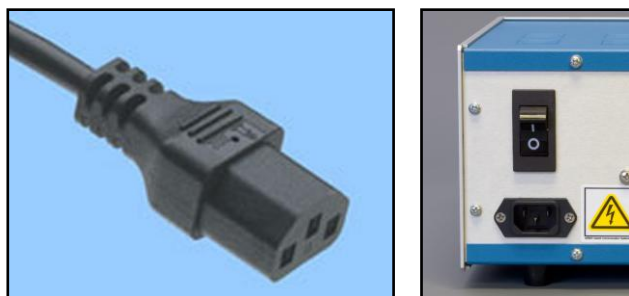


Figure 7.1: Standard C18 Connection on Power Entry Module

7.2 Power Cords

The power entry module on the back panel of the control unit accepts any power cord compatible with a standard C18 plug (see Figure 7.1). The rotator does not ship with a power cord, and power cords must be ordered separately. A wide range of power cord options are described below.



This cord is for use in the USA, Canada, Mexico, Brazil, Columbia, Korea, Mexico, Saudi Arabia, and Taiwan.

Power Cord (USA)EWM18B7



This cord is for use in continental Europe, Russia, and Indonesia.

Power Cord (Europe)EWM18B8EU



This cord is for use in the United Kingdom, Ireland, Oman, Hong Kong, and Singapore.

Power Cord (UK)EWM18B8UK



This cord is for use exclusively in China.

Power Cord (China)EWM18B8CN



This cord is for use in India and South Africa.
Power Cord (India)EWM18B8IN



This cord is for use exclusively in Israel.
Power Cord (Israel)EWM18B8IL



This cord is for use exclusively in Japan.
Power Cord (Japan)EWM18B8JP



This cord is for use exclusively in Argentina.
Power Cord (Argentina) EWM18B8AR



This cord is for use exclusively in Denmark.
Power Cord (Denmark)EWM18B8DK



This cord is for use in Australia & New Zealand.
Power Cord (Australia)EWM18B8NZ



This cord is for use exclusively in Switzerland.
Power Cord (Switzerland)EWM18B8CH



This cord is for use exclusively in Italy.
Power Cord (Italy)EWM18B8IT

7.3 Power Supplies

The rotator control unit has two internal power supplies. One of these power supplies is 24 VDC (2.8 A) and the other is 30 VDC (2.0 A). The location of these power supplies is shown in the photo below.

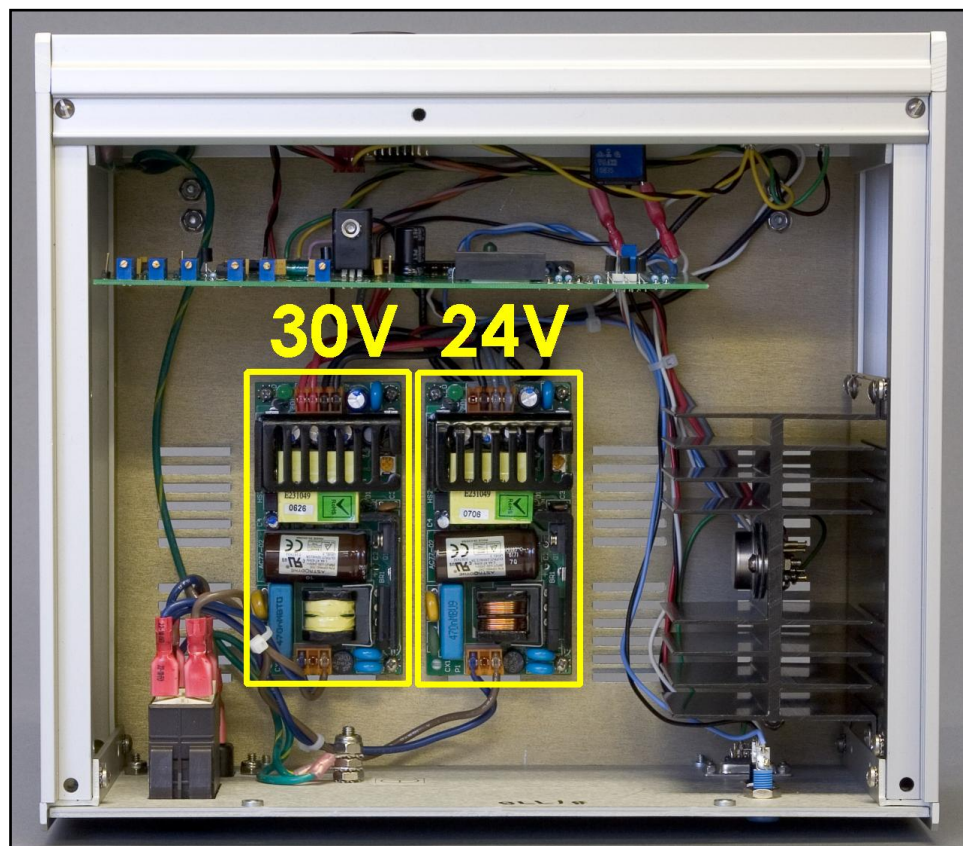
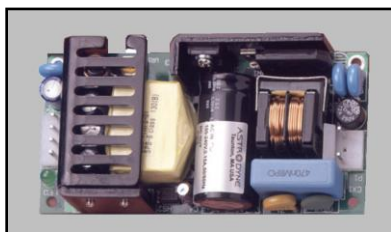
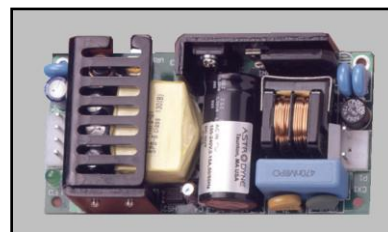


Figure 7.2: Location of Internal Power Supply Boards



Internal Power Supply (30V)

Power Supply (30 V, 2.0 A)EE60300-DP





Internal Power Supply (24V)

Power Supply (24 V, 2.8 A) EE60240-DP

8 Troubleshooting

This section describes some basic troubleshooting considerations when working with a rotator. If problems with the rotator persist, contact the factory for further assistance (see Section 1.9).

Problem	Suggested Cause or Action
System Power Loss	The main power switch on the back panel is a circuit breaker which may trip and cause the system to lose power. To reset the breaker, turn the switch off and then turn the switch on again. Repeated tripping may indicate a more serious problem.
No Rotation	Confirm that the unit is connected to a live power outlet.
	Confirm that the power switch has not tripped and that it is in the "on" position. Reset the switch if necessary.
	Check the front panel circuit breaker and reset the breaker if necessary.
	Check the motor control cable which connects the control unit to the motor unit. The connectors at both ends of this cable must be secured using the two screws on each connector.
	The rotation rate knob may be set to full counterclockwise position. If this is the case, then rotate the knob clockwise to increase the rotation rate.
	<div>  <p>The motor, the shaft or one of the bearings may be frozen due to corrosion.</p> <p>With the power cord unplugged and the rotator power switch in the "off" position, check for freedom of rotation of the shaft by manually attempting to rotate the shaft.</p> </div>
	<div>  <p>With the power cord unplugged and the rotator power switch in the "off" position, look inside the control unit and confirm that the printed circuit board is fully inserted into its connector.</p> </div>

Problem	Suggested Cause or Action
Continuous Rotation at a High Rate	Check the motor control cable which connects the control unit to the motor unit. The connectors at both ends of this cable must be secured using the two screws on each connector.
	Faulty connection or wire – contact the factory.
	Faulty circuitry – contact the factory.
Front Panel Circuit Breaker Trips	<p>This breaker only trips if the current passing through the motor windings is high enough to potentially damage the motor. This could occur if the electrode is spinning in a particularly viscous liquid, if the shaft is rubbing against something, or if an applied periodic waveform controlling the rotation rate has too great an amplitude or frequency.</p> <p>This breaker (thermal type) is sized to limit the average motor current to within the motor specification. Running the motor at a high modulation rate, or with large amplitude changes, or a combination of the two, may cause tripping. It may be necessary to reduce the modulation rate and/or amplitude to prevent tripping of the breaker.</p>
Excessive Audible Noise	If the rotator has a standard lower bearing assembly with a stainless steel bearing, then this bearing may be corroded. If corroded, replace the entire lower bearing assembly.
	If the rotator has a special lower bearing assembly with a ceramic bearing, then some noise is to be expected from the ceramic bearing. This special bearing assembly should be replaced if there is other evidence that it is damaged.
	Internal spindle bearings are worn – contact the factory.

Problem	Suggested Cause or Action
Rotator Spins Backwards	When the rotation rate knob is in the full counterclockwise position, it is natural to expect that the rotation rate should be exactly zero. In fact, it is normal for there to be a small residual rotation rate in either direction, sometimes in the reverse direction.
Electrical Noise in Voltammograms (environmental)	Make sure that working, reference, and counter electrode cables do not cross or travel near power cords, video cables, or network lines.
	Make sure that the potentiostat and rotator are located as far as possible from hotplates, ovens, video monitors, computers, network hubs, wireless devices, or cellular telephones.
Electrical Noise in Voltammograms (grounding issues) see Section 4.4.4	Confirm that the chassis ground of the rotator is connected to the chassis ground of the potentiostat.
	Confirm that all metal objects (such as cell clamps and ring stands) near the electrochemical cell are connected to the chassis ground of the potentiostat.
	Confirm that all chassis ground connections are made to a common grounding point to avoid the formation of "grounding loops". Note that grounding loops are sometimes non-obvious, especially when multiple instruments and computers are connected together.
Electrical Noise in Voltammograms (brush wear)	Always use a banana jumper cable to connect opposing brushes together. Two brushes in opposing contact provide a better electrical connection.
	Inspect all brush contacts. Brushes should have a concave groove worn in them which exactly mates with the rotating shaft. The depth of this concave groove naturally increases over the lifetime of the brush. A new brush should be worn continuously for approximately eight hours to intentionally wear a groove into the brush to increase the surface area of the brush that is in contact with the shaft.

Problem	Suggested Cause or Action
Electrical Noise in Voltammograms (cell connections)	<p>Confirm that the reference electrode has low impedance and is in good contact with the main test solution. High impedance at the reference electrode is often caused by a plugged frit, which impedes current between the inner chamber of the reference electrode and the main test solution. High impedance may also be encountered when working with low dielectric media (such as non-aqueous solvents).</p>
	<p>Use working, reference, and counter electrode cables which are shielded (coaxial) cables.</p>
	<p>Confirm that any alligator clips being used for connection to the electrodes are not rusted and are securely fastened to the electrodes.</p>
	<p>Note that many potentiostats utilize a driven shield to protect the reference electrode signal. This driven shield is connected to the outer shield line in the coaxial reference electrode cable. Only the inner signal line of the coaxial cable should be connected to the reference electrode. The outer shield line should not be connected to anything at the cell end of the cable. Do not ground such a driven shield line as it may cause the potentiostat to oscillate or malfunction.</p>

9 Storage and Shipment

In the event that the rotator system is not going to be used for a long period of time, it should be stored in the original packaging material to prevent damage. It should be stored at temperatures between -17°C and 37°C, and at humidity levels less than 95% non-condensing.

Retain the original packing materials for future use. These packing materials were designed to provide both protection in shipment, and to minimum size and weight for efficient shipment.

10 Theory

10.1 Forced Convection

The current signal recorded during an electrochemical experiment is easily influenced or disturbed by the convection of various molecules and ions due to bulk movement of the solution. Proper interpretation of the current signal must accurately account for any contributions (desired or undesired) from solution convection. Thus, the control of solution movement is a critical part of any electrochemical experiment design, and the issue of convection cannot be ignored. Two opposing approaches are typically used to address the convection issue. At one extreme, an experiment can be conducted in a quiescent solution, so that convection makes little or no contribution to the observed current. The opposite extreme involves forced convection, where the solution is actively stirred or pumped in a controlled manner.

At first glance, it may seem that the simplest and most obvious way to account for convection is to try to eliminate it entirely by using a quiescent (non-moving) solution. This is the approach used in many popular electroanalytical techniques^[1] (including cyclic voltammetry, chronoamperometry, square wave voltammetry, and differential pulse voltammetry). The timescale for these methods is generally less than 30 seconds, and on such short timescales, the influence of convection in an unstirred solution is generally negligible. On longer timescales, however, even unstirred solutions are prone to convective interference from thermal gradients and subtle environmental vibrations.

For long duration (steady-state) experiments, convection is unavoidable, so actively forcing^[2] the solution to move in a well-defined and controlled manner is the preferred approach. An entire family of electroanalytical methods (broadly categorized as hydrodynamic voltammetry) couples precise control of solution flow with rigorous mathematical models defining the flow. Some of the many examples of hydrodynamic voltammetry include placing an electrode in a flow cell,^[3] firing a jet of solution at an electrode target,^[4-5] embedding an electrode in a microfluidic channel,^[6] vibrating a wire-shaped electrode,^[7] subjecting the solution to ultrasonication,^[8] and rotating the electrode.^[9]

By far the most popular and widely used hydrodynamic methods are those that involve a rotating electrode. The rotating electrode geometries most amenable to mathematical modeling are the rotating disk electrode (RDE),^[9-11] the rotating ring-disk electrode (RRDE),^[12-17] and the rotating cylinder electrode (RCE).^[18-23] Researchers take advantage of the stable, steady-state laminar flow conditions adjacent to an RDE or RRDE to carefully gather information about electrode reaction kinetics.^[9,11,17,24-34] In contrast, the relatively chaotic and turbulent conditions adjacent to an RCE are exploited by corrosion scientists^[35-60] wishing

to mimic flow-induced pipeline corrosion conditions in the laboratory. Development of the RDE and RRDE as routine analytical tools has largely been carried out by the community of academic electroanalytical chemists, while the RCE has primarily been a tool used by the corrosion and electroplating industries.

10.2 Half Reactions

Regardless of the rotating electrode geometry being used, the common theme is that an ion or molecule is being conveyed to the electrode surface, and upon arrival, it is either oxidized or reduced depending upon the potential applied to the rotating electrode. If a sufficiently positive potential is applied to the electrode, then the molecules (or ions) tend to be oxidized, and conversely, if a sufficiently negative potential is applied to the rotating electrode, the molecules (or ions) tend to be reduced.

Reduction at a rotating electrode implies that electrons are being added to the ion or molecule by flowing out of the electrode and into the solution. A current travelling in this direction is said to be a cathodic current. The general form of a reduction half-reaction occurring at an electrode may be written as follows:

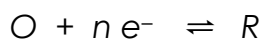


where R represents the reduced form of the molecule (or ion), O represents the oxidized form of the molecule (or ion), and n is the total number of electrons added to the molecule (or ion) when it is converted from the oxidized form (O) to the reduced form (R).

Oxidation at a rotating electrode implies that electrons are being removed from an ion or molecule and are travelling out of the solution and into the electrode. A current travelling in this direction is said to be an anodic current, and the oxidation occurring at the electrode can be represented by the following redox half reaction,



Given that electrochemical half reactions can occur in either direction, they are often written using chemical equilibrium notation* as follows:



* By convention, redox half reactions are generally tabulated in textbooks and other reference works as reduction reactions (with the oxidized form on the left side and the reduced form on the right side, as shown above), but it is understood that the reaction may occur in either direction depending upon the potential applied to the electrode.

Each half reaction has an associated standard electrode potential (E°) which is a thermodynamic quantity related to the free energy associated with the equilibrium. Like many other standard thermodynamic quantities, the standard electrode potential corresponds to a given standard state. The standard state corresponds to a thermodynamic system where the activities of activities of O and R are unity (i.e., when all solution concentrations are 1.0 mol/L, all gases are present at 1.0 atm partial pressure, and other materials are present as pure phases with unity activity).

To account for the (likely) possibility of non-unity activities, the Nernst equation (see below) can be used to express the equilibrium electrode potential ($E_{\text{NERNSTIAN}}$) in terms of the actual activities.

$$E_{\text{NERNSTIAN}} = E^\circ + (R T / n F) \ln [a_O / a_R]$$

where F is the Faraday constant ($F = 96485 \text{ C / mol}$), R is the ideal gas constant ($R = 8.3145 \text{ J / mol K}$), and T is the temperature (K). Usually, the activities of molecules or ions dissolved in solution are assumed to be the same as their molar concentrations, so the Nernst Equation is often written as follows

$$E_{\text{NERNSTIAN}} = E^\circ + (R T / n F) \ln [C_O / C_R]$$

where C_O and C_R are the concentrations of the dissolved molecules or ions in the oxidized and reduced forms, respectively, *at the surface of the electrode*. Note that any liquid or solid phase materials at the electrode surface (such as the solvent or the electrode itself) have unity activity and thus do not appear in the Nernst equation.

This half reaction at an electrode can be driven in the cathodic (reducing) direction by applying a potential to the electrode (E_{APPLIED}) which is more negative than the equilibrium electrode potential ($E_{\text{APPLIED}} < E_{\text{NERNSTIAN}}$). Conversely, the half reaction can be driven in the oxidizing (anodic) direction by applying a potential more positive than the equilibrium electrode potential ($E_{\text{APPLIED}} > E_{\text{NERNSTIAN}}$).

10.3 Voltammetry

The term voltammetry refers broadly to any method where the electrode potential is varied while the current is measured.^[1-2] The terminology associated with voltammetry varies across different industries and academic disciplines, but the underlying principles of all voltammetric techniques are very similar.

The most common form of voltammetry involves sweeping the electrode potential from an initial value to a final value at a constant rate. When working in the context of electroanalytical chemistry with a non-rotating electrode, this technique is called linear sweep voltammetry (LSV). In the context of corrosion

science, this kind of technique is usually called linear polarization resistance (LPR) or a Tafel analysis. The term cyclic voltammetry (CV) refers to a method where the electrode potential is swept repeatedly back-and-forth between two extremes.

When working with a rotating electrode, it is common to further specify the kind of electrode being used as part of the technique name, such as rotating disk voltammetry, rotating ring-disk voltammetry, or rotating cylinder voltammetry. In each of these techniques, the rotation rate is held constant as the electrode is swept from one potential to another potential at a constant sweep rate. In electroanalytical chemistry, the potential sweep usually spans at least 200 mV on either side of the standard electrode potential, and rotation rates are usually between 100 RPM and 2400 RPM. However, in the context of a corrosion study, the potential sweep may span a much narrower range (50 mV) using a slower sweep rate (less than 5 mV/sec) with an emphasis on higher rotation rates.

As an example, consider a solution that initially contains only the oxidized form of a molecule or ion. A rotating electrode is placed in this solution and is initially poised at a potential that is 200 mV more positive than the standard potential. At this potential, there is little or no current because there is nothing to oxidize (the molecule or ion is already oxidized), and the potential is not (yet) negative enough to cause any appreciable reduction of the molecule or ion.

Next, the electrode potential is slowly (20 mV/sec) swept in the negative (cathodic) direction (see Figure 10.1, left). As the applied potential approaches the standard electrode potential, a cathodic current is observed (see Figure 10.1, right). The cathodic current continues to increase as the potential moves past the standard electrode potential towards more negative potentials.

The current eventually reaches a maximum value (limiting current) once the applied potential is sufficiently negative relative to the standard electrode potential. At such a negative potential, any oxidized form of the molecule or ion (**O**) that reaches the surface of the electrode is immediately converted to the reduced form (**R**) as shown below.



The observed cathodic current is the result of electrons flowing out of the electrode and into the solution. The rate of electron flow is limited only by how fast the oxidized form (**O**) can arrive at the electrode surface. The maximum current observed in this circumstance is called the cathodic limiting current (i_{LC}).

Whenever an observed current is limited only by the rate at which material arrives at the electrode surface, the current is said to be mass transport limited. When working with a rotating electrode, the rate of mass transport is related to

the rotation rate of the electrode. Rotating the electrode at a faster rate increases the rate at which material arrives at the electrode surface. Thus, the limiting current increases with increasing rotation rate. Experiments involving a rotating electrode are designed to purposefully exploit this fundamental relationship between the rotation rate and the limiting current.

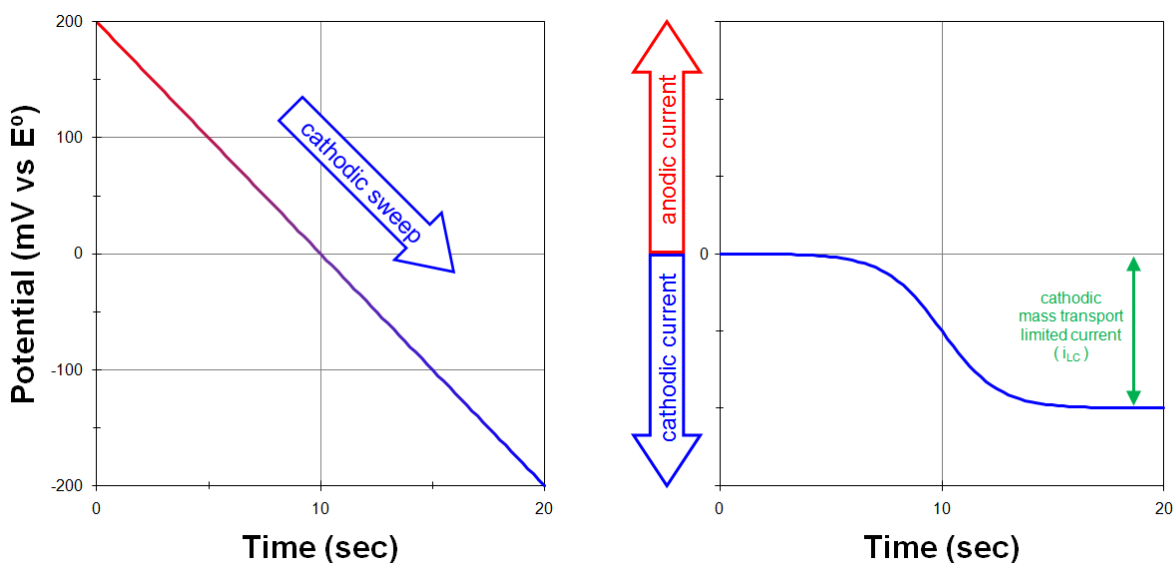


Figure 10.1: Response to a Potential Sweep (Cathodic) from a Solution Initially Containing only the Oxidized Form (O) with no Reduced Form (R)

The cathodic sweep experiment described above (see Figure 10.1) applies to the case where the solution initially contains only the oxidized form (O) of the molecule or ion being studied. The opposite case yields similar results. Consider a solution that initially contains only the reduced form (R) of the molecule or ion being studied. The rotating electrode is initially poised at a potential that is about 200 mV more negative than the standard potential. At this potential, there is little or no current because there is nothing to reduce (the molecule or ion is already reduced), and the potential is not (yet) positive enough to cause any appreciable oxidation of the molecule or ion.

Next, the electrode potential is slowly swept in the positive (anodic) direction (see Figure 10.2, left) and an anodic current is observed (see Figure 10.2, right). The anodic current eventually reaches a maximum value when the potential is sufficiently positive relative to the standard electrode potential. At this point, any of the reduced form (R) that reaches the electrode surface is immediately converted to the oxidized form (O).



The observed current is the result of electrons flowing into the electrode. The maximum current observed is called the anodic limiting current (i_{LA}).

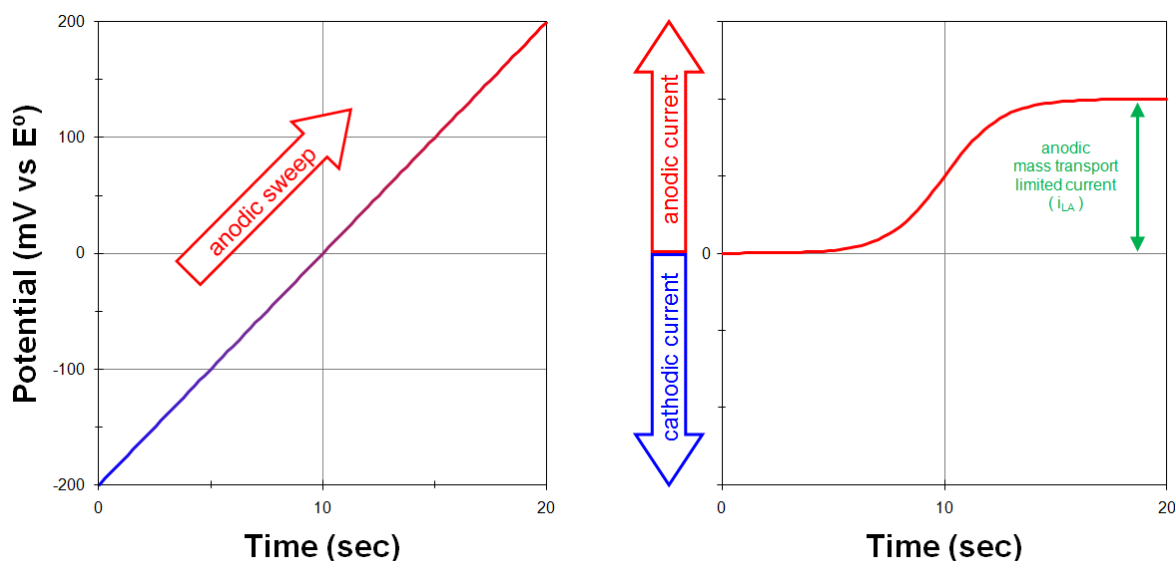


Figure 10.2: Response to a Potential Sweep (Anodic) from a Solution Initially Containing only the Reduced Form (R) with no Oxidized Form (O)

10.3.1 Voltammogram Plotting Conventions

The two streams of data recorded during a voltammetry experiment are the potential vs. time and the current vs. time. Rather than plot these two streams separately (as shown in Figure 10.3, left), it is more common to plot current vs. potential (as shown in Figure 10.3, right). Such a plot is called a voltammogram.

Although most electroanalytical researchers agree that current should be plotted along the vertical axis and potential should be plotted along the horizontal axis, there is not widespread agreement as to the orientation (direction) for each axis. Some researchers plot positive (anodic, oxidizing) potentials toward the right while others plot negative (cathodic, reducing) potential toward the right (as per classical polarography tradition). Furthermore, some researchers plot anodic (oxidizing) current upward along the vertical axis, while others plot cathodic (reducing) current in the upward direction.

This means there are four possible conventions for plotting a voltammogram, and one should always take a moment to ascertain the orientation of the axes before interpreting a voltammogram. Fortunately, of the four possible ways to plot a voltammogram, only two are commonly used. The older tradition (based on classical polarography) plots cathodic current upwards along the vertical axis and negative (cathodic, reducing) potentials toward the right along the horizontal axis. A complex voltammogram involving four different limiting currents (see Figure 10.4, left) illustrates this convention, which is sometimes called the “North American” convention.

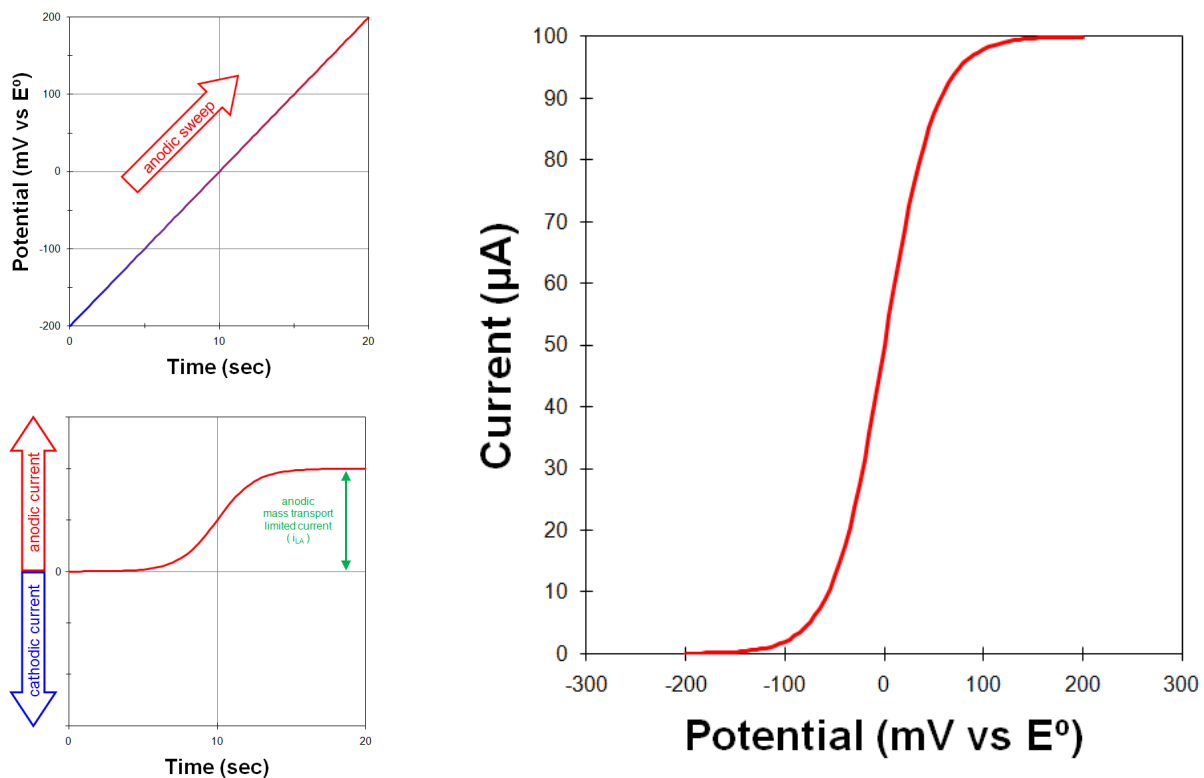


Figure 10.3: A Voltammogram is a Plot of Current versus Potential

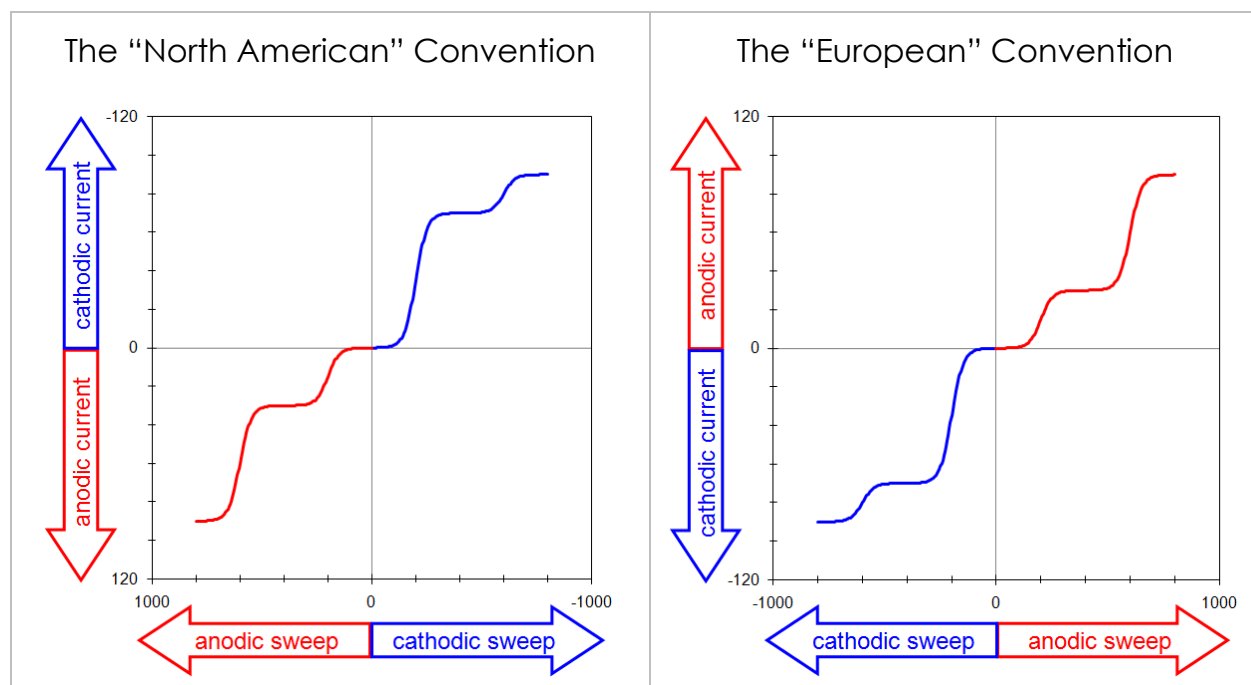


Figure 10.4: Two Popular Voltammogram Plotting Conventions

The same data may be plotted using the “European” convention (see Figure 10.4, right). This convention plots anodic currents upward along the vertical axis and more positive (anodic, oxidizing) potentials to the right along the horizontal axis. The European convention is a more readily understood by those outside the electroanalytical research community (because positive values are plotted to the right along the horizontal axis).

The European convention is used throughout the remainder of this document. Note that this choice also implies a mathematical sign convention for the current. Specifically, positive current values are considered anodic, and negative current values are considered cathodic in this document. This sign convention is somewhat arbitrary, and electrochemical data processing software available from various manufacturers may or may not use this sign convention.

10.3.2 Measuring Limiting Currents

The theoretical voltammetric response from a rotating electrode is a symmetric sigmoid-shaped wave (like the ideal voltammograms shown in Figure 10.3 and Figure 10.4). A perfect sigmoid has a flat baseline current before the wave and a flat limiting current plateau after the wave. The height of the wave (as measured from the baseline current to the limiting current plateau) is the mass-transport limited current.

In actual “real world” experiments, the wave may be observed on top of a background current, and furthermore, the background current may be slightly sloped (see Figure 10.5). This (undesired) background current may be due to interference from oxidation or reduction of impurities or of the solvent itself. The background current may also be due to capacitive charging and discharging of the ionic double-layer that forms next to the polarized electrode surface.

When attempting to measure the (desired) Faradaic mass-transport limited current at a rotating electrode, it is often necessary to account for the (undesired, possibly sloping) background current. If the background current has a constant slope across the entire voltammogram, then it is fairly easy to extrapolate the sloping baseline to a point underneath the limiting current plateau (see Figure 10.5, left). The limiting current is measured as the (vertical) distance between the plateau and the extrapolated baseline. In voltammograms where there is more than one wave, the plateau for the first wave is used as the baseline for the second wave (see i_{LA2} in Figure 10.5, left).

In some cases, the slope of the background current is not constant across the entire voltammogram. That is, the slope of the baseline leading up to the wave can be different than the slope of the plateau after the wave. It can be very difficult to discern exactly where to measure the limiting current along such a

voltammogram. One approach is to extrapolate the baseline forward through the wave and also extrapolate the plateau backward through the wave. Then, the limiting current is measured as the vertical distance between the baseline and plateau at a point corresponding to the center of the voltammogram (see i_{LA} in Figure 10.5, right).

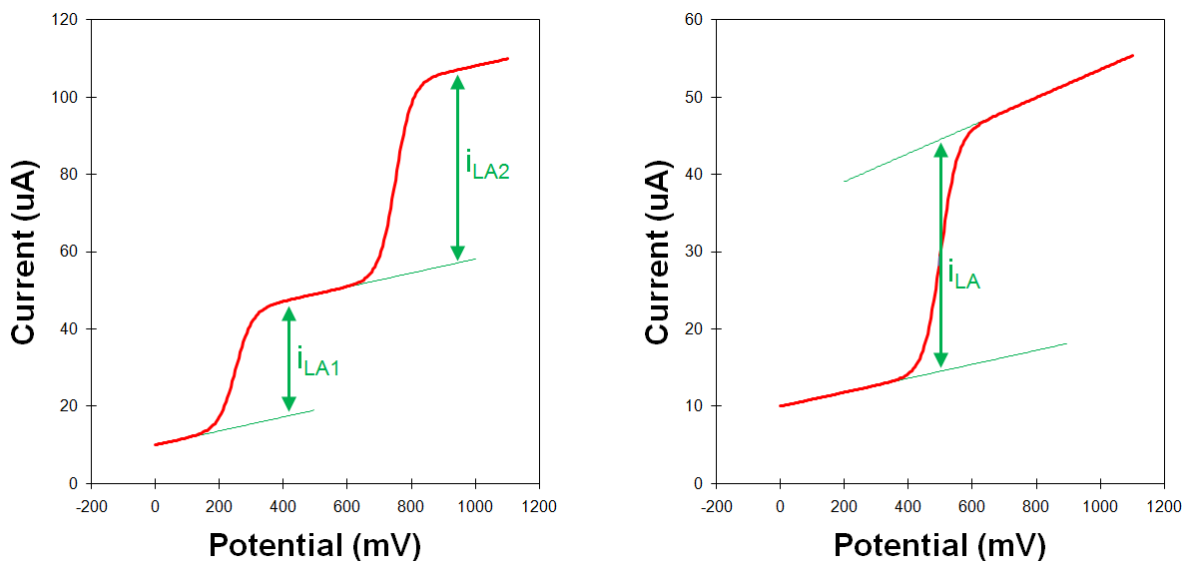


Figure 10.5: Sloping Backgrounds in Voltammograms

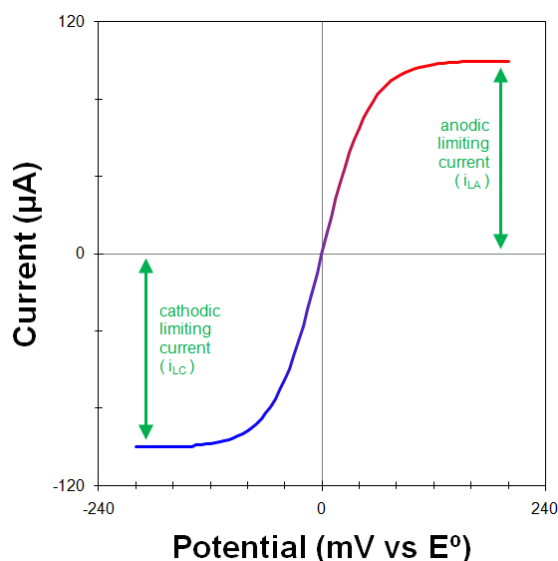


Figure 10.6: Voltammogram for a Solution Containing Both O and R

Finally, it should be noted that when the oxidized form (O) and the reduced form (R) of a molecule or ion are both present in a solution at the same time, the voltammogram is likely to exhibit both a cathodic and an anodic limiting current

(see Figure 10.6). It can be very difficult to measure the limiting current properly in this case, especially if there is also a sloping background current. For this reason, most experiments with rotating electrodes are conducted in solutions where only one form of the molecule or ion is initially present.

10.4 Rotating Disk Electrode (RDE) Theory

The general theory describing the rotating disk electrode was originally developed by Dr. Benjamin Levich in his landmark book^[10] called *Physicochemical Hydrodynamics* (Prentice-Hall). In 1962, this book was translated from Russian to English, and researchers in the United States and the United Kingdom rapidly built upon Dr. Levich's seminal work. Dr. Stanley Bruckenstein's laboratory at the University of Minnesota (and later at the University of Buffalo) helped to spread the theory and application of the rotating disk electrode^[9] to many other electroanalytical chemists, including Dr. John Albery^[12-17] (Oxford University) and Dr. Dennis Johnson^[11] (Iowa State University). Subsequent generations of researchers expanded on this initial work until the rotating disk electrode became a mature tool for probing electrochemical reaction kinetics.

The laminar flow at a rotating disk electrode conveys a steady stream of material from the bulk solution to the electrode surface. While the bulk solution far away from the electrode remains well-stirred by the convection induced by rotation, the portion of the solution nearer to the electrode surface tends to rotate with the electrode. Thus, if the solution is viewed from the frame of reference of the rotating electrode surface, then the solution appears relatively stagnant. This relatively stagnant layer is known as the hydrodynamic boundary layer, and its thickness (δ_H) can be approximated,

$$\delta_H = 3.6(\nu / \omega)^{1/2}$$

in terms of the kinematic viscosity of the solution (ν) and the angular rotation rate ($\omega = 2 \pi f / 60$, where f is the rotation rate in revolutions per minute). In an aqueous solution at a moderate rotation rate (~ 1000 RPM), the stagnant layer is approximately 300 to 400 μm thick.

Net movement of material to the electrode surface can be described mathematically by applying general convection-diffusion concepts from fluid dynamics. Mass transport of material from the bulk solution into the stagnant layer occurs by convection (due to the stirring action of the rotating electrode). But after the material enters the stagnant layer and moves closer to the electrode surface, convection becomes less important and diffusion becomes more important. Indeed, the final movement of an ion or molecule to the electrode surface is dominated by diffusion across a very thin layer of solution immediately adjacent to the electrode known as the diffusion layer.

The diffusion layer is much thinner than the hydrodynamic layer. The diffusion layer thickness (δ_F) can be approximated as follows,

$$\delta_F = 1.61 D_F^{1/3} \nu^{1/6} \omega^{-1/2}$$

in terms of the diffusion coefficient (D_F) of the molecule or ion. For a molecule or ion with a typical diffusion coefficient ($D_F \approx 10^{-5} \text{ cm}^2/\text{sec}$) in an aqueous solution, the diffusion layer is about twenty times thinner than the stagnant layer ($\delta_F \approx 0.05 \delta_H$).

The first mathematical treatment of convection and diffusion towards a rotating disk electrode was given by Levich. Considering the case where only the oxidized form of a molecule (or ion) of interest is initially present in the electrochemical cell, the cathodic limiting current (i_{LC}) observed at a rotating disk electrode is given by the Levich equation,^[2,10]

$$i_{LC} = 0.620 n F A D^{2/3} \nu^{-1/6} C_O \omega^{1/2}$$

in terms of the concentration (C_O) of the oxidized form in the solution, the Faraday constant ($F = 96485 \text{ coulombs per mole}$), the electrode area (A), the kinematic viscosity of the solution (ν), the diffusion coefficient (D) of the oxidized form, and the angular rotation rate (ω). Alternatively, when the solution initially contains only the reduced form, the Levich equation for the anodic limiting current (i_{LA}) can be written as

$$i_{LA} = 0.620 n F A D^{2/3} \nu^{-1/6} C_R \omega^{1/2}$$

where the concentration term (C_R) is for the reduced form rather than the oxidized form.

10.4.1 Levich Study

A Levich Study is a common experiment performed using a rotating disk electrode in which a series of voltammograms is acquired over a range of different rotation rates. For a simple electrochemical system where the rate of the half reaction is governed only by mass transport to the electrode surface, the overall magnitude of the voltammogram should increase with the square root of the rotation rate (see Figure 10.7, left).

The currents measured during a Levich study are usually plotted against the square root of the rotation rate on a graph called a Levich plot. As predicted by the Levich equation, the limiting current (see red circles on Figure 10.7, right) increases linearly with the square root of the rotation rate (with a slope of $0.620 n F A D^{2/3} \nu^{-1/6} C$) and the line intercepts the vertical axis at zero. It is common to choose a set of rotation rates that are multiples of perfect squares (such as 100, 400, 900, 1600 RPM, etc.) to facilitate construction of this plot.

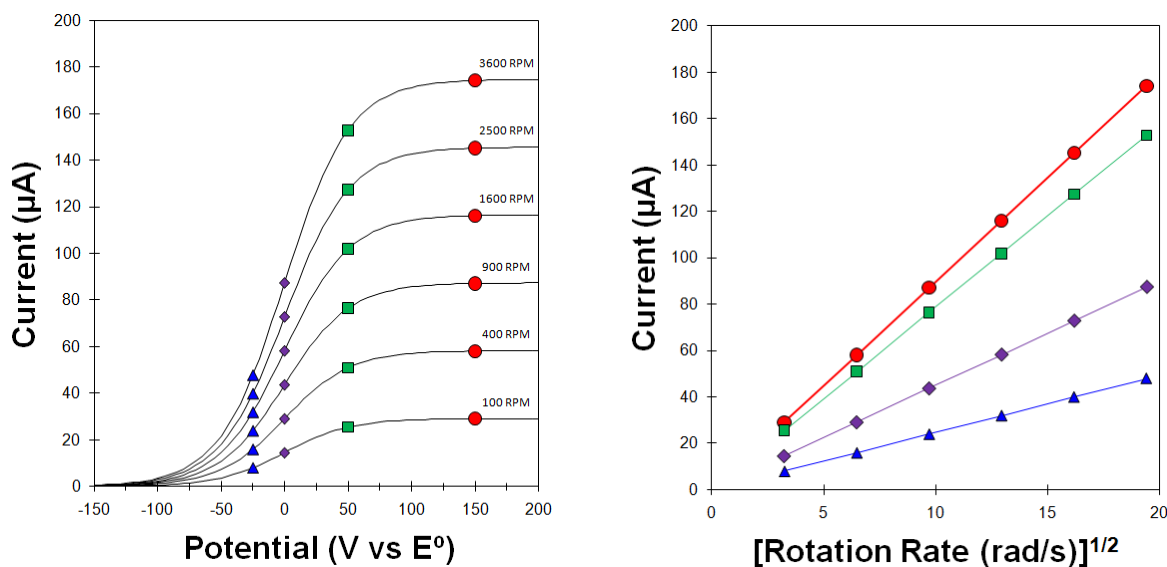


Figure 10.7: Levich Study – Voltammograms at Various Rotation Rates

If the electrochemical half-reaction observed during a Levich study is a simple and reversible half reaction (with no complications due to sluggish kinetics or coupled chemical reactions), then the shapes of the mass-transport controlled voltammograms will be sigmoidal regardless of the rotation rate. This means that the current observed at any given potential along the voltammogram will vary linearly with the square root of the rotation rate (see Figure 10.7, right). But, it is important to remember that the Levich equation only applies to the limiting current, not to the currents along the rising portion of the sigmoid.

Because the Levich equation only applies to the limiting current, the results from a Levich experiment are typically presented as a simple plot of the limiting current versus the square root of the rotation rate (see Figure 10.8, center).

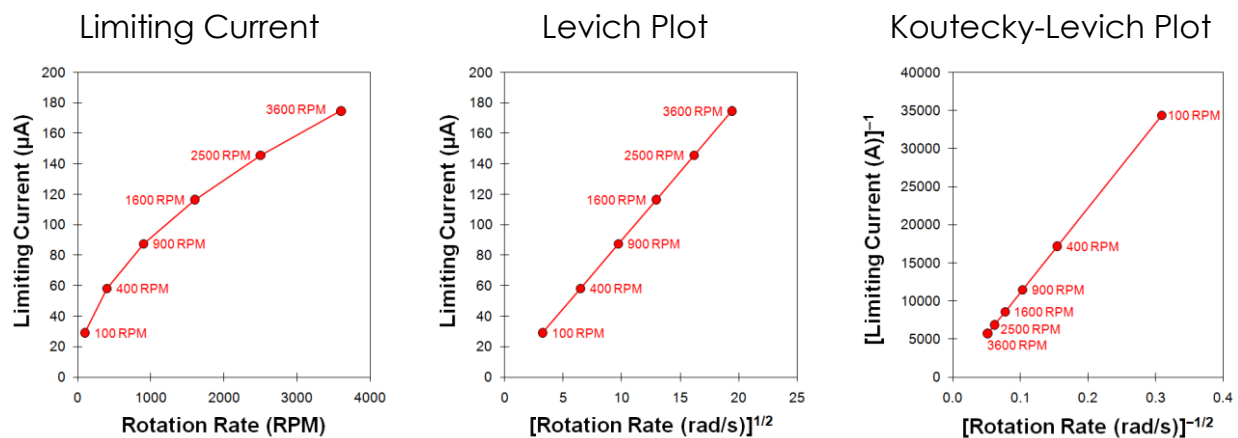


Figure 10.8: Levich Study – Limiting Current versus Rotation Rate

An alternate method of presenting the data from a Levich study is based on a rearrangement of the Levich equation in terms of the reciprocal current.

$$\frac{1}{i_L} = \left(\frac{1}{0.620 n F A D^{2/3} \nu^{-1/6} C} \right) \omega^{-1/2}$$

A plot of reciprocal current versus the reciprocal square root of the angular rotation rate (see Figure 10.8, right) is called a Koutecky-Levich^[2,11] plot. Again, for a simple and reversible half reaction with no complications the data fall along a straight line that intercepts the vertical axis at zero. If the line intercepts the vertical axis above zero, however, this is a strong indication that the half-reaction is limited by sluggish kinetics rather than by mass transport.

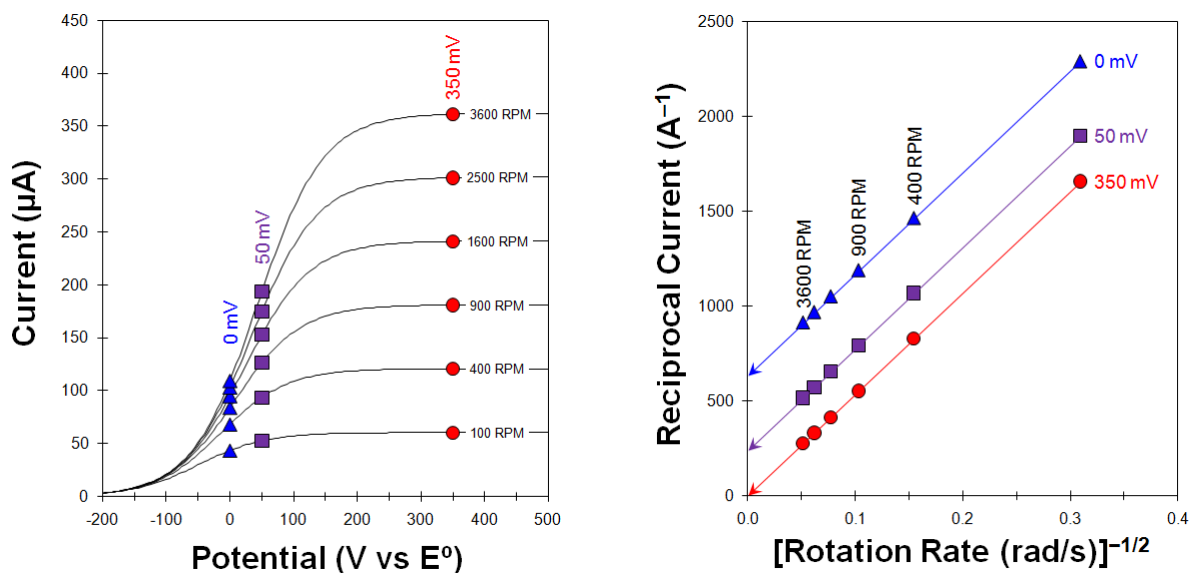


Figure 10.9: Koutecky Levich Study – Voltammograms with Sluggish Kinetics

10.4.2 Koutecky-Levich Analysis

When the rate of a half reaction occurring at an electrode surface is limited by a combination of mass transport and sluggish kinetics, it is often possible to use a rotating disk electrode to elucidate both the mass transport parameters (such as the diffusion coefficient) and the kinetic parameters (such as the standard rate constant, k^0) from a properly designed Levich study. A full treatment of this kind of analysis^[11] is beyond the scope of this document, but the following is a general description of how to extract kinetic information from a set of rotating disk voltammograms.

When the electron transfer process at an electrode surface exhibits sluggish kinetics, the voltammogram appears stretched out along the potential axis and the shape of the sigmoidal wave is slightly distorted. Comparing a set of

voltammograms with facile kinetics (see Figure 10.7) with a set of voltammograms with sluggish kinetics (see Figure 10.9), the mass transport limited current plateau (marked by red circles in each figure) is shifted further away from the standard electrode potential (E^0) when there are slow kinetics. Stated another way, when a sluggish redox half reaction is studied with a rotating disk electrode, a larger overpotential must be applied to the electrode to overcome the sluggish kinetics and reach the mass transport limited current.

This distortion of the ideal sigmoidal shape of the voltammogram can be exploited as a way to measure the standard rate constant (k^0). The general approach is to acquire a set of voltammograms at different rotation rates (i.e., perform a Levich study) and then plot the reciprocal current (sampled at particular locations along the rising portion of each voltammogram) on a Koutecky-Levich Plot. In the example provided (see Figure 10.9, left), the current was sampled at two locations along the rising portion of the voltammograms (at 0 and 50 mV vs. E^0 , marked with blue triangles and purple squares) and at one location on the limiting current plateau (at 350 mV vs. E^0 , marked with red circles). A linear relationship is evident (see Figure 10.9, right) when these sampled currents are plotted on a Koutecky-Levich Plot.

For the set of currents sampled on the limiting current plateau (red circles), an extrapolation back to the vertical axis (i.e., to infinite rotation rate) yields a zero intercept. This is the identical result obtained for a facile half-reaction (see Figure 10.8, right) because these currents are sampled at a high enough overpotential that there are no kinetic limitations. Only mass transport limits the current, and the usual Levich behavior applies.

However, for the two sets of currents sampled on the rising portion of the voltammogram (see Figure 10.9, blue triangles and purple squares), the extrapolation back to the vertical axis yields non-zero intercepts. This non-zero intercept indicates a kinetic limitation, meaning that even if mass transport were infinite (i.e., infinite rotation rate), the rate of the half-reaction would still be limited by the slow kinetics at the electrode surface.

The linear portion of the data on a Koutecky-Levich plot is described by the Koutecky-Levich equation.

$$\frac{1}{i} = \frac{1}{i_k} + \left(\frac{1}{0.620 n F A D^{2/3} \nu^{-1/6} C} \right) \omega^{-1/2}$$

Plotting the reciprocal current ($1 / i$) against the reciprocal angular rotation rate ($\omega^{-1/2}$) yields a straight line with an intercept equal to the reciprocal kinetic current (i_k). The kinetic current is the current that would be observed in the absence of any mass transport limitations. By measuring the kinetic current at a

variety of different overpotentials along the voltammogram, it is possible to determine the standard rate constant for the electrochemical half reaction.

Further details regarding Koutecky-Levich theory, including various forms of the Koutecky-Levich equation which pertain to different electrochemical processes, can be found in the literature.^[11]

10.5 Rotating Ring-Disk Electrode (RRDE) Theory

Soon after the rotating disk electrode was developed, the idea of putting a ring electrode around the disk electrode was introduced, and the rotating ring-disk electrode was born.^[12-17] In this “ring-disk” geometry, the overall axial flow pattern initially brings molecules and ions to the disk electrode. Then, the subsequent outward radial flow carries a fraction of these molecules or ions away from the disk electrode and past the surface of the ring electrode. This flow pattern allows products generated (upstream) by the half reaction at the disk electrode to be detected as they are swept (downstream) past the ring electrode.

Two of the key parameters which characterize a given ring-disk geometry are the collection efficiency^[14] and the transit time. The collection efficiency is the fraction of the material from the disk which subsequently flows past the ring electrode, and can be expressed as a fraction between 0.0 and 1.0 or as a percentage. Typical ring-disk geometries have collection efficiencies between 20% and 30%. The transit time is a more general concept indicating the average time required for material at the disk electrode to travel across the gap between the disk and the ring electrode. Obviously, the transit time is a function of both the gap distance and the rotation rate.

10.5.1 Theoretical Computation of the Collection Efficiency

The theoretical collection efficiency can be computed^[2] from the three principle diameters describing the RRDE geometry: the disk outer diameter (d_1), the ring inner diameter (d_2), and the ring outer diameter (d_3). This somewhat tedious computation is made easier by normalizing the ring diameters with respect to the disk diameter

$$\sigma_{OD} = d_3 / d_1 \quad \text{and} \quad \sigma_{ID} = d_2 / d_1$$

and by defining three additional quantities in terms of the normalized diameters

$$\sigma_A = \sigma_{ID}^3 - 1$$

$$\sigma_B = \sigma_{OD}^3 - \sigma_{ID}^3$$

$$\sigma_C = \sigma_A / \sigma_B$$

If a complex function, $G(x)$, is defined as follows,

$$G(x) = \frac{1}{4} + \left(\frac{\sqrt{3}}{4\pi} \right) \ln \left[\frac{(x^{1/3} + 1)^3}{x + 1} \right] + \left(\frac{3}{2\pi} \right) \arctan \left[\frac{2x^{1/3} - 1}{\sqrt{3}} \right]$$

then the theoretical collection efficiency ($N_{\text{theoretical}}$) for a rotating ring-disk electrode is given by the following equation:

$$N_{\text{theoretical}} = 1 - \sigma_{OD}^2 + \sigma_B^{2/3} - G(\sigma_C) - \sigma_B^{2/3} G(\sigma_A) + \sigma_{OD}^2 G(\sigma_C \sigma_{OD}^3)$$

10.5.2 Empirical Measurement of the Collection Efficiency

Direct computation of the theoretical collection efficiency is possible using the above relationship if the actual machined dimensions of the disk and ring are known for a particular RRDE. In practice, the actual RRDE dimensions may not be known due to uncertainties in the machining process and changes in the dimensions induced by electrode polishing or temperature cycling. For this reason, it is common practice to empirically measure the collection efficiency using a well-behaved redox system rather than to rely upon a computed value.

The ferrocyanide/ferricyanide half reaction is a simple, single-electron, reversible half reaction that is often used as the basis for measuring collection efficiency. The RRDE is placed in a solution containing a small concentration ($\sim 10 \text{ mM}$) of potassium ferricyanide, $\text{K}_3\text{Fe}(\text{CN})_6$, in a suitable aqueous electrolyte solution (such as 1.0 M potassium nitrate, KNO_3) and is operated at rotation rates between 500 and 2000 RPM. Initially, both the ring and the disk electrodes are held at a sufficiently positive potential that no reaction occurs. Then, the potential of the disk electrode is slowly swept ($\sim 50 \text{ mV/sec}$) towards more negative potentials, and a cathodic current is observed which corresponds to the reduction of ferricyanide to ferrocyanide at the disk.



As ferricyanide is reduced at the disk electrode, the ferrocyanide generated by this process is swept outward (radially) away from the disk electrode and toward the ring electrode. The ring electrode is held constant at a positive (oxidizing) potential throughout the experiment. Some (but not all) of the ferrocyanide generated at the disk travels close enough to the ring electrode that it is oxidized back to ferricyanide. Thus, an anodic current is observed at the ring electrode due to the oxidation of ferrocyanide to ferricyanide at the ring.



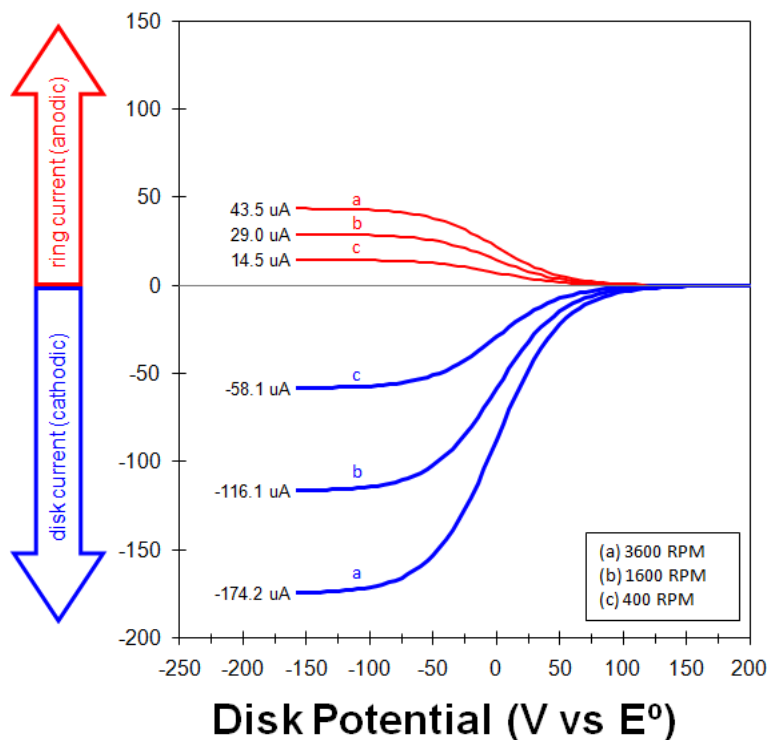


Figure 10.10: Rotating Ring-Disk Voltammograms at Various Rotation Rates

The measured ratio of the ring (anodic) limiting current to the disk (cathodic) limiting current is the empirical collection efficiency. As the rotation rate increases, both the disk and the ring currents increase (see Figure 10.10). Because both the anodic and cathodic limiting currents are proportional to the square root of the rotation rate, the empirical collection efficiency is expected to be independent of the rotation rate.

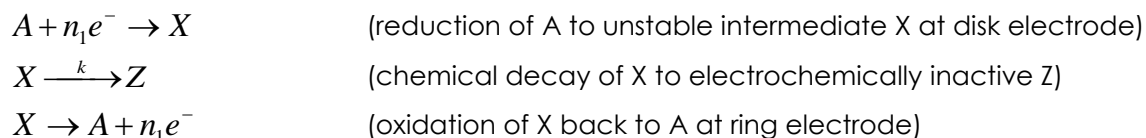
Once the collection efficiency value has been established empirically for a particular RRDE, it can be treated as a property of that particular RRDE, even if the RRDE is used to study a different half reaction in a different solution on a different day. Although the empirically measured collection efficiency ($N_{\text{empirical}}$) is a ratio of two currents with opposite mathematical signs (anodic and cathodic), the collection efficiency is always expressed as a positive number.

$$N_{\text{empirical}} = -i_{\text{LIMITING,RING}} / i_{\text{LIMITING,DISK}}$$

10.5.3 Generator/Collector Experiments

When a molecule or ion is oxidized or reduced at an electrode, it is often transformed into an unstable intermediate chemical species which, in turn, is likely to undergo additional chemical changes. The intermediate may have a long enough lifetime that it is capable of moving to the ring electrode and being detected. Or, the intermediate may be so unstable that it decays away

before it can be detected at the ring. Consider the following reaction scheme at a rotating ring-disk electrode:



In the above scheme, the disk electrode is poised at a potential where A is reduced to X, and the cathodic limiting current observed at the disk (i_{DISK}) is a measure of how much X is being “generated” at the disk electrode. At the same time, the ring electrode is poised at a more positive potential where X is oxidized back to A, and the anodic limiting current observed at the ring (i_{RING}) is a measure of much X is being “collected” at the ring. There is also a competing chemical reaction which is capable of eliminating X before it has a chance to travel from the disk to the ring.

The ratio of the ring current to the disk current under these conditions is called the apparent collection efficiency (N_{apparent}).

$$N_{\text{apparent}} = -i_{\text{RING}} / i_{\text{DISK}}$$

By comparing the apparent collection efficiency (N_{apparent}) to the previously measured empirical collection efficiency ($N_{\text{empirical}}$) for the same RRDE, it is possible to deduce the rate at which the competing chemical pathway is converting X to Z. That is, it is possible to use an RRDE “generator/collector” experiment to measure the kinetic behavior of unstable electrochemical intermediates.

Whenever $N_{\text{apparent}} \approx N_{\text{empirical}}$, it is an indication that the decay rate of the intermediate (via the X→Z pathway) is small with respect to the transit time required for X to travel from the disk to the ring. One way to shorten the transit time is to spin the RRDE at a faster rate. At high rotation rates, the apparent collection efficiency should approach the empirical collection efficiency. Conversely, at slower rotation rates, the apparent collection efficiency may be smaller ($N_{\text{apparent}} < N_{\text{empirical}}$) because some of the intermediate is consumed by the competing chemical pathway before X can travel to the ring.

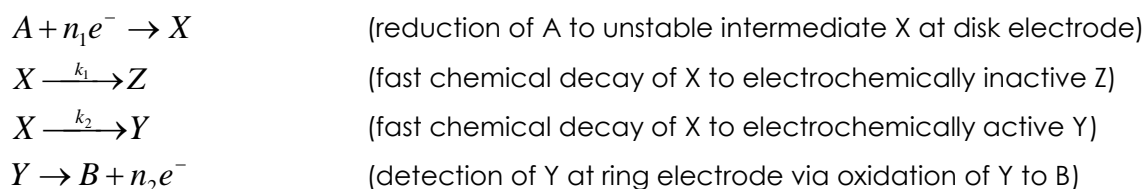
By recording a series of rotating ring-disk voltammograms at different rotation rates and analyzing the results, it is possible to estimate the rate constant (k) associated with the intermediate chemical decay pathway. Various relationships have been proposed for this kind of analysis,^[2] and one of the simplest is shown below

$$\frac{N_{\text{empirical}}}{N_{\text{apparent}}} = 1 + 1.28 \left(\frac{\nu}{D} \right)^{1/3} \left(\frac{k}{\omega} \right)$$

A plot of the ratio of the empirical to the apparent collection efficiency versus the reciprocal angular rotation rate should be linear. The slope of such a plot can yield the rate constant if the kinematic viscosity (ν) and the diffusion coefficient (D) are known.

10.5.4 Comparing Two Competing Pathways

Sometimes the intermediate generated by an electrochemical process can decay via two different pathways. As long as one of these pathways leads to an electrochemically active chemical species that can be detected at the ring, it is possible to determine which decay pathway is favored. Consider the following scheme:



In the above scheme, the disk electrode is poised at a potential where A is reduced to X, and the cathodic limiting current observed at the disk (i_{DISK}) is a measure of how much X is being “generated” at the disk electrode. The intermediate X is unstable, and as it is swept away from the disk and toward the ring, it rapidly decays to either Y or Z. By the time these species reach the ring, all of the X has decayed away, and the solution in contact with the ring contains both Y and Z. The species Z is electrochemically inactive and cannot be detected by the ring, but the species Y is active. By carefully poisoning the ring electrode at a potential appropriate for detecting Y (in this case, by oxidizing Y to B), it is possible for the ring to “collect” any Y which arrives at the surface of the ring.

The ratio of the ring current (due to Y being detected at the ring) to the disk current (due to X being generated at the disk) reveals the extent to which the X→Y pathway is favored in comparison to the X→Z pathway. The fraction of the decay by the X→Y pathway (θ_{XY}) can be computed as follows.

$$\theta_{XY} = \left(\frac{1}{N_{\text{empirical}}} \right) \left(\frac{n_1}{n_2} \right) \left| \frac{i_{\text{RING}}}{i_{\text{DISK}}} \right|$$

Note in the above equation that the fraction (n_1/n_2) carefully accounts for any difference in the number of electrons involved in the disk half reaction and the

number of electrons involved when detecting Y at the ring electrode. Schemes involving more complex stoichiometry may require additional correction factors.

The most commonly studied reaction at the RRDE is undoubtedly the oxygen reduction reaction (ORR).^[24-34] When oxygen (O₂) is dissolved in acidic media and reduced at a platinum electrode, one pathway leads to water as the ultimate reduction product while the other pathway leads to the formation of peroxide anions. In the context of hydrogen fuel cell research, the pathway which leads to water is preferred, and it is commonly called the four-electron pathway. The path to peroxide formation is called the two-electron pathway, and it is undesirable for a number of reasons, including the fact that peroxide can damage various polymer membrane materials found in a fuel cell. Further details on how to use an RRDE “generator/collector” experiment to distinguish between the two-electron and four-electron ORR pathways can be found in the electrochemical literature.^[24,27]

10.6 Rotating Cylinder Electrode (RCE) Theory

The rotating disk and ring-disk electrodes were developed primarily as a result of academic electroanalytical chemistry research. In contrast, the theory for the rotating cylinder electrode (RCE) was developed by industrial researchers^[37-39] in the corrosion and electroplating communities. While the flow of solution at a rotating disk (or ring-disk) is laminar over a wide range of rotation rates, the flow at the surface of a rotating cylinder is turbulent^[22] at all but the slowest rotation rates. Thus, the RCE is an excellent tool for creating and controlling turbulent flow conditions in the laboratory, and it is most commonly used to mimic turbulent corrosion conditions found in large scale industrial settings such as oilfield pipeline corrosion.^[47-60]

The turbulent flow at a rotating cylinder electrode conveys material from the bulk solution towards the electrode surface. While the bulk solution remains well stirred by the main vortex induced by the rotating electrode, the layer of solution adjacent to the cylinder surface tends to rotate with the electrode. Thus, a high shear condition is set up at the surface of the rotating cylinder, spinning off smaller Taylor vortices adjacent to the rotating electrode.

Net movement of material to the surface of a rotating cylinder was first characterized by Eisenberg^[18-19] in 1954 (about the same time that Levich was describing the rotating disk electrode). Eisenberg's work eventually led to the Eisenberg equation which gives the limiting current at a rotating cylinder electrode

$$i_L = 0.0487 n F A d_{cyl}^{+0.4} D^{+0.644} \nu^{-0.344} C \omega^{+0.7}$$

in terms of the concentration (C) and diffusion coefficient (D) of the molecule or ion being studied, the Faraday constant ($F = 96485$ coulombs per mole), the electrode area (A), the diameter of the cylinder (d_{cyl}), the kinematic viscosity of the solution (ν), and the angular rotation rate ($\omega = 2 \pi f / 60$, where f is the rotation rate in revolutions per minute). In the years since Eisenberg's initial work with the rotating cylinder, additional work by Gabe, Kear, Walsh, and Silverman has described industrial applications of the RCE.^[18-23,35-60]

10.7 References

1. PT Kissinger and WR Heineman, *Laboratory techniques in electroanalytical chemistry*, Marcel Dekker, New York (1996).
2. AJ Bard and LR Faulkner, *Electrochemical Methods-Fundamentals and Applications*, 2nd Edition, John Wiley & Sons, New York (2000) Chapter 9.
3. DC Johnson, SG Weber, AM Bond, RM Wightman, RE Shoup and IS Krull, *Electroanalytical voltammetry in flowing solutions*, *Analytica Chimica Acta* 180 (1986) 187-250.
4. H Gunasingham and B Fleet, *Wall-jet electrode in continuous monitoring voltammetry*, *Analytical Chemistry* 55 (1983) 1409-1414.
5. JV Macpherson and PR Unwin, *Hydrodynamic Modulation Voltammetry with an Oscillating Microjet Electrode*, *Analytical Chemistry* 71 (1999) 4642.
6. IE Henley, K Yunus and AC Fisher, *Voltammetry under Microfluidic Control: Computer-Aided Design Development and Application of Novel Microelectrochemical Reactors*, *J. of Physical Chemistry B* 107 (2003) 3878-3884.
7. KW Pratt and DC Johnson, *Vibrating wire electrodes—I. Literature review, design and evaluation*, *Electrochimica Acta* 27 (1982) 1013-1021.
8. C Hagan and LA Coury, *Comparison of hydrodynamic voltammetry implemented by sonication to a rotating disk electrode*, *Analytical Chemistry* 66 (1994) 399-405.
9. S Bruckenstein and B Miller, *Unraveling reactions with rotating electrodes*, *Acc. Chem. Res.* 10 (1977) 54-61.
10. VG Levich, *Physicochemical Hydrodynamics*, Prentice-Hall, Upper Saddle River NJ (1962).
11. S Treimer, A Tanga and DC Johnson, *Consideration of the Application of Koutecky-Levich Plots in the Diagnoses of Charge-Transfer Mechanisms at Rotated Disk Electrodes*, *Electroanalysis* 14 (2002) 165-171.
12. WJ Albery and ML Hitchman, *Ring-Disc Electrodes*, Clarendon Press, Oxford (1971).
13. WJ Albery, *Ring-disc electrodes. Part 1.— A new approach to the theory*, *Trans. Faraday Soc.* 62 (1966) 1915-1919.
14. WJ Albery and S Bruckenstein, *Ring-disc electrodes. Part 2.— Theoretical and experimental collection efficiencies*, *Trans. Faraday Soc.* 62 (1966) 1920-1931.
15. WJ Albery, S Bruckenstein and DT Napp, *Ring-disc electrodes. Part 3.— Current-voltage curves at the ring electrode with simultaneous currents at the disc electrode*, *Trans. Faraday Soc.* 62 (1966) 1932-1937.
16. WJ Albery, S Bruckenstein and DC Johnson, *Ring-disc electrodes. Part 4.— Diffusion layer titration curves*, *Trans. Faraday Soc.* 62 (1966) 1938-1945.
17. WJ Albery, *Ring-disc electrodes. Part 5.— First-order kinetic collection efficiencies at the ring electrode*, *Trans. Faraday Soc.* 62 (1966) 1946-1954.
18. M Eisenberg, CW Tobias and CR Wilke, *Ionic Mass Transfer and Concentration Polarization at Rotating Electrodes*, *Journal of the Electrochemical Society* 101 (1954) 306.
19. M Eisenberg, CW Tobias and CR Wilke, *Chem. Eng. Progr. Symp. Ser.* 51 (1955) 1.

20. DR Gabe, *Rotating Cylinder Electrode*, J. Appl. Electrochem. 4 (1974) 91.
21. DR Gabe and DJ Robinson, *Mass Transfer in a Rotating Cylinder Cell-I. Laminar Flow*, Electrochimica Acta 17 (1972) 1121.
22. DR Gabe and DJ Robinson, *Mass Transfer in a Rotating Cylinder Cell-II. Turbulent Flow*, Electrochimica Acta 17 (1972) 1129.
23. DR Gabe and FC Walsh, *The Rotating Cylinder Electrode: A Review of Development*, J. Appl. Electrochem. 13 (1983) 3.
24. Y Garsany, OA Baturina, KE Swider-Lyons and SS Kocha, *Experimental Methods for Quantifying the Activity of Platinum Electrocatalysts for the Oxygen Reduction Reaction*, Analytical Chemistry 82 (2010) 6321-6328.
25. HA Gasteiger, SS Kocha, B Sompalli and FT Wagner, *Activity benchmarks and requirements for Pt, Pt-alloy, and non-Pt oxygen reduction catalysts for PEMFCs*, Applied Catalysis B: Environmental 56 (2005) 9-35.
26. UA Paulus, A Wokauna, GG Scherera, TJ Schmidt, V Stamenkovic, NM Markovic and PN Ross, *Oxygen reduction on high surface area Pt-based alloy catalysts in comparison to well defined smooth bulk alloy electrodes*, Electrochimica Acta 47 (2002) 3787-3798.
27. UA Paulus, TJ Schmidt, HA Gasteiger and RJ Behm, *Oxygen reduction on a high-surface area Pt/Vulcan carbon catalyst: a thin-film rotating ring-disk electrode study*, J. of Electroanalytical Chem. 495 (2001) 134-145.
28. TJ Schmidt, UA Paulus, HA Gasteiger and RJ Behm, *The oxygen reduction reaction on a Pt/carbon fuel cell catalyst in the presence of chloride anions*, J. of Electroanalytical Chem. 508 (2001) 41-47.
29. G Brisard, N Bertrand, PN Ross and NM Markovic, *Oxygen reduction and hydrogen evolution-oxidation reactions on Cu(hkl) surfaces*, J. of Electroanalytical Chem. 480 (2000) 219-224.
30. L Geniès, R Faure and R Durand, *Electrochemical reduction of oxygen on platinum nanoparticles in alkaline media*, Electrochimica Acta 44 (1998) 1317-1327.
31. E Higuchia, H Uchida and M Watanabe, *Effect of loading level in platinum-dispersed carbon black electrocatalysts on oxygen reduction activity evaluated by rotating disk electrode*, J. of Electroanalytical Chem. 583 (2005) 69-76.
32. ZD Weia, SH Chanb, LL Lia, HF Caia, ZT Xiab and CX Sunc, *Electrodepositing Pt on a Nafion-bonded carbon electrode as a catalyzed electrode for oxygen reduction reaction*, Electrochimica Acta 50 (2005) 2279-2287.
33. S Marcotte, D Villers, N Guillet, L Roué and JP Dodelet, *Electroreduction of oxygen on Co-based catalysts: determination of the parameters affecting the two-electron transfer reaction in an acid medium*, Electrochimica Acta 50 (2004) 179-188.
34. S Durón, R Rivera-Noriega, P Nkeng, G Poillerat and O Solorza-Feria, *Kinetic study of oxygen reduction on nanoparticles of ruthenium synthesized by pyrolysis of Ru₃(CO)₁₂*, J. of Electroanalytical Chem. 566 (2004) 281-289.
35. DR Gabe and FC Walsh, *Enhanced Mass Transfer at the Rotating Cylinder Electrode-I. Characterization of a Smooth Cylinder and Roughness Development in Solutions of Constant Concentration*, J. Appl. Electrochem. 14 (1984) 555.
36. DR Gabe and FC Walsh, *Enhanced Mass Transfer at the Rotating Cylinder Electrode-II. Development of Roughness for Solutions of Decreasing Concentration*, J. Appl. Electrochem. 14 (1984) 565.
37. DR Gabe and FC Walsh, *Enhanced Mass Transfer at the Rotating Cylinder Electrode-III. Pilot and Production Plant Experience*, J. Appl. Electrochem. 15 (1985) 807.
38. DR Gabe and PA Mekanjuola, *Enhanced Mass Transfer Using Roughened Rotating Cylinder Electrodes in Turbulent Flow*, J. Appl. Electrochem. 17 (1987) 370.

39. DR Gabe, GD Wilcox, J Gonzalez-Garcia and FC Walsh, *The Rotating Cylinder Electrode: Its Continued Development and Application*, J. Appl. Electrochem. 28 (1998) 759.
40. G Kear, BD Barker, K Stokes and FC Walsh, *Flow Influenced Electrochemical Corrosion of Nickel Aluminum Bronze – Part I. Cathodic Polarization*, J. Appl. Electrochem. 34 (2004) 1235.
41. G Kear, BD Barker, K Stokes and FC Walsh, *Flow Influenced Electrochemical Corrosion of Nickel Aluminum Bronze – Part II. Anodic Polarization and Derivation of the Mixed Potential*, J. Appl. Electrochem. 34 (2004) 1241.
42. Q Lu, MM Stack and CR Wiseman, *AC Impedance Spectroscopy as a Technique for Investigating Corrosion of Iron in Hot Flowing Bayer Liquors*, J. Appl. Electrochem. 31 (2001) 1373.
43. JM Maciel and SML Agostinho, *Use of a Rotating Cylinder Electrode in Corrosion Studies of a 90/10 Cu–Ni Alloy in 0.5M H₂SO₄ Media*, J. Appl. Electrochem. 30 (2000) 981.
44. JM Grau and JM Bisang, *Mass Transfer Studies at Rotating Cylinder Electrodes of Expanded Metal*, J. Appl. Electrochem. 35 (2005) 285.
45. A Eklund and D Simonsson, *Enhanced Mass Transfer to a Rotating Cylinder Electrode with Axial Flow*, J. Appl. Electrochem. 18 (1988) 710.
46. KD Efird, EJ Wright, JA Boros and TG Hailey, *Correlation of Steel Corrosion in Pipe Flow with Jet Impingement and Rotating Cylinder Tests*, Corrosion 49 (1993) 992.
47. DC Silverman, *Rotating Cylinder Electrode for Velocity Sensitivity Testing*, Corrosion 40 (1984) 220.
48. DC Silverman and ME Zerr, *Application of the Rotating Cylinder Electrode – E-Brite® 26-1 in Concentrated Sulfuric Acid*, Corrosion 42 (1986) 633.
49. DC Silverman, *Rotating Cylinder Electrode – Geometry Relationships for Prediction of Velocity-Sensitive Corrosion*, Corrosion 44 (1988) 42.
50. DC Silverman, *Corrosion Prediction in Complex Environments using Electrochemical Impedance Spectroscopy*, Electrochimica Acta 38 (1993) 2075.
51. DC Silverman, *On Estimating Conditions for Simulating Velocity-Sensitive Corrosion in the Rotating Cylinder Electrode*, Corrosion 55 (1999) 1115.
52. DC Silverman, *Technical Note: Simplified Equation for Simulating Velocity-Sensitive Corrosion in the Rotating Cylinder Electrode at Higher Reynolds Numbers*, Corrosion 59 (2003) 207.
53. DC Silverman, *The Rotating Cylinder Electrode for Velocity-Sensitive Corrosion – A Review*, Corrosion 60 (2004) 1003.
54. DC Silverman, *Technical Note: Conditions for Similarity of Mass-Transfer Coefficients and Fluid Shear Stresses between the Rotating Cylinder Electrode and Pipe*, Corrosion 61 (2005) 515.
55. G Wranglen, J Berendson and G Karlberg, *Apparatus for Electrochemical Studies of Corrosion Processes in Flowing Systems*, in *Physico-Chemical Hydrodynamics*, edited by B Spalding (London: Adv. Publications, 1977) 461.
56. RA Holser, G Prentice, RB Pond and R Guanti, *Use of Rotating Cylinder Electrodes to Simulate Turbulent Flow Conditions in Corrosion Systems*, Corrosion 46 (1990) 764.
57. TY Chen, AA Moccari and DD Macdonald, *Development of Controlled Hydrodynamic Techniques for Corrosion Testing*, Corrosion 48 (1992) 239.
58. S Nesic, GT Solvi and S Skjerve, *Comparison of Rotating Cylinder and Loop Methods for Testing CO₂ Corrosion Inhibitors*, British Corrosion Journal 32 (1997) 269.
59. ASTM G 170, *Standard Guide for Evaluating and Qualifying Oilfield and Refinery Corrosion Inhibitors in the Laboratory* (2001).
60. ASTM G 185, *Standard Practice for Evaluating and Qualifying Oil Field and Refinery Corrosion Inhibitors Using the Rotating Cylinder Electrode* (2006).

11 Glossary

Anodic Current	Flow of charge at an electrode as a result of an oxidation reaction occurring at the electrode surface. For a working electrode immersed in a test solution, an anodic current corresponds to flow of electrons out of the solution and into the electrode.
Banana Cable	A banana cable is a single-wire (one conductor) signal cable often to make connections between various electronic instruments. Each end of the cable has a banana plug. The plug consists of a cylindrical metal pin about 25 mm (one inch) long, with an outer diameter of about 4 mm, which can be inserted into a matching banana jack.
Banana Jack	Female banana connector
Banana Plug	Male banana connector
BNC Connector	The BNC (Bayonet Neill-Concelman) connector is a very common type of RF connector used for terminating coaxial cable.
Brush Contacts	Electrical contact to the rotating shaft is accomplished by means of silver-carbon brush contacts. These brushes are spring loaded to assure that they are firmly pressed against the rotating shaft at all times.
Cathodic Current	Flow of charge at an electrode as a result of an reduction reaction occurring at the electrode surface. For a working electrode immersed in a test solution, a cathodic current corresponds to flow of electrons out of the electrode and into the solution.

Coaxial Cable	Coaxial cable, or coax, is an electrical cable with an inner conductor surrounded by a flexible, tubular insulating layer, surrounded by a tubular conducting shield. The term coaxial comes from the inner conductor and the outer shield sharing the same geometric axis. Coaxial cable is often used to carry signals from one instrument to another in situations where it is important to shield the signal from environmental noise sources.
Collection Efficiency	In the context of rotating ring-disk voltammetry, the collection efficiency is a measure of the amount of material which is generated at the disk electrode which ultimately makes its way to the ring electrode. It is often expressed as a percentage, and typical collection efficiencies fall between 20% and 30%.
Collection Experiment	An experiment with a rotating ring-disk electrode where the ring potential is held constant while the disk potential is swept slowly between two limits.
Convection	Convection is the movement of molecules or ions through a liquid solution as a result of bulk movement of the solution. Such bulk movement may be due to stirring the solution or due to vibrations or thermal gradients in the solution.
Counter Electrode	The counter electrode, often also called the auxiliary electrode, is one of three electrodes found in a typical three-electrode voltammetry experiment. The purpose of the counter electrode is to help carry the current across the solution by completing the circuit back to the potentiostat.
Cyclic Voltammetry	An electroanalytical method where the working electrode potential is repeatedly swept back and forth between two extremes while the working electrode current is measured.
Cylinder Insert	Most rotating cylinder electrode tips are designed to accept cylinder inserts fabricated from various alloys of interest to corrosion scientists.

Diffusion	In the context of electrochemistry in liquid solutions, diffusion is a time-dependent process consisting of random motion of ions or molecules in solution which leads to the statistical distribution of these species, gradually spreading the ions and molecules through the solution.
Diffusion Coefficient	A factor of proportionality representing the amount of substance diffusing across a unit area through a unit concentration gradient in unit time.
Diffusion Layer	Mass transport to a rotating electrode occurs via a combination of convection and diffusion. As material approaches the electrode, diffusion dominates over convection as the principle means of transport. Across the very thin layer of solution immediately adjacent to the electrode, diffusion is essentially the only means of mass transport. This thin layer is known as the diffusion layer. The diffusion layer should not be confused with the stagnant layer. The diffusion layer exists entirely within the thicker stagnant layer (see also Stagnant Layer).
Disk Insert	Some rotating disk and ring-disk electrode tips are designed to accept interchangeable disk inserts fabricated from various precious metals and advanced carbon materials.
Eisenberg Equation	The Eisenberg equation describes the mass transfer limited current at a rotating cylinder electrode.
Electroactive	An adjective used to describe a molecule or ion capable of being oxidized or reduced at an electrode surface.
Electrode	An electrode is an electrical conductor used to make contact with a nonmetallic part of a circuit.
Electrode Materials	Common electrode materials used to fabricate rotating disk and ring-disk electrodes are gold, platinum, and glassy carbon. Rotating cylinder electrodes are usually made from various alloys of steel, aluminum, or brass.

Faradaic Current	The portion of the current observed in an electroanalytical experiment that can be attributed to one or more redox processes occurring at an electrode surface.
Forced Convection	Active stirring or pumping of a liquid solution.
Half-Reaction	A balanced chemical equation showing how various molecules or ions are being reduced (or oxidized) at an electrode surface.
Hydrodynamic Layer	(see the definition of stagnant layer)
Hydrodynamic Voltammetry	A family of electroanalytical methods based upon precise control of solution flow coupled with rigorous mathematical models.
Insulating Materials	Chemically resistant and electrically insulating polymers commonly used to fabricate rotating electrodes include Teflon, PEEK (poly ether ether ketone), and KEL-F.
Laminar Flow	Laminar flow, sometimes known as streamline flow, occurs when a fluid flows in parallel layers, with no disruption between the layers.
Levich Equation	The Levich equation describes the mass transfer limited current at a rotating disk electrode.
Levich Study	Experiment using a rotating disk electrode in which a series of voltammograms are acquired over a range of rotation rates.
Levich Plot	A plot of limiting current vs. square root of rotation rate from a Levich study.
Linear Polarization Resistance	Term used in corrosion science for an experiment in which the electrode potential is changed from an initial value to final value at a slow and constant rate. This technique is similar to linear sweep voltammetry, but the sweep rates are much slower, and the results are plotted differently.

Linear Sweep Voltammetry	Experiment in which the working electrode potential is swept from initial value to final value at a constant rate while the current is measured.
Mass Transport Limited Current	The current corresponding to the maximum mass transfer rate of an ion or molecule to an electrode surface.
Migration	In an electroanalytical context, the term migration refers to the movement of ions across a solution under the influence of an electric field.
Non-Faradaic Current	The portion of the current observed in an electroanalytical experiment that cannot be attributed to any redox processes occurring at an electrode surface.
Overpotential	The overpotential is the difference between the formal potential of a half reaction and the potential presently being applied to the working electrode.
Oxidation	Removal of electrons from an ion or molecule.
Quiescent Solution	A solution in which there is little or no convection.
Redox	An adjective used to describe a molecule, ion, or process associated with an electrochemical reaction.
Reduction	Addition of electrons to an ion or molecule.
Reference Electrode	A reference electrode has a stable and well-known thermodynamic potential. The high stability of the electrode potential is usually reached by employing a redox system with constant (buffered or saturated) concentrations of the ions or molecules involved in the redox half reaction.
Reynolds Number	In fluid mechanics, the Reynolds number is a dimensionless number that gives a measure of the ratio of inertial forces to viscous forces and consequently quantifies the relative importance of these two types of forces for given flow conditions.

Rotation Rate	The rate at which a rotating electrode rotates. Experimentally, this is usually expressed in RPM, but in theoretical equations, the rotation rate is usually expressed in radians per second.
Shielding Experiment	An experiment with a rotating ring-disk electrode where the disk potential is held constant while the ring potential is swept slowly between two limits.
Stagnant Layer	At a rotating electrode, the portion of the solution near the electrode tends to rotate at nearly the same speed as the electrode surface. This layer of solution is known as the stagnant layer (or, in the context of fluid dynamics, the stagnant layer is more properly called the hydrodynamic layer). Mass transport across the stagnant layer occurs by a combination of convection and diffusion, with diffusion dominating as the material travels closer to the electrode surface (see also Diffusion Layer).
Standard Electrode Potential	A thermodynamic quantity expressing the free energy of a redox half reaction in terms of electric potential.
Sweep Rate	Rate at which the electrode potential is changed when performing a sweep voltammetry method such as cyclic voltammetry.
Three-Electrode Cell	A common electrochemical cell arrangement consisting of a working electrode, a reference electrode, and a counter electrode.
Transit Time	In the context of rotating ring-disk voltammetry, the transit time is the average amount of time required for material generated at the disk electrode to be swept over to the ring electrode.
Turbulent Flow	Chaotic (non-laminar) flow of solution.
Voltammogram	A plot of current vs. potential from an electroanalytical experiment in which the potential is swept back and forth between two limits.

Window Experiment

An experiment with a rotating ring-disk electrode where the disk potential is swept slowly between two limits, and the ring potential is swept in the same manner as the disk potential but with a constant offset between the ring and disk potentials.

Working Electrode

The electrode at which the redox process of interest occurs. While there may be many electrodes in an electrochemical cell, the focus of an experiment is typically only on a particular half reaction occurring at the working electrode.